

Intel[®] Pentium[®] 4 Processors 570/571, 560/561, 550/551, 540/541, 530/531 and 520/521 $^{\triangle}$ Supporting Hyper-Threading Technology¹

Datasheet

On 90 nm Process in 775-land LGA Package and supporting Intel[®] Extended Memory 64 Technology[©]

May 2005

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Revision History

Revision No.	Description	Date of Release
-001	Initial release	June 2004
-002	 Added specifications for processor number 550 with PRB = 0 Added support for Execute Disable Bit capability Added Icc Enhanced Auto Halt specifications Added support for Thermal Monitor 2 	September 2004
-003	Added specifications for processor number 570 with PRB = 1	November 2004
-004	 Added specifications for processor numbers 571, 561, 551, 541, 531, and 521. Modified Table 2-3, "FSB Signal Groups". Added Note 5 to Table 2-18. Updated Figure 3-5 Top Slde Marking Example and added Figure 3-6. Minor edits throughout for clarity. 	May 2005

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Intel[®] Pentium[®] 4 Processors 570/571, 560/561, 550/551, 540/541, 530/531, and 520/521

- Available at 3.80 GHz, 3.60 GHz, 3.40 GHz, 3.20 GHz, 3 GHz, and 2.80 GHz
- Supports Hyper-Threading Technology¹ (HT Technology) for all frequencies with 800 MHz front side bus (FSB)
- Intel[®] Pentium[®] 4 processors 571, 561, 551, 541, 531, and 521 support Intel[®] Extended Memory 64 Technology (EM64T)^Φ
- Supports Execute Disable Bit capability
- Binary compatible with applications running on previous members of the Intel microprocessor line
- Intel NetBurst® microarchitecture
- FSB frequency at 800 MHz
- Hyper-Pipelined Technology
- Advance Dynamic Execution
- Very deep out-of-order execution
- · Enhanced branch prediction
- Optimized for 32-bit applications running on advanced 32-bit operating systems

- 16-KB Level 1 data cache
- 1-MB Advanced Transfer Cache (on-die, fullspeed Level 2 (L2) cache) with 8-way associativity and Error Correcting Code (ECC)
- 144 Streaming SIMD Extensions 2 (SSE2) instructions
- 13 Streaming SIMD Extensions 3 (SSE3) instructions
- Enhanced floating point and multimedia unit for enhanced video, audio, encryption, and 3D performance
- Power Management capabilities
- System Management mode
- Multiple low-power states
- 8-way cache associativity provides improved cache hit rate on load/store operations
- 775-land Package

The Intel® Pentium® 4 processor family supporting Hyper-Threading Technology¹ (HT Technology) delivers Intel's advanced, powerful processors for desktop PCs and entry-level workstations that are based on the Intel NetBurst® microarchitecture. The Pentium 4 processor is designed to deliver performance across applications and usages where end-users can truly appreciate and experience the performance. These applications include Internet audio and streaming video, image processing, video content creation, speech, 3D, CAD, games, multimedia, and multitasking user environments. Intel® Extended Memory 64 Technology enables the Intel® Pentium® processor to execute operating systems and applications written to take advange of the Intel EM64T[©].

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1 Introduction

The Intel[®] Pentium[®] 4 processor on 90 nm process in the 775-land package is a follow on to the Pentium 4 processor in the 478-pin package with enhancements to the Intel NetBurst[®] microarchitecture. The Pentium 4 processor on 90 nm process in the 775-land package uses Flip-Chip Land Grid Array (FC-LGA4) package technology, and plugs into a 775LGA socket. The Pentium 4 processor in the 775-land package, like its predecessor, the Pentium 4 processor in the 478-pin package, is based on the same Intel 32-bit microarchitecture and maintains the tradition of compatibility with IA-32 software.

Note: In this document the Pentium 4 processor on 90 nm process in the 775-land package is also referred to as the processor.

The Pentium 4 processor on 90 nm process in the 775-land package supports Hyper-Threading Technology ¹. Hyper-Threading Technology allows a single, physical processor to function as two logical processors. While some execution resources (such as caches, execution units, and buses) are shared, each logical processor has its own architecture state with its own set of general-purpose registers, control registers to provide increased system responsiveness in multitasking environments, and headroom for next generation multithreaded applications. Intel recommends enabling Hyper-Threading Technology with Microsoft Windows* XP Professional or Windows* XP Home, and disabling Hyper-Threading Technology via the BIOS for all previous versions of Windows operating systems. For more information on Hyper-Threading Technology, see http://www.intel.com/info/hyperthreading. Refer to Section 6.1, for Hyper-Threading Technology configuration details.

The Intel Pentium 4 processor 571, 561, 541, 531, and 521 support Intel[®] Extended Memory 64 Technology (EM64T) as an enhancement to Intel's IA-32 architecture. This enhancement enables the processor to execute operating systems and applications written to take advantage of Intel EM64T. With appropriate 64 bit supporting hardware and software, platforms based on an Intel processor supporting Intel[®] EM64T can enable use of extended virtual and physical memory. Further details on the 64-bit extension architecture and programming model is provided in the Intel[®] Extended Memory 64 Technology Software Developer Guide at: http://developer.intel.com/technology/64bitextensions/.

In addition to supporting all the existing Streaming SIMD Extensions 2 (SSE2), there are 13 new instructions that further extend the capabilities of Intel processor technology. These new instructions are called Streaming SIMD Extensions 3 (SSE3). These new instructions enhance the performance of optimized applications for the digital home such as video, image processing, and media compression technology. 3D graphics and other entertainment applications such as gaming will have the opportunity to take advantage of these new instructions as platforms with the Pentium 4 processor in the 775-land package and SSE3 become available in the market place.

The processor's Intel NetBurst microarchitecture FSB uses a split-transaction, deferred reply protocol like the Pentium 4 processor. The Intel NetBurst microarchitecture FSB uses Source-Synchronous Transfer (SST) of address and data to improve performance by transferring data four times per bus clock (4X data transfer rate, as in AGP 4X). Along with the 4X data bus, the address bus can deliver addresses two times per bus clock and is referred to as a "double-clocked" or 2X address bus. Working together, the 4X data bus and 2X address bus provide a data bus bandwidth of up to 6.4 GB/s.



The Pentium 4 processor on 90 nm process in the LGA775-land package will also include the Execute Disable Bit capability previously available in Intel[®] Itanium[®] processors. This feature combined with a support operating system allows memory to be marked as executable or non-executable. If code attempts to run in non-executable memory the processor raises an error to the operating system. This feature can prevent some classes of viruses or worms that exploit buffer overrun vulnerabilities and can thus help improve the overall security of the system. See the *Intel[®] Architecture Software Developer's Manual* for more detailed information.

Intel will enable support components for the processor including heatsink, heatsink retention mechanism, and socket. Manufacturability is a high priority; hence, mechanical assembly may be completed from the top of the baseboard and should not require any special tooling.

The processor includes an address bus powerdown capability that removes power from the address and data pins when the FSB is not in use. This feature is always enabled on the processor.

1.1 Terminology

A '#' symbol after a signal name refers to an active low signal, indicating a signal is in the active state when driven to a low level. For example, when RESET# is low, a reset has been requested. Conversely, when NMI is high, a nonmaskable interrupt has occurred. In the case of signals where the name does not imply an active state but describes part of a binary sequence (such as *address* or *data*), the '#' symbol implies that the signal is inverted. For example, D[3:0] = 'HLHL' refers to a hex 'A', and D[3:0]# = 'LHLH' also refers to a hex 'A' (H= High logic level, L= Low logic level).

"FSB" refers to the interface between the processor and system core logic (a.k.a. the chipset components). The FSB is a multiprocessing interface to processors, memory, and I/O.

1.1.1 Processor Packaging Terminology

Commonly used terms are explained here for clarification:

- Pentium 4 processor on 90 nm process in the 775-land package Processor in the FC-LGA4 package with a 1-MB L2 cache.
- **Processor** For this document, the term processor is the generic form of the Pentium 4 processor in the 775-land package.
- **Keep-out zone** The area on or near the processor that system design can not use.
- Intel 925X/915G/915P Express chipsets Chipsets that supports DDR and DDR2 memory technology for the Pentium 4 processor in the 775-land package.
- **Processor core** Processor core die with integrated L2 cache.
- FC-LGA4 package The Pentium 4 processor in the 775-land package is available in a Flip-Chip Land Grid Array 4 package, consisting of a processor core mounted on a substrate with an integrated heat spreader (IHS).
- **LGA775 socket** The Pentium 4 processor in the 775-land package mates with the system board through a surface mount, 775-land, LGA socket.
- **Integrated heat spreader (IHS)** —A component of the processor package used to enhance the thermal performance of the package. Component thermal solutions interface with the processor at the IHS surface.



- **Retention mechanism (RM)**—Since the LGA775 socket does not include any mechanical features for heatsink attach, a retention mechanism is required. Component thermal solutions should attach to the processor via a retention mechanism that is independent of the socket.
- Storage conditions—Refers to a non-operational state. The processor may be installed in a platform, in a tray, or loose. Processors may be sealed in packaging or exposed to free air. Under these conditions, processor lands should not be connected to any supply voltages, have any I/Os biased, or receive any clocks. Upon exposure to "free air" (i.e., unsealed packaging or a device removed from packaging material) the processor must be handled in accordance with moisture sensitivity labeling (MSL) as indicated on the packaging material.
- **Functional operation**—Refers to normal operating conditions in which all processor specifications, including DC, AC, system bus, signal quality, mechanical and thermal, are satisfied.

1.2 References

Material and concepts available in the following documents may be beneficial when reading this document.

Table 1-1. References

Document	Document Numbers/ Location
Intel [®] Pentium [®] 4 Processor on 90 nm Process Specification Update	http://developer.intel.com/ design/Pentium4/ specupdt/302352.htm
Intel® Pentium® 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines	http://developer.intel.com/ design/Pentium4/guides/ 302553.htm
Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket	http://developer.intel.com/ design/Pentium4/guides/ 302356.htm
Intel [®] Architecture Software Developer's Manual	
IA-32 Intel [®] Architecture Software Developer's Manual Volume 1: Basic Architecture	
IA-32 Intel [®] Architecture Software Developer's Manual Volume 2A: Instruction Set Reference Manual A–M	http://developer.intel.com/ design/pentium4/
IA-32 Intel [®] Architecture Software Developer's Manual Volume 2B: Instruction Set Reference Manual, N–Z	manuals/index_new.htm
IA-32 Intel [®] Architecture Software Developer's Manual Volume 3: System Programming Guide	
IA-32 Intel [®] Architecture and Intel [®] Extended Memory 64 Software Developer's Manual Documentation Changes	http://developer.intel.com/ design/pentium4/ manuals/index_new.htm

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Introduction





2 Electrical Specifications

This chapter describes the electrical characteristics of the processor interfaces and signals. DC electrical characteristics are provided.

2.1 FSB and GTLREF

Most processor FSB signals use Gunning Transceiver Logic (GTL+) signaling technology. Platforms implement a termination voltage level for GTL+ signals defined as V_{TT} . V_{TT} must be provided via a separate voltage source and not be connected to V_{CC} . This configuration allows for improved noise tolerance as processor frequency increases. Because of the speed improvements to the data and address bus, signal integrity and platform design methods have become more critical than with previous processor families.

The GTL+ inputs require a reference voltage (GTLREF) that is used by the receivers to determine if a signal is a logical 0 or a logical 1. GTLREF must be generated on the system board (see Table 2-18 for GTLREF specifications). Termination resistors are provided on the processor silicon and are terminated to $V_{\rm TT}$. Intel chipsets will also provide on-die termination, thus eliminating the need to terminate the bus on the system board for most GTL+ signals.

Some GTL+ signals do not include on-die termination and must be terminated on the system board. See Table 2-4 for details regarding these signals.

The GTL+ bus depends on incident wave switching. Therefore, timing calculations for GTL+ signals are based on flight time as opposed to capacitive deratings. Analog signal simulation of the FSB, including trace lengths, is highly recommended when designing a system.

2.2 Power and Ground Lands

For clean on-chip power distribution, the Pentium 4 processor in the 775-land package has 226 V_{CC} (power), 24 V_{TT} and 273 V_{SS} (ground) lands. All power lands must be connected to V_{CC} , all V_{TT} lands must be connected to V_{TT} , while all V_{SS} lands must be connected to a system ground plane. The processor V_{CC} lands must be supplied the voltage determined by the Voltage IDentification (VID) signals.

2.3 Decoupling Guidelines

Due to its large number of transistors and high internal clock speeds, the processor is capable of generating large current swings between low and full power states. This may cause voltages on power planes to sag below their minimum values if bulk decoupling is not adequate. Care must be taken in the board design to ensure that the voltage provided to the processor remains within the specifications listed in Table 2-8. Failure to do so can result in timing violations or reduced lifetime of the component. For further information and design guidelines, refer to the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket*.



2.3.1 V_{CC} Decoupling

Regulator solutions need to provide bulk capacitance with a low Effective Series Resistance (ESR) and keep a low interconnect resistance from the regulator to the socket. Bulk decoupling for the large current swings when the part is powering on, or entering/exiting low power states, must be provided by the voltage regulator solution (VR). For more details on this topic, refer to the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket*.

2.3.2 FSB GTL+ Decoupling

The Pentium 4 processor in the 775-land package integrates signal termination on the die as well as incorporating high frequency decoupling capacitance on the processor package. Decoupling must also be provided by the system baseboard for proper GTL+ bus operation.

2.3.3 FSB Clock (BCLK[1:0]) and Processor Clocking

BCLK[1:0] directly controls the FSB interface speed as well as the core frequency of the processor. As in previous generation processors, the Pentium 4 processor in the 775-land package core frequency is a multiple of the BCLK[1:0] frequency. The processor bus ratio multiplier will be set at its default ratio during manufacturing. No user intervention is necessary, and the processor will automatically run at the speed indicated on the package.

The Pentium 4 processor in the 775-land package uses a differential clocking implementation. For more information on the Pentium 4 processor in the 775-land package clocking, refer to the CK410/CK410M Clock Synthesizer/Driver Specification.

Tabl	e 2-1.	Core	Frequency	to FSB	Multiplier	Config	gurati	on
------	--------	------	-----------	--------	------------	--------	--------	----

Multiplication of System Core Frequency to FSB Frequency	Core Frequency (200 MHz BCLK/800 MHz FSB)	Notes ^{1, 2}
1/14	2.80 GHz	-
1/15	3 GHz	-
1/16	3.20 GHz	-
1/17	3.40 GHz	-
1/18	3.60 GHz	-
1/19	3.80 GHz	-

NOTES:

- 1. Individual processors operate only at or below the rated frequency.
- 2. Listed frequencies are not necessarily committed production frequencies.



2.4 Voltage Identification

The VID specification for the Pentium 4 processor in the 775-land package is supported by the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket*. The voltage set by the VID signals is the reference VR output voltage to be delivered to the processor V_{CC} pins. A minimum voltage is provided in Table 2-8 and changes with frequency. This allows processors running at a higher frequency to have a relaxed minimum voltage specification. The specifications have been set such that one voltage regulator can work with all supported frequencies.

Individual processor VID values may be calibrated during manufacturing such that two devices at the same speed may have different VID settings.

The Pentium 4 processor in the 775-land package uses six voltage identification signals, VID[5:0], to support automatic selection of power supply voltages. Table 2-2 specifies the voltage level corresponding to the state of VID[5:0]. A '1' in this table refers to a high voltage level and a '0' refers to low voltage level. If the processor socket is empty (VID[5:0] = x11111), or the voltage regulation circuit cannot supply the voltage that is requested, it must disable itself. See the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket* for more details.

Power source characteristics must be guaranteed to be stable when the supply to the voltage regulator is stable.

The LL_ID[1:0] lands are used by the platform to configure the proper loadline slope for the processor. LL_ID[1:0] = 00 for the Pentium 4 processor in the 775-land package.

The VTT_SEL land is used by the platform to configure the proper V_{TT} voltage level for the processor. VTT_SEL = 1 for the Pentium 4 processor in the 775-land package.

The GTLREF_SEL signal is used by the platform to select the appropriate chipset GTLREF level. GTLREF_SEL = 0 for the Pentium 4 processor in the 775-land package.

LL_ID[1:0] and VTT_SEL are signals that are implemented on the processor package. That is, they are either connected directly to V_{SS} or are open lands.



Table 2-2. Voltage Identification Definition

0 0 1 0		VID2	VID1	VID0								
				VIDU	VID	VID5	VID4	VID3	VID2	VID1	VID0	VID
1 0	1	0	1	0	0.8375	0	1	1	0	1	0	1.2125
	1	0	0	1	0.8500	1	1	1	0	0	1	1.2250
0 0	1	0	0	1	0.8625	0	1	1	0	0	1	1.2375
1 0	1	0	0	0	0.8750	1	1	1	0	0	0	1.2500
0 0	1	0	0	0	0.8875	0	1	1	0	0	0	1.2625
1 0	0	1	1	1	0.9000	1	1	0	1	1	1	1.2750
0 0	0	1	1	1	0.9125	0	1	0	1	1	1	1.2875
1 0	0	1	1	0	0.9250	1	1	0	1	1	0	1.3000
0 0	0	1	1	0	0.9375	0	1	0	1	1	0	1.3125
1 0	0	1	0	1	0.9500	1	1	0	1	0	1	1.3250
0 0	0	1	0	1	0.9625	0	1	0	1	0	1	1.3375
1 0	0	1	0	0	0.9750	1	1	0	1	0	0	1.3500
0 0	0	1	0	0	0.9875	0	1	0	1	0	0	1.3625
1 0	0	0	1	1	1.0000	1	1	0	0	1	1	1.3750
0 0	0	0	1	1	1.0125	0	1	0	0	1	1	1.3875
1 0	0	0	1	0	1.0250	1	1	0	0	1	0	1.4000
0 0	0	0	1	0	1.0375	0	1	0	0	1	0	1.4125
1 0	0	0	0	1	1.0500	1	1	0	0	0	1	1.4250
0 0	0	0	0	1	1.0625	0	1	0	0	0	1	1.4375
1 0	0	0	0	0	1.0750	1	1	0	0	0	0	1.4500
0 0	0	0	0	0	1.0875	0	1	0	0	0	0	1.4625
1 1	1	1	1	1	VR output off	1	0	1	1	1	1	1.4750
0 1	1	1	1	1	VR output off	0	0	1	1	1	1	1.4875
1 1	1	1	1	0	1.1000	1	0	1	1	1	0	1.5000
0 1	1	1	1	0	1.1125	0	0	1	1	1	0	1.5125
1 1	1	1	0	1	1.1250	1	0	1	1	0	1	1.5250
0 1	1	1	0	1	1.1375	0	0	1	1	0	1	1.5375
1 1	1	1	0	0	1.1500	1	0	1	1	0	0	1.5500
0 1	1	1	0	0	1.1625	0	0	1	1	0	0	1.5625
1 1	1	0	1	1	1.1750	1	0	1	0	1	1	1.5750
0 1	1	0	1	1	1.1875	0	0	1	0	1	1	1.5875
1 1	1	0	1	0	1.2000	1	0	1	0	1	0	1.6000



2.4.1 Phase Lock Loop (PLL) Power and Filter

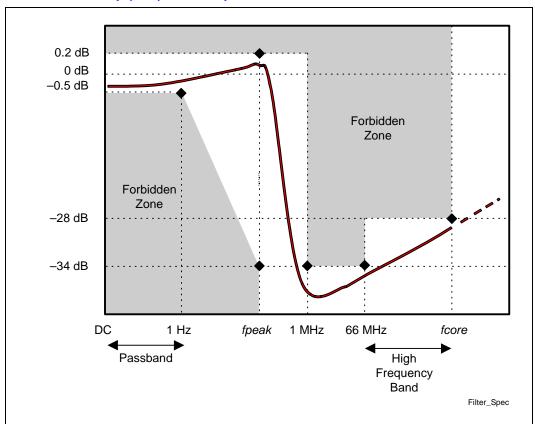
 V_{CCA} and $V_{CCIOPLL}$ are power sources required by the PLL clock generators for the Pentium 4 processor in the 775-land package. Since these PLLs are analog, they require low noise power supplies for minimum jitter. Jitter is detrimental to the system: it degrades external I/O timings as well as internal core timings (i.e., maximum frequency). To prevent this degradation, these supplies must be low pass filtered from V_{TT} .

The AC low-pass requirements, with input at V_{TT} are as follows:

- < 0.2 dB gain in pass band
- < 0.5 dB attenuation in pass band < 1 Hz
- > 34 dB attenuation from 1 MHz to 66 MHz
- > 28 dB attenuation from 66 MHz to core frequency

The filter requirements are illustrated in Figure 2-1.

Figure 2-1. Phase Lock Loop (PLL) Filter Requirements



NOTES:

- 1. Diagram not to scale.
- 2. No specification exists for frequencies beyond fcore (core frequency).
- 3. fpeak, if existent, should be less than 0.05 MHz.



2.5 Reserved, Unused, FC and TESTHI Signals

All RESERVED signals must remain unconnected. Connection of these signals to V_{CC} , V_{SS} , V_{TT} , or to any other signal (including each other) can result in component malfunction or incompatibility with future processors. See Chapter 4 for a land listing of the processor and the location of all RESERVED signals.

For reliable operation, always connect unused inputs or bidirectional signals to an appropriate signal level. In a system level design, on-die termination has been included on the Pentium 4 processor in the 775-land package to allow signals to be terminated within the processor silicon. Most unused GTL+ inputs should be left as no connects, as GTL+ termination is provided on the processor silicon. However, see Table 2-4 for details on GTL+ signals that do not include on-die termination. Unused active high inputs should be connected through a resistor to ground (V_{SS}). Unused outputs can be left unconnected, however this may interfere with some test access port (TAP) functions, complicate debug probing, and prevent boundary scan testing. A resistor must be used when tying bidirectional signals to power or ground. When tying any signal to power or ground, a resistor will also allow for system testability. For unused GTL+ input or I/O signals, use pull-up resistors of the same value as the on-die termination resistors (R_{TT}). Refer to Table 2-18 for more details.

TAP, GTL+ Asynchronous inputs, and GTL+ Asynchronous outputs do not include on-die termination. Inputs and used outputs must be terminated on the system board. Unused outputs may be terminated on the system board or left unconnected. Note that leaving unused outputs unterminated may interfere with some TAP functions, complicate debug probing, and prevent boundary scan testing.

FCx signals are signals that are available for compatibility with other processors.

The TESTHI signals must be tied to the processor V_{TT} using a matched resistor, where a matched resistor has a resistance value within $\pm 20\%$ of the impedance of the board transmission line traces. For example, if the trace impedance is $60~\Omega$, then a value between $48~\Omega$ and $72~\Omega$ is required.

The TESTHI signals may use individual pull-up resistors or be grouped together as detailed below. A matched resistor must be used for each group:

- TESTHI[1:0]
- TESTHI[7:2]
- TESTHI8 cannot be grouped with other TESTHI signals
- TESTHI9 cannot be grouped with other TESTHI signals
- TESTHI10 cannot be grouped with other TESTHI signals
- TESTHI11 cannot be grouped with other TESTHI signals
- TESTHI12 cannot be grouped with other TESTHI signals
- TESTHI13 cannot be grouped with other TESTHI signals



2.6 FSB Signal Groups

The FSB signals have been combined into groups by buffer type. GTL+ input signals have differential input buffers, which use GTLREF as a reference level. In this document, the term "GTL+ Input" refers to the GTL+ input group as well as the GTL+ I/O group when receiving. Similarly, "GTL+ Output" refers to the GTL+ output group as well as the GTL+ I/O group when driving.

With the implementation of a source synchronous data bus comes the need to specify two sets of timing parameters. One set is for common clock signals which are dependent upon the rising edge of BCLK0 (ADS#, HIT#, HITM#, etc.) and the second set is for the source synchronous signals which are relative to their respective strobe lines (data and address) as well as the rising edge of BCLK0. Asychronous signals are still present (A20M#, IGNNE#, etc.) and can become active at any time during the clock cycle. Table 2-3 identifies which signals are common clock, source synchronous, and asynchronous.

Table 2-3. FSB Signal Groups

Signal Group	Туре	Signals	s ¹	
GTL+ Common Clock Input	Synchronous to BCLK[1:0]	BPRI#, DEFER#, RS[2:0]#, RSP#, TRDY#		
GTL+ Common Clock I/O	Synchronous to BCLK[1:0]	AP[1:0]#, ADS#, BINIT#, BNR#, BPM[5:0]#, BR0#, DBSY#, DP[3:0]#, DRDY#, HIT#, HITM#, LOCK#, MCERR#		
		Signals	Associated Strobe	
		REQ[4:0]#, A[16:3]# ³	ADSTB0#	
GTL+ Source Synchronous I/O	Synchronous to assoc.	A[35:17]# ³	ADSTB1#	
·	Strobe	D[15:0]#, DBI0#	DSTBP0#, DSTBN0#	
		D[31:16]#, DBI1#	DSTBP1#, DSTBN1#	
		D[47:32]#, DBI2#	DSTBP2#, DSTBN2#	
		D[63:48]#, DBI3#	DSTBP3#, DSTBN3#	
GTL+ Strobes	Synchronous to BCLK[1:0]	ADSTB[1:0]#, DSTBP[3:0]#, DSTBN[3:0]#		
GTL+ Asynchronous Input		A20M#, IGNNE#, INIT#, LINT0/INTR, LINT1/NMI, SMI#, STPCLK#, RESET#		
GTL+ Asynchronous Output		FERR#/PBE#, IERR#, THERMTRIP#		
GTL+ Asynchronous Input/Output		PROCHOT#		
TAP Input	Synchronous to TCK	TCK, TDI, TMS, TRST#		
TAP Output	Synchronous to TCK	TDO		
FSB Clock	Clock	BCLK[1:0], ITP_CLK[1:0] ²		
Power/Other		VCC, VTT, VCCA, VCCIOPLL, VID COMP[1:0], RESERVED, TESTHI[' THERMDC, VCC_SENSE, VSS_SI SKTOCC#, DBR# ² , VTTPWRGD, E VTT_OUT_LEFT, VTT_OUT_RIGH FCx, VSS_MB_REGULATION, VCC MSID[1:0]	3:0], THERMDA, ENSE, BSEL[2:0], BOOTSELECT, PWRGOOD, T, VTT_SEL, LL_ID[1:0],	



- 1. Refer to Section 4.2 for signal descriptions.
- In processor systems where there is no debug port implemented on the system board, these signals are used to support a debug port interposer. In systems with the debug port implemented on the system board, these signals are no connects.
- 3. The value of these signals during the active-to-inactive edge of RESET# defines the processor configuration options. See Section 6.1 for details.

Table 2-4. Signal Characteristics

Signals with R_{TT}	Signals with no R _{TT}
A[35:3]#, ADS#, ADSTB[1:0]#, AP[1:0]#, BINIT#, BNR#, BOOTSELECT ¹ , BPRI#, D[63:0]#, DBI[3:0]#, DBSY#, DEFER#, DP[3:0]#, DRDY#, DSTBN[3:0]#, DSTBP[3:0]#, HIT#, HITM#, LOCK#, MCERR#, PROCHOT#, REQ[4:0]#, RS[2:0]#, RSP#, TRDY#	A20M#, BCLK[1:0], BPM[5:0]#, BR0#, BSEL[2:0], COMP[1:0], FERR#/PBE#, IERR#, IGNNE#, INIT#, LINT0/INTR, LINT1/NMI, PWRGOOD, RESET#, SKTOCC#, SMI#, STPCLK#, TDO, TESTHI[13:0], THERMDA, THERMDC, THERMTRIP#, VID[5:0], VTTPWRGD, GTLREF, TCK, TDI, TRST#, TMS
Open Drain Signals ²	
BSEL[2:0], VID[5:0], THERMTRIP#, FERR#/PBE#, IERR#, BPM[5:0]#, BR0#, TDO, VTT_SEL, LL_ID[1:0], MSID[1:0]	

NOTES:

- 1. The BOOTSELECT signal has a 500-5000 Ω pull-up to V_{TT} rather than on-die termination.
- Signals that do not have R_{TT}, nor are actively driven to their high-voltage level.

Table 2-5. Signal Reference Voltages

GTLREF	V _{TT} /2
BPM[5:0]#, LINTO/INTR, LINT1/NMI, RESET#, BINIT#, BNR#, HIT#, HITM#, MCERR#, PROCHOT#, BR0#, A[35:0]#, ADS#, ADSTB[1:0]#, AP[1:0]#, BPRI#, D[63:0]#, DBI[3:0]#, DBSY#, DEFER#, DP[3:0]#, DRDY#, DSTBN[3:0]#, DSTBP[3:0]#, LOCK#, REQ[4:0]#, RS[2:0]#, RSP#, TRDY#	BOOTSELECT, VTTPWRGD, A20M#, IGNNE#, INIT#, PWRGOOD ¹ , SMI#, STPCLK#, TCK ¹ , TDI ¹ , TMS ¹ , TRST# ¹

NOTES:

2.7 GTL+ Asynchronous Signals

Legacy input signals such as A20M#, IGNNE#, INIT#, SMI#, and STPCLK# use CMOS input buffers. All of these signals follow the same DC requirements as GTL+ signals, however the outputs are not actively driven high (during a logical 0 to 1 transition) by the processor. These signals do not have setup or hold time specifications in relation to BCLK[1:0].

All of the GTL+ Asynchronous signals are required to be asserted/de-asserted for at least six BCLKs for the processor to recognize the proper signal state. See Section 6.2 for additional timing requirements for entering and leaving the low power states.

^{1.} These signals also have hysteresis added to the reference voltage. See Table 2-13 for more information.



2.8 Test Access Port (TAP) Connection

Due to the voltage levels supported by other components in the Test Access Port (TAP) logic, it is recommended that the Pentium 4 processor in the 775-land package be first in the TAP chain and followed by any other components within the system. A translation buffer should be used to connect to the rest of the chain unless one of the other components is capable of accepting an input of the appropriate voltage level. Similar considerations must be made for TCK, TMS, TRST#, TDI, and TDO. Two copies of each signal may be required, with each driving a different voltage level.

2.9 FSB Frequency Select Signals (BSEL[2:0])

The BSEL[2:0] signals are used to select the frequency of the processor input clock (BCLK[1:0]). Table 2-6 defines the possible combinations of the signals and the frequency associated with each combination. The required frequency is determined by the processor, chipset, and clock synthesizer. All agents must operate at the same frequency.

The Pentium 4 processor in the 775-land package currently operates at a 533 MHz or 800 MHz FSB frequency (selected by a 133 MHz or 200 MHz BCLK[1:0] frequency). Individual processors will only operate at their specified FSB frequency.

For more information about these signals, refer to Section 4.2.

Table 2-6. BSEL[2:0] Frequency Table for BCLK[1:0]

BSEL2	BSEL1	BSEL0	FSB Frequency
L	L	L	RESERVED
L	L	Н	133 MHz
L	Н	Н	RESERVED
L	Н	L	200 MHz
Н	L	L	RESERVED
Н	L	Н	RESERVED
Н	Н	Н	RESERVED
Н	Н	L	RESERVED



2.10 Absolute Maximum and Minimum Ratings

Table 2-7 specifies absolute maximum and minimum ratings. Within functional operation limits, functionality and long-term reliability can be expected.

At conditions outside functional operation condition limits, but within absolute maximum and minimum ratings, neither functionality nor long-term reliability can be expected. If a device is returned to conditions within functional operation limits after having been subjected to conditions outside these limits, but within the absolute maximum and minimum ratings, the device may be functional, but with its lifetime degraded depending on exposure to conditions exceeding the functional operation condition limits.

At conditions exceeding absolute maximum and minimum ratings, neither functionality nor long-term reliability can be expected. Moreover, if a device is subjected to these conditions for any length of time then, when returned to conditions within the functional operating condition limits, it will either not function, or its reliability will be severely degraded.

Although the processor contains protective circuitry to resist damage from static electric discharge, precautions should always be taken to avoid high static voltages or electric fields.

Table 2-7. Processor DC	Absolute Maximui	n Ratings
-------------------------	------------------	-----------

Symbol	Parameter	Min	Max	Unit	Notes ^{1, 2}
V _{CC}	Core voltage with respect to Vss	-0.3	1.55	V	_
V _{TT}	FSB termination voltage with respect to V _{SS}	-0.3	1.55	V	_
T _C	Processor case temperature	See Section 5	See Section 5	°C	_
T _{STORAGE}	Processor storage temperature	-40	+85	°C	3, 4

NOTES:

- 1. For functional operation, all processor electrical, signal quality, mechanical and thermal specifications must be satisfied.
- 2. Excessive overshoot or undershoot on any signal will likely result in permanent damage to the processor.
- Storage temperature is applicable to storage conditions only. In this scenario, the processor must not receive a clock, and
 no lands can be connected to a voltage bias. Storage within these limits will not affect the long-term reliability of the device.
 For functional operation, refer to the processor case temperature specifications.
- This rating applies to the processor and does not include any tray or packaging.

2.11 Processor DC Specifications

The processor DC specifications in this section are defined at the processor core silicon and not at the package lands unless noted otherwise. See Chapter 4 for the signal definitions and signal assignments. Most of the signals on the processor FSB are in the GTL+ signal group. The DC specifications for these signals are listed in Table 2-12.

Previously, legacy signals and Test Access Port (TAP) signals to the processor used low-voltage CMOS buffer types. However, these interfaces now follow DC specifications similar to GTL+. The DC specifications for these signal groups are listed in Table 2-11 and Table 2-13.

Table 2-8 through Table 2-15 list the DC specifications for the Pentium 4 processor in the 775-land package and are valid only while meeting specifications for case temperature, clock frequency, and input voltages. Care should be taken to read all notes associated with each parameter.

MSR_PLATFORM_BRV bit 18 is a Platform Requirement Bit (PRB) that indicates that the processor has specific platform requirements.



Table 2-8. Voltage and Current Specifications (Sheet 1 of 2)

Symbol	Symbol Parameter		Min	Тур	Max	Unit	Notes ¹
VID range	range VID		1.200	_	1.425	V	2
	Processor Number	Core Frequency		•	•		
		V _{CC} for 775_VR_CONFIG_04B processors					
V_{CC}	570/571	3.80 GHZ (PRB = 1)	Refer	to Table 2		V	3, 4, 5, 6
00	560/561	3.60 GHz (PRB = 1)		Figure 2-3)		
	550	3.40 GHz (PRB = 1)					
		V _{CC} for 775_VR_CONFIG_04A processors					
	550/551	3.40 GHz (PRB = 0)	Refe	r to Table 2	2-9 and	.,	3, 4, 6, 7, 8
V _{CC}	540/541	3.20 GHz (PRB = 0)		Figure 2-2		V	3, 4, 0, 7, 0
	530/531	3 GHz (PRB = 0)					
	520/521	2.80 GHz (PRB = 0)					
		I _{CC} for processor with multiple VID					
	570/571	3.80 GHZ (PRB = 1)			119		
	560/561	3.60 GHz (PRB = 1)			119		
I _{CC}	550	3.40 GHz (PRB = 1)	_	_	119	Α	9
	550/551	3.40 GHz (PRB = 0)			78		
	540/541	3.20 GHz (PRB = 0)			78		
	530/531	3 GHz (PRB = 0)			78		
	520/521	2.80 GHz (PRB = 0)			78		
		I _{CC} Stop-Grant					
	570/571	3.80 GHZ (PRB = 1)			56		
	560/561	3.60 GHz (PRB = 1)			56		
I _{SGNT}	550	3.40 GHz (PRB = 1)	_	_	56	Α	10, 11, 15
	550/551	3.40 GHz (PRB = 0)			40		
	540/541	3.20 GHz (PRB = 0)			40		
	530/531	3 GHz (PRB = 0)			40		
	520/521	2.80 GHz (PRB = 0)			40		
		I _{CC} Enhanced Auto Halt					
	570/571	3.80 GHZ (PRB = 1)			37		
	560/561	3.60 GHz (PRB = 1)			37		
IENHANCED_AUTO_	550/551	3.40 GHz (PRB = 0)	_	_	31	Α	11, 15
HALT	540/541	3.20 GHz (PRB = 0)			31		
	530/531	3 GHz (PRB = 0)			40		
	520/521	2.80 GHz (PRB = 0)			40		
I _{TCC}	I _{CC} TCC active		1	_	I _{cc}	Α	12
V _{TT}	FSB termination volta	ge (DC+AC specifications)	1.14	1.20	1.26	V	13, 14
VTT_OUT I _{CC}	DC Current that may	be drawn from VTT_OUT per pin		_	580	mA	
I _{TT}	FSB termination curre	ent	_	_	3.5	Α	15, 16



Table 2-8. Voltage and Current Specifications (Sheet 2 of 2)

Symbol	Parameter	Min	Тур	Max	Unit	Notes ¹
I _{CC_VCCA}	I _{CC FOR PLL LANDS}	_	_	120	mA	15
I _{CC_VCCIOPLL}	I _{CC FOR I/O PLL LAND}	_	_	100	mA	15
I _{CC_GTLREF}	I _{CC} for GTLREF	_	_	200	μΑ	15

- Unless otherwise noted, all specifications in this table are based on estimates and simulations or empirical data. These specifications will be updated with characterized data from silicon measurements at a later date.
- Each processor is programmed with a maximum valid voltage identification value (VID), which is set at manufacturing and can not be altered. Individual maximum VID values are calibrated during manufacturing such that two processors at the same frequency may have different settings within the VID range. Note this differs from the VID employed by the processor during a power management event (Thermal Monitor 2 or Enhanced HALT State).
- These voltages are targets only. A variable voltage source should exist on systems in the event that a different voltage is required. See Section 2.4 and Table 2-2 for more information.
- The voltage specification requirements are measured across VCC_SENSE and VSS_SENSE lands at the socket with a 100 MHz bandwidth oscilloscope, 1.5 pF maximum probe capacitance, and 1 $M\Omega$ minimum impedance. The maximum length of ground wire on the probe should be less than 5 mm. Ensure external noise from the system is not coupled into the oscilloscope probe.
- Refer to Table 2-10 and Figure 2-3 for the minimum, typical, and maximum V_{CC} allowed for a given current. The processor should not be subjected to any Vcc and Icc combination wherein V_{CC} exceeds V_{cc_max} for a given current.

 775_VR_CONFIG_04A and 775_VR_CONFIG_04B refer to voltage regulator configurations that are defined in the *Voltage Regulator Down*
- 6. (VRD) 10.1 Design Guide For Desktop LGA775 Socket.
- 7 Refer to Table 2-9 and Figure 2-2 for the minimum, typical, and maximum V_{CC} allowed for a given current. The processor should not be subjected
- to any V_{CC} and I_{CC} combination wherein V_{CC} exceeds V_{CC} max for a given current. These frequencies will operate in a system designed for 775_VR_CONFIG_04B processors. The power and I_{CC} will be incrementally higher in 8. this configuration due to the improved loadline and resulting higher V_{CC}.
- $\rm I_{\rm cc_max}$ is specified at $\rm V_{\rm CC_max}.$ The current specified is also for AutoHALT State. 10
- Icc Stop-Grant and I $_{CC}$ Enhanced Auto Halt are specified at V_{CC_max} .
- The maximum instantaneous current the processor will draw while the thermal control circuit is active as indicated by the assertion of PROCHOT# is the same as the maximum Icc for the processor.
- V_{TT} must be provided via a separate voltage source and not be connected to V_{CC}. This specification is measured at the land.
- Baseboard bandwidth is limited to 20 MHz.
- These parameters are based on design characterization and are not tested.
- This is maximum total current drawn from V_{TT} plane by only the processor. This specification does not include the current coming from R_{TT} (through the signal line). Refer to the Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket to determine the total I_{TT} drawn by the system.



Table 2-9. V_{CC} Static and Transient Tolerance for 775_VR_CONFIG_04A Processors

	Voltage Deviation from VID Setting (V) ^{1, 2, 3, 4}					
I _{CC} (A)	Maximum Voltage 1.70 mΩ	Typical Voltage 1.75 mΩ	Minimum Voltage 1.80 mΩ			
0	0.000	-0.025	-0.050			
5	-0.009	-0.034	-0.059			
10	-0.017	-0.043	-0.068			
15	-0.026	-0.051	-0.077			
20	-0.034	-0.060	-0.086			
25	-0.043	-0.069	-0.095			
30	-0.051	-0.078	-0.104			
35	-0.060	-0.086	-0.113			
40	-0.068	-0.095	-0.122			
45	-0.077	-0.104	-0.131			
50	-0.085	-0.113	-0.140			
55	-0.094	-0.121	-0.149			
60	-0.102	-0.130	-0.158			
65	-0.111	-0.139	-0.167			
70	-0.119	-0.148	-0.176			
75	-0.128	-0.156	-0.185			
78	-0.133	-0.162	-0.190			

The loadline specification includes both static and transient limits except for overshoot allowed as shown in

Section 2.12.

This table is intended to aid in reading discrete points on Figure 2-2.

The loadlines specify voltage limits at the die measured at the VCC_SENSE and VSS_SENSE lands. Voltage regulation feedback for voltage regulator circuits must be taken from processor V_{CC} and V_{SS} lands. Refer to the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket* for socket loadline guidelines and VR implementation details.

Adherence to this loadline specification for the processor is required to ensure reliable processor operation.



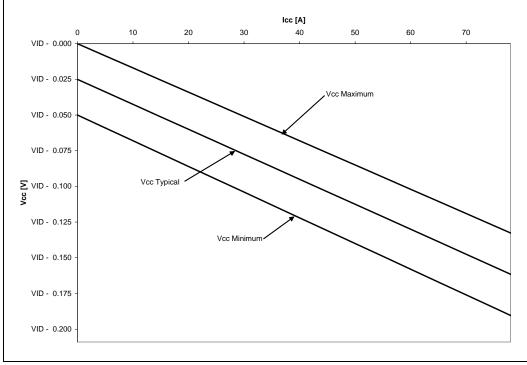


Figure 2-2. V_{CC} Static and Transient Tolerance for 775_VR_CONFIG_04A

- The loadline specification includes both static and transient limits except for overshoot allowed as shown in Section 2.12.
 This loadline specification shows the deviation from the VID set point.
 The loadlines specify voltage limits at the die measured at the VCC_SENSE and VSS_SENSE lands. Voltage regulation feedback for voltage regulator circuits must be taken from processor V_{CC} and V_{SS} lands. Refer to the Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket for socket loadline guidelines and VR implementation details.
 Adherence to this loadline specification for the processor is required to ensure reliable processor operation.



Table 2-10. V_{CC} Static and Transient Tolerance for 775_VR_CONFIG_04B Processors

	Voltage Deviation from VID Setting (V) ^{1, 2, 3, 4}					
I _{CC} (A)	Maximum Voltage 1.30 mΩ	Typical Voltage 1.35 m Ω	Minimum Voltage 1.40 mΩ			
0	0.000	-0.019	-0.038			
5	-0.007	-0.026	-0.045			
10	-0.013	-0.033	-0.052			
15	-0.020	-0.039	-0.059			
20	-0.026	-0.046	-0.066			
25	-0.033	-0.053	-0.073			
30	-0.039	-0.060	-0.080			
35	-0.046	-0.066	-0.087			
40	-0.052	-0.073	-0.094			
45	-0.059	-0.080	-0.101			
50	-0.065	-0.087	-0.108			
55	-0.072	-0.093	-0.115			
60	-0.078	-0.100	-0.122			
65	-0.085	-0.107	-0.129			
70	-0.091	-0.114	-0.136			
75	-0.098	-0.120	-0.143			
80	-0.104	-0.127	-0.150			
85	-0.111	-0.134	-0.157			
90	-0.117	-0.141	-0.164			
95	-0.124	-0.147	-0.171			
100	-0.130	-0.154	-0.178			
105	-0.137	-0.161	-0.185			
110	-0.143	-0.168	-0.192			
115	-0.150	-0.174	-0.199			
119	-0.155	-0.180	-0.205			

- The loadline specification includes both static and transient limits except for overshoot allowed as shown in
- This table is intended to aid in reading discrete points on Figure 2-2.

 The loadlines specify voltage limits at the die measured at the VCC_SENSE and VSS_SENSE lands. Voltage regulation feedback for voltage regulator circuits must be taken from processor V_{CC} and V_{SS} lands. Refer to the *Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket for socket loadline guide*lines and VR implementation details.
- Adherence to this loadline specification for the processor is required to ensure reliable processor operation.



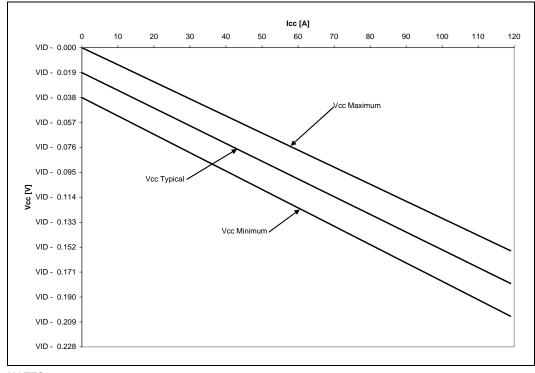


Figure 2-3. V_{CC} Static and Transient Tolerance for 775_VR_CONFIG_04B

- The loadline specification includes both static and transient limits except for overshoot allowed as shown in Section 2.12.
 This loadline specification shows the deviation from the VID set point.
 The loadlines specify voltage limits at the die measured at the VCC_SENSE and VSS_SENSE lands. Voltage regulation feedback for voltage regulator circuits must be taken from processor V_{CC} and V_{SS} lands. Refer to the Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket for socket loadline guidelines and VR implementation details.
 Adherence to this loadline specification for the processor is required to ensure reliable processor operation.



Table 2-11. GTL+ Asynchronous Signal Group DC Specifications

Symbol	Parameter	Min	Max	Unit	Notes ¹
V_{IL}	Input Low Voltage	0.0	V _{TT} /2 – (0.10 * V _{TT})	V	2, 3
V _{IH}	Input High Voltage	V _{TT} /2 + (0.10 * V _{TT})	V _{TT}	V	3, 4, 5, 6
V _{OH}	Output High Voltage	0.90*V _{TT}	V _{TT}	V	5, 6, 7
I _{OL}	Output Low Current	_	V _{TT} /[(0.50*R _{TT_MIN}) + R _{ON_MIN}]	Α	8
ILI	Input Leakage Current	N/A	± 200	μΑ	9
I _{LO}	Output Leakage Current	N/A	± 200	μΑ	10
R _{ON}	Buffer On Resistance	8	12	Ω	-

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- V_{IL} is defined as the voltage range at a receiving agent that will be interpreted as a logical low value.
- $LI\bar{N}TO/INTR$ and LINT1/NMI use GTLREF as a reference voltage. For these two signals V_{IH} = GTLREF + $(0.10*V_{TT})$ and V_{IL}= GTLREF - (0.10 * V_{TT}).
- V_{IH} is defined as the voltage range at a receiving agent that will be interpreted as a logical high value.
- V_{IH} and V_{OH} may experience excursions above V_{TT} . However, input signal drivers must comply with the signal quality spec-
- The V_{TT} referred to in these specifications refers to instantaneous V_{TT} .
- All outputs are open drain.
- The maximum output current is based on maximum current handling capability of the buffer and is not specified into the test
- Leakage to V_{SS} with land held at V_{TT}.
- Leakage to V_{TT} with land held at 300 mV.

Table 2-12. GTL+ Signal Group DC Specifications

Symbol	Parameter	Min	Max	Unit	Notes ¹
V _{IL}	Input Low Voltage	0.0	GTLREF – (0.10 * V _{TT})	V	2, 3
V _{IH}	Input High Voltage	GTLREF + (0.10 * V _{TT})	V_{TT}	V	3, 4
V _{OH}	Output High Voltage	0.90*V _{TT}	V_{TT}	V	3
I _{OL}	Output Low Current	N/A	V _{TT} /[(0.50*R _{TT_MIN}) + R _{ON_MIN}]	Α	-
I _{LI}	Input Leakage Current	N/A	± 200	μΑ	5
I _{LO}	Output Leakage Current	N/A	± 200	μA	-
R _{ON}	Buffer On Resistance	8	12	Ω	-

NOTES:

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- V_{IL} is defined as the voltage range at a receiving agent that will be interpreted as a logical low value.
- The V_{TT} referred to in these specifications is the instantaneous V_{TT} . V_{IH} is defined as the voltage range at a receiving agent that will be interpreted as a logical high value.
- Leakage to V_{SS} with land held at V_{TT}.



Table 2-13. PWRGOOD and TAP Signal Group DC Specifications

Symbol	Parameter	Min	Max	Unit	Notes ^{1, 2}
V _{HYS}	Input Hysteresis	200	350	mV	3
V _{T+}	Input low to high threshold voltage	0.5 * (V _{TT} + V _{HYS_MIN)}	0.5 * (V _{TT} + V _{HYS_MAX})	V	4
V _{T-}	Input high to low threshold voltage	0.5 * (V _{TT} – V _{HYS_MAX})	0.5 * (V _{TT} – V _{HYS_MIN})	V	4
V _{OH}	Output High Voltage	N/A	V _{TT}	V	4
I _{OL}	Output Low Current	_	45	mA	5
I _{LI}	Input Leakage Current	_	± 200	μA	6
I _{LO}	Output Leakage Current	_	± 200	μΑ	-
R _{ON}	Buffer On Resistance	7	12	Ω	-

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- All outputs are open drain.
- V_{HYS} represents the amount of hysteresis, nominally centered about 0.5 * V_{TT} , for all TAP inputs.
- The V_{TT} referred to in these specifications refers to instantaneous V_{TT}.
- The maximum output current is based on maximum current handling capability of the buffer and is not specified into the test
- Leakage to V_{SS} with land held at V_{TT}.

Table 2-14. VTTPWRGD DC Specifications

Symbol	Parameter	Min	Тур	Max	Unit	Notes
V_{IL}	Input Low Voltage	_	_	0.3	V	
V_{IH}	Input High Voltage	0.9			V	

Table 2-15. BSEL [2:0] and VID[5:0] DC Specifications

Symbol	Parameter	Max	Unit	Notes ^{1, 2}
R _{ON} (BSEL)	Buffer On Resistance	60	Ω	_
R _{ON} (VID)	Buffer On Resistance	60	Ω	_
I _{OL}	Max Land Current	8	mA	_
I _{LO}	Output Leakage Current	200	μΑ	3
V _{TOL}	Voltage Tolerance	V _{TT} (max)	V	_

NOTES:

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- These parameters are not tested and are based on design simulations. Leakage to $V_{\rm SS}$ with land held at 2.5 V.

Table 2-16. BOOTSELECT DC Specifications

Symbol	Parameter	Min	Тур	Max	Unit	Notes
V _{IL}	Input Low Voltage	_	_	0.24	V	1
V _{IH}	Input High Voltage	0.96	_	_	V	_

NOTES:

1. These parameters are not tested and are based on design simulations.



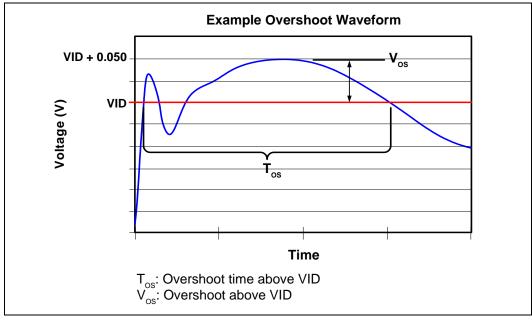
V_{CC} Overshoot Specification

The Pentium 4 processor in the 775-land package can tolerate short transient overshoot events where V_{CC} exceeds the VID voltage when transitioning from a high to low current load condition. This overshoot cannot exceed VID + V_{OS_MAX} (V_{OS_MAX} is the maximum allowable overshoot voltage). The time duration of the overshoot event must not exceed T_{OS_MAX} (T_{OS_MAX} is the maximum allowable time duration above VID). These specifications apply to the processor die voltage as measured across the VCC_SENSE and VSS_SENSE lands.

Table 2-17. V_{CC} Overshoot Specifications

Symbol	Parameter	Min	Тур	Max	Unit	Figure
V _{OS_MAX}	Magnitude of V _{CC} overshoot above VID	_	_	0.050	V	2-4
T _{OS_MAX}	Time duration of V _{CC} overshoot above VID	_	_	25	μs	2-4

Figure 2-4. V_{CC} Overshoot Example Waveform



NOTES:

- V_{OS} is measured overshoot voltage.
 T_{OS} is measured time duration above VID.

2.12.1 **Die Voltage Validation**

Overshoot events from application testing on real processors must meet the specifications in Table 2-17 when measured across the VCC_SENSE and VSS_SENSE lands. Overshoot events that are < 10 ns in duration may be ignored. These measurements of processor die level overshoot should be taken with a 100 MHz bandwidth limited oscilloscope. Refer to the Voltage Regulator Down (VRD) 10.1 Design Guide For Desktop LGA775 Socket for additional voltage regulator validation details.



2.13 **GTL+ FSB Specifications**

Termination resistors are not required for most GTL+ signals, as these are integrated into the processor silicon. Valid high and low levels are determined by the input buffers which compare a signal's voltage with a reference voltage called GTLREF. Table 2-18 lists the GTLREF specifications. The GTL+ reference voltage (GTLREF) should be generated on the system board using high precision voltage divider circuits.

Table 2-18. GTL+ Bus Voltage Definitions

Symbol	Parameter	Min	Тур Мах		Units	Notes ¹
GTLREF	Bus Reference Voltage	(0.98 * 0.67) * V _{TT}	0.67 * V _{TT}	(1.02 * 0.67) * V _{TT}	V	2, 3, 4, 5
R _{PULLUP}	On die pullup for BOOTSELECT signal	500	_	5000	Ω	6
R _{TT}	Termination Resistance	54	60	66	Ω	7
COMP[1:0]	COMP Resistance	59.8	60.4	61	Ω	8

NOTES:

- Unless otherwise noted, all specifications in this table apply to all processor frequencies.
- The tolerances for this specification have been stated generically to enable the system designer to calculate the minimum and maximum values across the range of $V_{\mbox{\scriptsize TT}}$.
- GTLREF should be generated from V_{TT} by a voltage divider of 1% resistors or 1% matched resistors.
- The V_{TT} referred to in these specifications is the instantaneous V_{TT} . The Intel® 915G/915GV/915P and 910GL Express chipset platforms use a pull-up resistor of 100 Ω and a pull-down resistor 5. of 210 $\Omega.$ Contact your Intel representative for further details and documentation.
- These pull-ups are to V_{TT} .
- R_{TT} is the on-die termination resistance measured at $V_{TT}/2$ of the GTL+ output driver.
- COMP resistance must be provided on the system board with 1% resistors. COMP[1:0] resistors are to VSS.



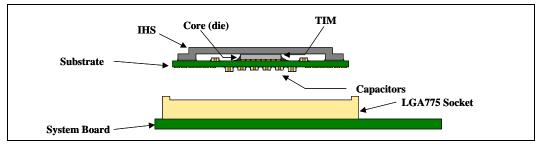
3 Package Mechanical Specifications

The Pentium 4 processor in the 775-land package is packaged in a Flip-Chip Land Grid Array (FC-LGA4) package that interfaces with the motherboard via an LGA775 socket. The package consists of a processor core mounted on a substrate land-carrier. An integrated heat spreader (IHS) is attached to the package substrate and core and serves as the mating surface for processor component thermal solutions, such as a heatsink. Figure 3-1 shows a sketch of the processor package components and how they are assembled together. Refer to the *LGA775 Socket Mechanical Design Guide* for complete details on the LGA775 socket.

The package components shown in Figure 3-1 include the following:

- Integrated Heat Spreader (IHS)
- Thermal Interface Material (TIM)
- Processor core (die)
- · Package substrate
- Capacitors

Figure 3-1. Processor Package Assembly Sketch



NOTE:

1. Socket and motherboard are included for reference and are not part of processor package.

3.1 Package Mechanical Drawing

The package mechanical drawings are shown in Figure 3-2 and Figure 3-4. The drawings include dimensions necessary to design a thermal solution for the processor. These dimensions include:

- Package reference with tolerances (total height, length, width, etc.)
- IHS parallelism and tilt
- · Land dimensions
- Top-side and back-side component keep-out dimensions
- · Reference datums

All drawing dimensions are in mm [in].

Note: Guidelines on potential IHS flatness variation with socket load plate actuation and installation of the cooling solution is available in the processor Thermal/Mechanical Design Guidelines.



Figure 3-2. Processor Package Drawing 1

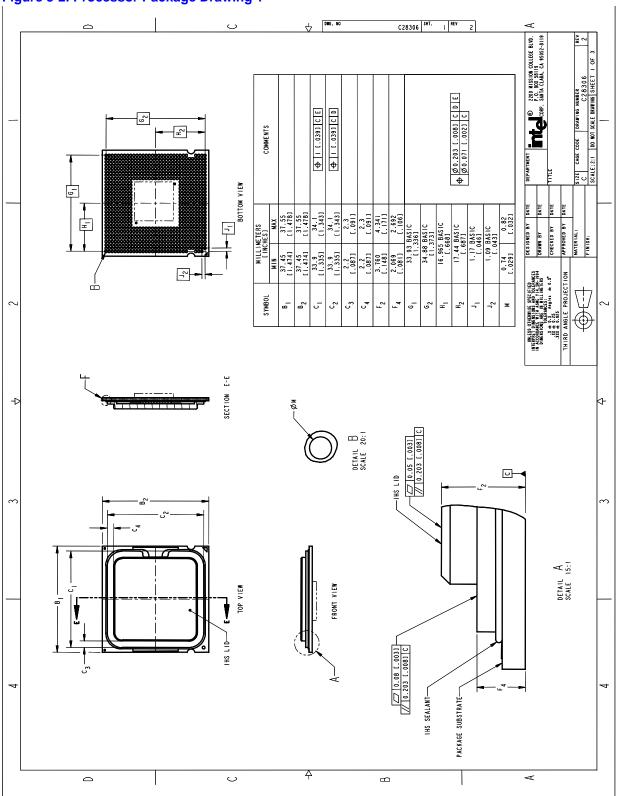




Figure 3-3. Processor Package Drawing 2

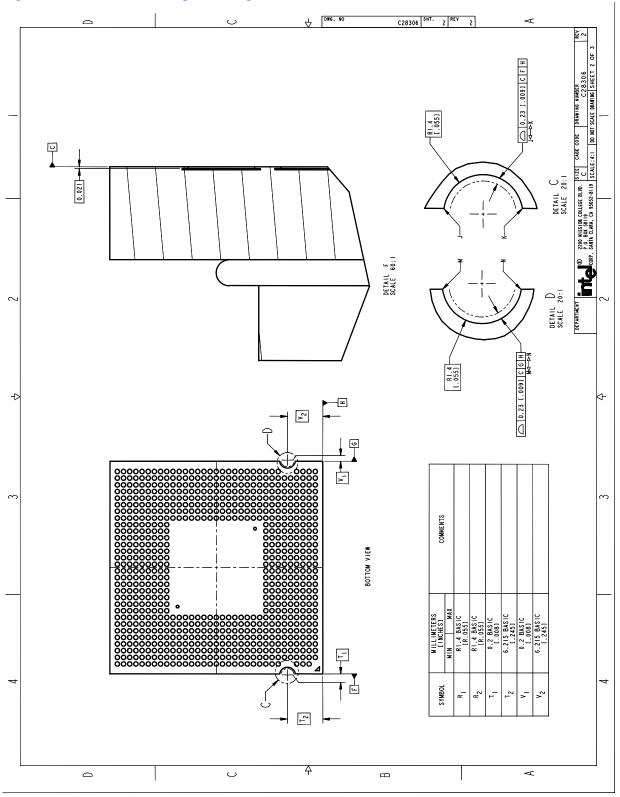
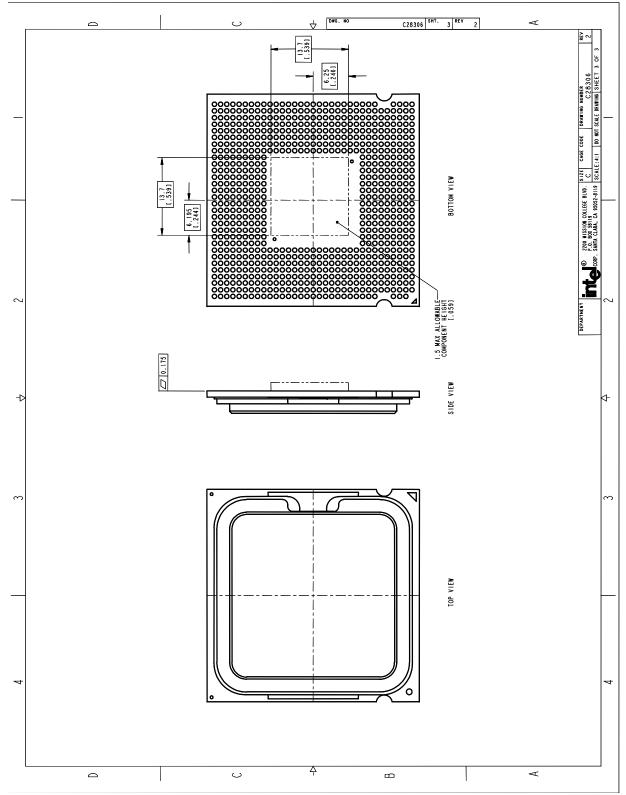




Figure 3-4. Processor Package Drawing 3





3.2 Processor Component Keep-Out Zones

The processor may contain components on the substrate that define component keep-out zone requirements. A thermal and mechanical solution design must not intrude into the required keep-out zones. Decoupling capacitors are typically mounted to either the topside or land-side of the package substrate. See Figure 3-2 and Figure 3-3 for keep-out zones.

The location and quantity of package capacitors may change due to manufacturing efficiencies but will remain within the component keep-in.

3.3 Package Loading Specifications

Table 3-1 provides dynamic and static load specifications for the processor package. These mechanical maximum load limits should not be exceeded during heatsink assembly, shipping conditions, or standard use condition. Also, any mechanical system or component testing should not exceed the maximum limits. The processor package substrate should not be used as a mechanical reference or load-bearing surface for thermal and mechanical solution. The minimum loading specification must be maintained by any thermal and mechanical solutions.

Table 3-1. Processor Loading Specifications

Parameter	Minimum	Maximum	Notes
Static	80 N [18 lbf]	311 N [70 lbf]	1, 2, 3
Dynamic	_	756 N [170 lbf]	1, 3, 4

NOTES:

- 1. These specifications apply to uniform compressive loading in a direction normal to the processor IHS.
- This is the maximum force that can be applied by a heatsink retention clip. The clip must also provide the minimum specified load on the processor package.
- These specifications are based on limited testing for design characterization. Loading limits are for the package only and does not include the limits of the processor socket.
- Dynamic loading is defined as the sum of the load on the package from a 1 lb heatsink mass accelerating through a 11 ms trapezoidal pulse of 50 g and the maximum static load.

3.4 Package Handling Guidelines

Table 3-2 includes a list of guidelines on package handling in terms of recommended maximum loading on the processor IHS relative to a fixed substrate. These package handling loads may be experienced during heatsink removal.

Table 3-2. Package Handling Guidelines

Parameter	Maximum Recommended	Notes
Shear	311 N [70 lbf]	1, 4
Tensile	111 N [25 lbf]	2, 4
Torque	3.95 N-m [35 lbf-in]	3, 4

NOTES:

- 1. A shear load is defined as a load applied to the IHS in a direction parallel to the IHS top surface.
- A tensile load is defined as a pulling load applied to the IHS in a direction normal to the IHS surface.
- 3. A torque load is defined as a twisting load applied to the IHS in an axis of rotation normal to the IHS top surface.
- 4. These guidelines are based on limited testing for design characterization.



3.5 Package Insertion Specifications

The Pentium 4 processor in the 775-land package can be inserted into and removed from a LGA775 socket 15 times. The socket should meet the LGA775 requirements detailed in the LGA775 Socket Mechanical Design Guide.

3.6 Processor Mass Specification

The typical mass of the Pentium 4 processor in the 775-land package is 21.5 g [0.76 oz]. This mass [weight] includes all the components that are included in the package.

3.7 Processor Materials

Table 3-3 lists some of the package components and associated materials.

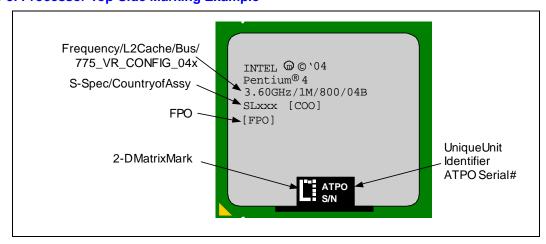
Table 3-3. Processor Materials

Component	Material		
Integrated Heat Spreader (IHS)	Nickel Plated Copper		
Substrate	Fiber Reinforced Resin		
Substrate Lands	Gold Plated Copper		

3.8 Processor Markings

Figure 3-5 and Figure 3-6 show the topside markings on the processor. These diagrams aid in the identification of the Pentium 4 processor in the 775-land package.

Figure 3-5. Processor Top-Side Marking Example





ProcessorNumber/S-Spec/
CountryofAssy

Frequency/L2Cache/Bus/
775_VR_CONFIG_04x
FPO

2-DMatrixMark

Pentium® 4
571 SLxxx [COO]
3.80GHZ/1M/800/04B

[FPO]

UniqueUnit Identifier
ATPO Serial#

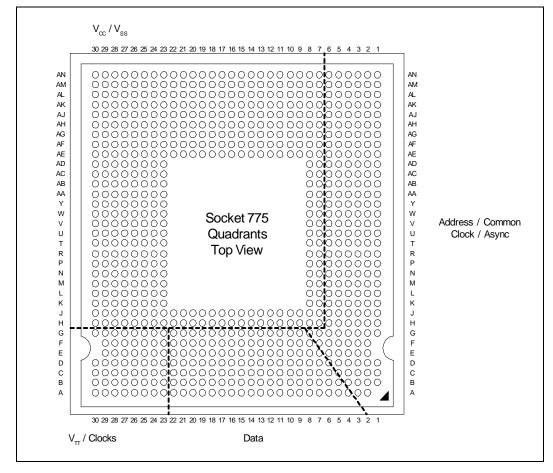
Figure 3-6. Processor Top-Side Marking Example for Processors Supporting Intel® EM64T

3.9 Processor Land Coordinates

Figure 3-7 shows the top view of the processor land coordinates. The coordinates are referred to throughout the document to identify processor lands.



Figure 3-7. Processor Land Coordinates (Top View)



§



4 Land Listing and Signal Descriptions

This chapter provides the processor land assignment and signal descriptions.

4.1 Processor Land Assignments

This section contains the land listings for the Pentium 4 processor in the 775-land package. The landout footprint is shown in Figure 4-1 and Figure 4-2. These figures represent the landout arranged by land number and they show the physical location of each signal on the package land array (top view). Table 4-1 is a listing of all processor lands ordered alphabetically by land (signal) name. Table 4-2 is also a listing of all processor lands; the ordering is by land number.



Figure 4-1. Landout Diagram (Top View – Left Side)

	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15
AN	VCC	vcc	VSS	VSS	vcc	VCC	VSS	VSS	vcc	vcc	VSS	vcc	VCC	VSS	VSS	vcc
АМ	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AL	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AK	VSS	VSS	VSS	VSS	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AJ	VSS	VSS	VSS	VSS	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
АН	VCC	VCC	VCC	VCC	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AG	VCC	VCC	VCC	VCC	VCC	VCC	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AF	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AE	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VCC	VCC	VCC	VSS	VCC	VCC	VSS	VSS	VCC
AD	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
AC	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
AB	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
AA	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
Υ	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
w	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
٧	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
U	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
Т	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
R	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
Р	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
N	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
М	VCC	vcc	vcc	VCC	vcc	VCC	vcc	VCC								
L	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS								
K	VCC	VCC	VCC	VCC	VCC	VCC	VCC	VCC								
J	VCC	vcc	VCC	vcc	VCC	VCC	VCC	VCC	VCC	vcc	vcc	vcc	VCC	DP3#	DP0#	vcc
Н	BSEL1	GTLREF _SEL	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	vss	VSS	VSS	DP2#	DP1#
G	BSEL2	BSEL0	BCLK1	TESTHI4	TESTHI5	TESTHI3	TESTHI6	RESET#	D47#	D44#	DSTBN2#	DSTBP2#	D35#	D36#	D32#	D31#
F		RSVD	BCLK0	VTT_SEL	TESTHI0	TESTHI2	TESTHI7	RSVD	VSS	D43#	D41#	VSS	D38#	D37#	VSS	D30#
E		VSS	VSS	VSS	VSS	VSS	RSVD	RSVD	D45#	D42#	VSS	D40#	D39#	VSS	D34#	D33#
D	VTT	VTT	VTT	VTT	VTT	VTT	VSS	RSVD	D46#	VSS	D48#	DBI2#	VSS	D49#	RSVD	VSS
С	VTT	VTT	VTT	VTT	VTT	VTT	VSS	VCCIO PLL	VSS	D58#	DBI3#	VSS	D54#	DSTBP3#	VSS	D51#
В	VTT	VTT	VTT	VTT	VTT	VTT	VSS	VSSA	D63#	D59#	VSS	D60#	D57#	VSS	D55#	D53#
Α	VTT	VTT	VTT	VTT	VTT	VTT	VSS	VCCA	D62#	VSS	RSVD	D61#	VSS	D56#	DSTBN3#	VSS
	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15



Figure 4-2. Landout Diagram (Top View – Right Side)

							_			_				_
	1	2	3	4	5	6	7	8	9	10	11	12	13	14
A	VSS	VSS	VCC_ SENSE	VSS_ SENSE	VCC_MB_ REGULATION	VSS_MB_ REGULATION	FC16	VCC	VCC	VSS	vcc	vcc	VSS	VCC
Al	VSS	VID0	VID2	VSS	FC11	VTTPWRGD	FC12	VCC	VCC	VSS	VCC	VCC	VSS	VCC
AI	THERMDA	PROCHOT#	VSS	VID5	VID1	VID3	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
Al	THERMDC	VSS	ITP_CLK0	VID4	VSS	RSVD	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
A	BPM1#	BPM0#	ITP_CLK1	VSS	A34#	A35#	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
Al	VSS	RSVD	VSS	A32#	A33#	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
A	TRST#	BPM3#	BPM5#	A30#	A31#	A29#	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
Al	TDO	BPM4#	VSS	A28#	A27#	VSS	VSS	VCC	VCC	VSS	VCC	VCC	VSS	VCC
Al	TCK	VSS	RSVD	RSVD	VSS	RSVD	VSS	SKTOCC#	VCC	VSS	VCC	VCC	VSS	VCC
ΑI	TDI	BPM2#	BINIT#	VSS	ADSTB1#	A22#	VSS	VCC						
A	TMS	DBR#	VSS	RSVD	A25#	VSS	VSS	VCC						
AI	VSS	IERR#	MCERR#	A26#	A24#	A17#	VSS	VCC						
A	VTT_OUT_ RIGHT	LL_ID1	VSS	A21#	A23#	VSS	VSS	vcc						
Y	BOOT SELECT	VSS	RSVD	A20#	VSS	A19#	VSS	vcc						
W	MSID0	TESTHI12	TESTHI1	VSS	A16#	A18#	VSS	VCC						
v	MSID1	LL_ID0	VSS	A15#	A14#	VSS	VSS	VCC						
U	VSS	AP0#	AP1#	A13#	A12#	A10#	VSS	VCC						
Т	COMP1	FC4	VSS	A11#	A9#	VSS	VSS	VCC						
R	FC2	VSS	FERR#/ PBE#	A8#	VSS	ADSTB0#	VSS	vcc						
Р	TESTHI11	SMI#	INIT#	VSS	RSVD	A4#	VSS	VCC						
N	PWRGOOD	IGNNE#	VSS	RSVD	RSVD	VSS	VSS	vcc						
М	VSS	THER- MTRIP#	STPCLK#	A7#	A5#	REQ2#	VSS	vcc						
L	LINT1	TESTHI13	VSS	A6#	A3#	VSS	VSS	vcc						
к	LINT0	VSS	A20M#	REQ0#	VSS	REQ3#	VSS	VCC						
J	VTT_OUT_ LEFT	FC3	RSVD	VSS	REQ1#	REQ4#	VSS	vcc	VCC	vcc	vcc	vcc	vcc	VCC
н	GTLREF	FC6	VSS	RSP#	TESTHI10	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS	VSS
G	VSS	FC1	TESTHI8	TESTHI9	FC7	RSVD	DEFER#	BPRI#	D16#	RSVD	DBI1#	DSTBN1#	D27#	D29#
F		FC5	BR0#	VSS	RS1#	RSVD	VSS	D17#	D18#	VSS	D23#	D24#	VSS	D28#
E		VSS	TRDY#	HITM#	RSVD	RSVD	RSVD	VSS	D19#	D21#	VSS	DSTBP1#	D26#	VSS
D	RSVD	ADS#	VSS	HIT#	VSS	VSS	D20#	D12#	VSS	D22#	D15#	VSS	D25#	RSVD
С	DRDY#	BNR#	LOCK#	VSS	D1#	D3#	VSS	DSTBN0#	RSVD	VSS	D11#	D14#	VSS	D52#
В	VSS	DBSY#	RS0#	D0#	VSS	D5#	D6#	VSS	DSTBP0#	D10#	VSS	D13#	RSVD	VSS
А		VSS	RS2#	D2#	D4#	VSS	D7#	DBI0#	VSS	D8#	D9#	VSS	COMP0	D50#
	1	2	3	4	5	6	7	8	9	10	11	12	13	14



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name Direction** Type L5 A3# Source Synch Input/Output P6 A4# Source Synch Input/Output A5# M5 Input/Output Source Synch A6# L4 Input/Output Source Synch M4 Input/Output A7# Source Synch A8# R4 Source Synch Input/Output A9# T5 Input/Output Source Synch A10# U6 Input/Output Source Synch A11# T4 Source Synch Input/Output A12# U5 Source Synch Input/Output U4 A13# Source Synch Input/Output A14# V5 Source Synch Input/Output A15# V4 Input/Output Source Synch A16# W5 Source Synch Input/Output A17# AB6 Source Synch Input/Output A18# W6 Input/Output Source Synch A19# Y6 Source Synch Input/Output Y4 A20# Source Synch Input/Output A20M# К3 Asynch GTL+ Input A21# AA4 Source Synch Input/Output A22# AD6 Input/Output Source Synch A23# AA5 Source Synch Input/Output A24# AB5 Source Synch Input/Output A25# AC5 Input/Output Source Synch A26# AB4 Source Synch Input/Output A27# AF5 Source Synch Input/Output A28# AF4 Source Synch Input/Output A29# AG6 Input/Output Source Synch A30# AG4 Source Synch Input/Output A31# AG5 Input/Output Source Synch A32# AH4 Input/Output Source Synch A33# AH5 Source Synch Input/Output A34# AJ5 Input/Output Source Synch AJ6 A35# Source Synch Input/Output ADS# D2 Common Clock Input/Output ADSTB0# R6 Source Synch Input/Output ADSTB1# AD5 Input/Output Source Synch AP0# U2 Common Clock Input/Output AP1# U3 Common Clock Input/Output BCLK0 F28 Clock Input

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction					
BCLK1	G28	Clock	Input					
BINIT#	AD3	Common Clock	Input/Output					
BNR#	C2	Common Clock	Input/Output					
BOOTSELECT	Y1	Power/Other	Input					
BPM0#	AJ2	Common Clock	Input/Output					
BPM1#	AJ1	Common Clock	Input/Output					
BPM2#	AD2	Common Clock	Input/Output					
BPM3#	AG2	Common Clock	Input/Output					
BPM4#	AF2	Common Clock	Input/Output					
BPM5#	AG3	Common Clock	Input/Output					
BPRI#	G8	Common Clock	Input					
BR0#	F3	Common Clock	Input/Output					
BSEL0	G29	Power/Other	Output					
BSEL1	H30	Power/Other	Output					
BSEL2	G30	Power/Other	Output					
COMP0	A13	Power/Other	Input					
COMP1	T1	Power/Other	Input					
D0#	B4	Source Synch	Input/Output					
D1#	C5	Source Synch	Input/Output					
D2#	A4	Source Synch	Input/Output					
D3#	C6	Source Synch	Input/Output					
D4#	A5	Source Synch	Input/Output					
D5#	B6	Source Synch	Input/Output					
D6#	В7	Source Synch	Input/Output					
D7#	A7	Source Synch	Input/Output					
D8#	A10	Source Synch	Input/Output					
D9#	A11	Source Synch	Input/Output					
D10#	B10	Source Synch	Input/Output					
D11#	C11	Source Synch	Input/Output					
D12#	D8	Source Synch	Input/Output					
D13#	B12	Source Synch	Input/Output					
D14#	C12	Source Synch	Input/Output					
D15#	D11	Source Synch	Input/Output					
D16#	G9	Source Synch	Input/Output					
D17#	F8	Source Synch	Input/Output					
D18#	F9	Source Synch	Input/Output					
D19#	E9	Source Synch	Input/Output					
D20#	D7	Source Synch	Input/Output					
D21#	E10	Source Synch	Input/Output					
D22#	D10	Source Synch	Input/Output					



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type F11 D23# Source Synch Input/Output D24# F12 Source Synch Input/Output D25# D13 Input/Output Source Synch D26# E13 Input/Output Source Synch G13 Input/Output D27# Source Synch D28# F14 Source Synch Input/Output D29# G14 Input/Output Source Synch F15 Input/Output D30# Source Synch D31# G15 Source Synch Input/Output D32# G16 Source Synch Input/Output D33# E15 Source Synch Input/Output D34# E16 Source Synch Input/Output D35# G18 Input/Output Source Synch G17 Input/Output D36# Source Synch D37# F17 Source Synch Input/Output D38# F18 Source Synch Input/Output D39# E18 Source Synch Input/Output E19 D40# Source Synch Input/Output D41# F20 Source Synch Input/Output D42# E21 Source Synch Input/Output D43# F21 Source Synch Input/Output D44# G21 Source Synch Input/Output D45# E22 Source Synch Input/Output D22 Input/Output D46# Source Synch D47# G22 Source Synch Input/Output D48# D20 Source Synch Input/Output D49# D17 Input/Output Source Synch D50# A14 Input/Output Source Synch D51# C15 Source Synch Input/Output D52# C14 Input/Output Source Synch B15 Input/Output D53# Source Synch D54# C18 Source Synch Input/Output D55# B16 Input/Output Source Synch A17 D56# Input/Output Source Synch D57# B18 Source Synch Input/Output D58# C21 Source Synch Input/Output B21 Input/Output D59# Source Synch D60# B19 Source Synch Input/Output D61# A19 Source Synch Input/Output D62# A22 Source Synch Input/Output

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
D63#	B22	Source Synch	Input/Output
DBI0#	A8	Source Synch	Input/Output
DBI1#	G11	Source Synch	Input/Output
DBI2#	D19	Source Synch	Input/Output
DBI3#	C20	Source Synch	Input/Output
DBR#	AC2	Power/Other	Output
DBSY#	B2	Common Clock	Input/Output
DEFER#	G7	Common Clock	Input
DP0#	J16	Common Clock	Input/Output
DP1#	H15	Common Clock	Input/Output
DP2#	H16	Common Clock	Input/Output
DP3#	J17	Common Clock	Input/Output
DRDY#	C1	Common Clock	Input/Output
DSTBN0#	C8	Source Synch	Input/Output
DSTBN1#	G12	Source Synch	Input/Output
DSTBN2#	G20	Source Synch	Input/Output
DSTBN3#	A16	Source Synch	Input/Output
DSTBP0#	В9	Source Synch	Input/Output
DSTBP1#	E12	Source Synch	Input/Output
DSTBP2#	G19	Source Synch	Input/Output
DSTBP3#	C17	Source Synch	Input/Output
FC1	G2	Power/Other	Input
FC2	R1	Power/Other	Input
FC3	J2	Power/Other	Input
FC4	T2	Power/Other	Input
FC5	F2	Common Clock	Input
FC6	H2	Power/Other	Input
FC7	G5	Source Synch	Output
FC11	AM5	Power/Other	Output
FC12	AM7	Power/Other	Output
FC16	AN7	Power/Other	Output
FERR#/PBE#	R3	Asynch GTL+	Output
GTLREF	H1	Power/Other	Input
GTLREF_SEL	H29	Power/Other	Output
HIT#	D4	Common Clock	Input/Output
HITM#	E4	Common Clock	Input/Output
IERR#	AB2	Asynch GTL+	Output
IGNNE#	N2	Asynch GTL+	Input
INIT#	P3	Asynch GTL+	Input
ITP_CLK0	AK3	TAP	Input



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type ITP_CLK1 AJ3 TAP Input LINT0 Asynch GTL+ K1 Input LINT1 L1 Asynch GTL+ Input LL_ID0 V2 Power/Other Output LL_ID1 AA2 Power/Other Output LOCK# СЗ Common Clock Input/Output MCERR# AB3 Common Clock Input/Output MSID0 W1 Power/Other Output MSID1 V1 Power/Other Output PROCHOT# AL2 Asynch GTL+ Input/Output **PWRGOOD** N1 Power/Other Input REQ0# K4 Input/Output Source Synch REQ1# J5 Source Synch Input/Output M6 REQ2# Input/Output Source Synch REQ3# K6 Source Synch Input/Output REQ4# J6 Source Synch Input/Output RESERVED A20 RESERVED AC4 RESERVED AE3 RESERVED AE4 RESERVED AE6 **RESERVED** AH2 RESERVED C9 RESERVED D1 RESERVED D14 RESERVED D16 RESERVED E23 RESERVED E24 RESERVED E5 RESERVED E6 **RESERVED** E7 RESERVED F23 **RESERVED** F29 RESERVED F6 RESERVED G10 RESERVED B13 **RESERVED** J3 RESERVED N4 RESERVED N5 RESERVED P5

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
RESERVED	Y3		
RESERVED	D23		
RESERVED	AK6		
RESERVED	G6		
RESET#	G23	Common Clock	Input
RS0#	В3	Common Clock	Input
RS1#	F5	Common Clock	Input
RS2#	А3	Common Clock	Input
RSP#	H4	Common Clock	Input
SKTOCC#	AE8	Power/Other	Output
SMI#	P2	Asynch GTL+	Input
STPCLK#	МЗ	Asynch GTL+	Input
TCK	AE1	TAP	Input
TDI	AD1	TAP	Input
TDO	AF1	TAP	Output
TESTHI0	F26	Power/Other	Input
TESTHI1	W3	Power/Other	Input
TESTHI2	F25	Power/Other	Input
TESTHI3	G25	Power/Other	Input
TESTHI4	G27	Power/Other	Input
TESTHI5	G26	Power/Other	Input
TESTHI6	G24	Power/Other	Input
TESTHI7	F24	Power/Other	Input
TESTHI8	G3	Power/Other	Input
TESTHI9	G4	Power/Other	Input
TESTHI10	H5	Power/Other	Input
TESTHI11	P1	Power/Other	Input
TESTHI12	W2	Power/Other	Input
TESTHI13	L2	Asynch GTL+	Input
THERMDA	AL1	Power/Other	
THERMDC	AK1	Power/Other	
THERMTRIP#	M2	Asynch GTL+	Output
TMS	AC1	TAP	Input
TRDY#	E3	Common Clock	Input
TRST#	AG1	TAP	Input
VCC	AA8	Power/Other	
VCC	AB8	Power/Other	
VCC	AC23	Power/Other	
VCC	AC24	Power/Other	
VCC	AC25	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type VCC AC26 Power/Other VCC AC27 Power/Other VCC AC28 Power/Other VCC AC29 Power/Other VCC AC30 Power/Other VCC AC8 Power/Other VCC AD23 Power/Other VCC AD24 Power/Other VCC AD25 Power/Other VCC AD26 Power/Other VCC AD27 Power/Other VCC AD28 Power/Other VCC AD29 Power/Other VCC AD30 Power/Other VCC AD8 Power/Other VCC AE11 Power/Other VCC AE12 Power/Other VCC AE14 Power/Other VCC AE15 Power/Other VCC AE18 Power/Other VCC AE19 Power/Other VCC AE21 Power/Other VCC AE22 Power/Other VCC AE23 Power/Other VCC AE9 Power/Other VCC AF11 Power/Other VCC AF12 Power/Other VCC AF14 Power/Other VCC AF15 Power/Other VCC AF18 Power/Other AF19 VCC Power/Other VCC AF21 Power/Other VCC AF22 Power/Other VCC AF8 Power/Other VCC AF9 Power/Other VCC AG11 Power/Other VCC AG12 Power/Other VCC AG14 Power/Other VCC AG15 Power/Other VCC AG18 Power/Other

Table 4-1. Alphabetical Land Assignments

Assignments								
Land Name	Land #	Signal Buffer Type	Direction					
VCC	AG19	Power/Other						
VCC	AG21	Power/Other						
VCC	AG22	Power/Other						
VCC	AG25	Power/Other						
VCC	AG26	Power/Other						
VCC	AG27	Power/Other						
VCC	AG28	Power/Other						
VCC	AG29	Power/Other						
VCC	AG30	Power/Other						
VCC	AG8	Power/Other						
VCC	AG9	Power/Other						
VCC	AH11	Power/Other						
VCC	AH12	Power/Other						
VCC	AH14	Power/Other						
VCC	AH15	Power/Other						
VCC	AH18	Power/Other						
VCC	AH19	Power/Other						
VCC	AH21	Power/Other						
VCC	AH22	Power/Other						
VCC	AH25	Power/Other						
VCC	AH26	Power/Other						
VCC	AH27	Power/Other						
VCC	AH28	Power/Other						
VCC	AH29	Power/Other						
VCC	AH30	Power/Other						
VCC	AH8	Power/Other						
VCC	AH9	Power/Other						
VCC	AJ11	Power/Other						
VCC	AJ12	Power/Other						
VCC	AJ14	Power/Other						
VCC	AJ15	Power/Other						
VCC	AJ18	Power/Other						
VCC	AJ19	Power/Other						
VCC	AJ21	Power/Other						
VCC	AJ22	Power/Other						
VCC	AJ25	Power/Other						
VCC	AJ26	Power/Other						
VCC	AJ8	Power/Other						
VCC	AJ9	Power/Other						
VCC	AK11	Power/Other						



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name Direction** Type VCC AK12 Power/Other VCC AK14 Power/Other VCC AK15 Power/Other VCC AK18 Power/Other VCC AK19 Power/Other VCC AK21 Power/Other VCC AK22 Power/Other VCC AK25 Power/Other VCC AK26 Power/Other VCC AK8 Power/Other VCC AK9 Power/Other VCC AL11 Power/Other VCC AL12 Power/Other VCC AL14 Power/Other VCC AL15 Power/Other VCC AL18 Power/Other VCC AL19 Power/Other VCC AL21 Power/Other VCC AL22 Power/Other VCC AL25 Power/Other VCC AL26 Power/Other VCC AL29 Power/Other VCC AL30 Power/Other VCC AL8 Power/Other VCC AL9 Power/Other VCC AM11 Power/Other VCC AM12 Power/Other VCC AM14 Power/Other VCC AM15 Power/Other VCC AM18 Power/Other VCC AM19 Power/Other VCC AM21 Power/Other VCC AM22 Power/Other VCC AM25 Power/Other VCC AM26 Power/Other VCC AM29 Power/Other VCC AM30 Power/Other VCC AM8 Power/Other VCC AM9 Power/Other VCC AN11 Power/Other

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
VCC	AN12	Power/Other	
VCC	AN14	Power/Other	
VCC	AN15	Power/Other	
VCC	AN18	Power/Other	
VCC	AN19	Power/Other	
VCC	AN21	Power/Other	
VCC	AN22	Power/Other	
VCC	AN25	Power/Other	
VCC	AN26	Power/Other	
VCC	AN29	Power/Other	
VCC	AN30	Power/Other	
VCC	AN8	Power/Other	
VCC	AN9	Power/Other	
VCC	J10	Power/Other	
VCC	J11	Power/Other	
VCC	J12	Power/Other	
VCC	J13	Power/Other	
VCC	J14	Power/Other	
VCC	J15	Power/Other	
VCC	J18	Power/Other	
VCC	J19	Power/Other	
VCC	J20	Power/Other	
VCC	J21	Power/Other	
VCC	J22	Power/Other	
VCC	J23	Power/Other	
VCC	J24	Power/Other	
VCC	J25	Power/Other	
VCC	J26	Power/Other	
VCC	J27	Power/Other	
VCC	J28	Power/Other	
VCC	J29	Power/Other	
VCC	J30	Power/Other	
VCC	J8	Power/Other	
VCC	J9	Power/Other	
VCC	K23	Power/Other	
VCC	K24	Power/Other	
VCC	K25	Power/Other	
VCC	K26	Power/Other	
VCC	K27	Power/Other	
VCC	K28	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type VCC K29 Power/Other VCC K30 Power/Other VCC Power/Other VCC L8 Power/Other VCC M23 Power/Other VCC M24 Power/Other VCC M25 Power/Other VCC M26 Power/Other VCC M27 Power/Other VCC M28 Power/Other VCC M29 Power/Other VCC M30 Power/Other VCC M8 Power/Other VCC N23 Power/Other VCC N24 Power/Other VCC N25 Power/Other VCC N26 Power/Other VCC N27 Power/Other VCC N28 Power/Other VCC N29 Power/Other Power/Other VCC N30 VCC N8 Power/Other VCC P8 Power/Other VCC R8 Power/Other VCC T23 Power/Other VCC T24 Power/Other VCC T25 Power/Other VCC T26 Power/Other VCC T27 Power/Other VCC T28 Power/Other VCC T29 Power/Other VCC T30 Power/Other VCC T8 Power/Other Power/Other VCC U23 VCC U24 Power/Other VCC U25 Power/Other VCC U26 Power/Other VCC U27 Power/Other VCC U28 Power/Other VCC U29 Power/Other

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
VCC	U30	Power/Other	
VCC	U8	Power/Other	
VCC	V8	Power/Other	
VCC	W23	Power/Other	
VCC	W24	Power/Other	
VCC	W25	Power/Other	
VCC	W26	Power/Other	
VCC	W27	Power/Other	
VCC	W28	Power/Other	
VCC	W29	Power/Other	
VCC	W30	Power/Other	
VCC	W8	Power/Other	
VCC	Y23	Power/Other	
VCC	Y24	Power/Other	
VCC	Y25	Power/Other	
VCC	Y26	Power/Other	
VCC	Y27	Power/Other	
VCC	Y28	Power/Other	
VCC	Y29	Power/Other	
VCC	Y30	Power/Other	
VCC	Y8	Power/Other	
VCC_MB_ REGULATION	AN5	Power/Other	Output
VCC_SENSE	AN3	Power/Other	Output
VCCA	A23	Power/Other	
VCCIOPLL	C23	Power/Other	
VID0	AM2	Power/Other	Output
VID1	AL5	Power/Other	Output
VID2	AM3	Power/Other	Output
VID3	AL6	Power/Other	Output
VID4	AK4	Power/Other	Output
VID5	AL4	Power/Other	Output
VSS	A12	Power/Other	
VSS	A15	Power/Other	
VSS	A18	Power/Other	
VSS	A2	Power/Other	
VSS	A21	Power/Other	
VSS	A24	Power/Other	
VSS	A6	Power/Other	
VSS	A9	Power/Other	
VSS	AA23	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name Direction** Type AA24 VSS Power/Other VSS Power/Other AA25 VSS AA26 Power/Other VSS AA27 Power/Other VSS AA28 Power/Other VSS AA29 Power/Other VSS AA3 Power/Other VSS AA30 Power/Other VSS AA6 Power/Other VSS AA7 Power/Other VSS AB1 Power/Other VSS AB23 Power/Other VSS AB24 Power/Other VSS AB25 Power/Other VSS AB26 Power/Other VSS AB27 Power/Other VSS AB28 Power/Other VSS AB29 Power/Other VSS AB30 Power/Other VSS AB7 Power/Other VSS AC3 Power/Other VSS AC6 Power/Other VSS AC7 Power/Other VSS AD4 Power/Other VSS AD7 Power/Other VSS AE10 Power/Other VSS AE13 Power/Other VSS AE16 Power/Other VSS AE17 Power/Other VSS AE2 Power/Other AE20 VSS Power/Other VSS AE24 Power/Other VSS AE25 Power/Other VSS AE26 Power/Other VSS AE27 Power/Other VSS AE28 Power/Other VSS AE29 Power/Other VSS AE30 Power/Other VSS AE5 Power/Other VSS AE7 Power/Other

Table 4-1. Alphabetical Land Assignments

VSS AF10 Power/Other VSS AF13 Power/Other VSS AF16 Power/Other VSS AF17 Power/Other VSS AF20 Power/Other VSS AF23 Power/Other VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF30 Power/Other VSS AF3 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG20 Power/Other VSS AG7 Power/Other VSS AH1<	Land Name	Land #	Signal Buffer Type	Direction
VSS AF16 Power/Other VSS AF17 Power/Other VSS AF20 Power/Other VSS AF23 Power/Other VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF30 Power/Other VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG21 Power/Other VSS AG22 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH1<	VSS	AF10	Power/Other	
VSS AF17 Power/Other VSS AF20 Power/Other VSS AF23 Power/Other VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF39 Power/Other VSS AF30 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG20 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH20	VSS	AF13	Power/Other	
VSS AF20 Power/Other VSS AF23 Power/Other VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF3 Power/Other VSS AF3 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG20 Power/Other VSS AG21 Power/Other VSS AG7 Power/Other VSS AH10 Power/Other VSS AH11 Power/Other VSS AH20 </td <td>VSS</td> <td>AF16</td> <td>Power/Other</td> <td></td>	VSS	AF16	Power/Other	
VSS AF23 Power/Other VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF30 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH20 Power/Other VSS AH23	VSS	AF17	Power/Other	
VSS AF24 Power/Other VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG20 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH24<	VSS	AF20	Power/Other	
VSS AF25 Power/Other VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF3 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH3 <td>VSS</td> <td>AF23</td> <td>Power/Other</td> <td></td>	VSS	AF23	Power/Other	
VSS AF26 Power/Other VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 </td <td>VSS</td> <td>AF24</td> <td>Power/Other</td> <td></td>	VSS	AF24	Power/Other	
VSS AF27 Power/Other VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG21 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH24 Power/Other VSS AH3 </td <td>VSS</td> <td>AF25</td> <td>Power/Other</td> <td></td>	VSS	AF25	Power/Other	
VSS AF28 Power/Other VSS AF29 Power/Other VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG16 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH6 <td>VSS</td> <td>AF26</td> <td>Power/Other</td> <td></td>	VSS	AF26	Power/Other	
VSS AF39 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 <td>VSS</td> <td>AF27</td> <td>Power/Other</td> <td></td>	VSS	AF27	Power/Other	
VSS AF3 Power/Other VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ10 <td>VSS</td> <td>AF28</td> <td>Power/Other</td> <td></td>	VSS	AF28	Power/Other	
VSS AF30 Power/Other VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG21 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ16 <td>VSS</td> <td>AF29</td> <td>Power/Other</td> <td></td>	VSS	AF29	Power/Other	
VSS AF6 Power/Other VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG217 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ10 Power/Other	VSS	AF3	Power/Other	
VSS AF7 Power/Other VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG27 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH10 Power/Other VSS AH10 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other	VSS	AF30	Power/Other	
VSS AG10 Power/Other VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other	VSS	AF6	Power/Other	
VSS AG13 Power/Other VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AF7	Power/Other	
VSS AG16 Power/Other VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG10	Power/Other	
VSS AG17 Power/Other VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AJ10 Power/Other VSS AJ10 Power/Other VSS AJ16 Power/Other	VSS	AG13	Power/Other	
VSS AG20 Power/Other VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG16	Power/Other	
VSS AG23 Power/Other VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG17	Power/Other	
VSS AG24 Power/Other VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG20	Power/Other	
VSS AG7 Power/Other VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG23	Power/Other	
VSS AH1 Power/Other VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG24	Power/Other	
VSS AH10 Power/Other VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AG7	Power/Other	
VSS AH13 Power/Other VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH1	Power/Other	
VSS AH16 Power/Other VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH10	Power/Other	
VSS AH17 Power/Other VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH13	Power/Other	
VSS AH20 Power/Other VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH16	Power/Other	
VSS AH23 Power/Other VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH17	Power/Other	
VSS AH24 Power/Other VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH20	Power/Other	
VSS AH3 Power/Other VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH23	Power/Other	
VSS AH6 Power/Other VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH24	Power/Other	
VSS AH7 Power/Other VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	АН3	Power/Other	
VSS AJ10 Power/Other VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH6	Power/Other	
VSS AJ13 Power/Other VSS AJ16 Power/Other	VSS	AH7	Power/Other	
VSS AJ16 Power/Other	VSS	AJ10	Power/Other	
	VSS	AJ13	Power/Other	
VSS AJ17 Power/Other	VSS	AJ16	Power/Other	
t	VSS	AJ17	Power/Other	
VSS AJ20 Power/Other	VSS	AJ20	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type AJ23 VSS Power/Other VSS AJ24 Power/Other VSS AJ27 Power/Other VSS AJ28 Power/Other VSS AJ29 Power/Other VSS AJ30 Power/Other VSS AJ4 Power/Other VSS AJ7 Power/Other VSS AK10 Power/Other VSS AK13 Power/Other VSS AK16 Power/Other VSS AK17 Power/Other VSS AK2 Power/Other VSS AK20 Power/Other VSS AK23 Power/Other VSS AK24 Power/Other VSS AK27 Power/Other VSS AK28 Power/Other VSS AK29 Power/Other VSS AK30 Power/Other VSS AK5 Power/Other VSS AK7 Power/Other VSS AL10 Power/Other VSS AL13 Power/Other VSS AL16 Power/Other VSS AL17 Power/Other VSS AL20 Power/Other VSS AL23 Power/Other VSS AL24 Power/Other VSS AL27 Power/Other AL28 VSS Power/Other VSS AL3 Power/Other VSS AL7 Power/Other VSS AM1 Power/Other VSS AM10 Power/Other VSS AM13 Power/Other VSS AM16 Power/Other VSS AM17 Power/Other VSS AM20 Power/Other VSS AM23 Power/Other

Table 4-1. Alphabetical Land Assignments

	giiiic		
Land Name	Land #	Signal Buffer Type	Direction
VSS	AM24	Power/Other	
VSS	AM27	Power/Other	
VSS	AM28	Power/Other	
VSS	AM4	Power/Other	
VSS	AN1	Power/Other	
VSS	AN10	Power/Other	
VSS	AN13	Power/Other	
VSS	AN16	Power/Other	
VSS	AN17	Power/Other	
VSS	AN2	Power/Other	
VSS	AN20	Power/Other	
VSS	AN23	Power/Other	
VSS	AN24	Power/Other	
VSS	AN27	Power/Other	
VSS	AN28	Power/Other	
VSS	B1	Power/Other	
VSS	B11	Power/Other	
VSS	B14	Power/Other	
VSS	B17	Power/Other	
VSS	B20	Power/Other	
VSS	B24	Power/Other	
VSS	B5	Power/Other	
VSS	B8	Power/Other	
VSS	C10	Power/Other	
VSS	C13	Power/Other	
VSS	C16	Power/Other	
VSS	C19	Power/Other	
VSS	C22	Power/Other	
VSS	C24	Power/Other	
VSS	C4	Power/Other	
VSS	C7	Power/Other	
VSS	D12	Power/Other	
VSS	D15	Power/Other	
VSS	D18	Power/Other	
VSS	D21	Power/Other	
VSS	D24	Power/Other	
VSS	D3	Power/Other	
VSS	D5	Power/Other	
VSS	D6	Power/Other	
VSS	D9	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name Direction** Type VSS E11 Power/Other VSS E14 Power/Other VSS E17 Power/Other VSS E2 Power/Other VSS E20 Power/Other VSS E25 Power/Other VSS E26 Power/Other VSS E27 Power/Other VSS E28 Power/Other VSS E29 Power/Other VSS E8 Power/Other VSS F10 Power/Other VSS F13 Power/Other F16 VSS Power/Other VSS F19 Power/Other VSS F22 Power/Other VSS F4 Power/Other F7 VSS Power/Other VSS G1 Power/Other VSS H10 Power/Other VSS H11 Power/Other VSS H12 Power/Other VSS H13 Power/Other VSS H14 Power/Other VSS H17 Power/Other VSS H18 Power/Other VSS H19 Power/Other VSS H20 Power/Other VSS H21 Power/Other VSS H22 Power/Other H23 VSS Power/Other VSS H24 Power/Other VSS H25 Power/Other H26 VSS Power/Other VSS H27 Power/Other VSS H28 Power/Other VSS Н3 Power/Other VSS H6 Power/Other VSS H7 Power/Other VSS Н8 Power/Other

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
VSS	H9	Power/Other	
VSS	J4	Power/Other	
VSS	J7	Power/Other	
VSS	K2	Power/Other	
VSS	K5	Power/Other	
VSS	K7	Power/Other	
VSS	L23	Power/Other	
VSS	L24	Power/Other	
VSS	L25	Power/Other	
VSS	L26	Power/Other	
VSS	L27	Power/Other	
VSS	L28	Power/Other	
VSS	L29	Power/Other	
VSS	L3	Power/Other	
VSS	L30	Power/Other	
VSS	L6	Power/Other	
VSS	L7	Power/Other	
VSS	M1	Power/Other	
VSS	M7	Power/Other	
VSS	N3	Power/Other	
VSS	N6	Power/Other	
VSS	N7	Power/Other	
VSS	P23	Power/Other	
VSS	P24	Power/Other	
VSS	P25	Power/Other	
VSS	P26	Power/Other	
VSS	P27	Power/Other	
VSS	P28	Power/Other	
VSS	P29	Power/Other	
VSS	P30	Power/Other	
VSS	P4	Power/Other	
VSS	P7	Power/Other	
VSS	R2	Power/Other	
VSS	R23	Power/Other	
VSS	R24	Power/Other	
VSS	R25	Power/Other	
VSS	R26	Power/Other	
VSS	R27	Power/Other	
VSS	R28	Power/Other	
VSS	R29	Power/Other	



Table 4-1. Alphabetical Land Assignments

Signal Buffer Land **Land Name** Direction Type R30 VSS Power/Other VSS R5 Power/Other VSS Power/Other VSS Т3 Power/Other Т6 VSS Power/Other VSS T7 Power/Other U1 VSS Power/Other VSS U7 Power/Other V23 VSS Power/Other VSS V24 Power/Other VSS V25 Power/Other VSS V26 Power/Other VSS V27 Power/Other VSS V28 Power/Other VSS V29 Power/Other VSS ٧3 Power/Other VSS V30 Power/Other VSS ٧6 Power/Other VSS ٧7 Power/Other VSS W4 Power/Other Power/Other VSS W7 VSS Y2 Power/Other VSS Y5 Power/Other VSS Υ7 Power/Other VSS_MB_ REGULATION AN6 Power/Other Output VSS_SENSE AN4 Power/Other Output **VSSA** B23 Power/Other VTT A25 Power/Other VTT A26 Power/Other VTT A27 Power/Other VTT A28 Power/Other VTT A29 Power/Other VTT A30 Power/Other VTT B25 Power/Other VTT B26 Power/Other VTT B27 Power/Other VTT B28 Power/Other VTT B29 Power/Other VTT B30 Power/Other VTT C25 Power/Other

Table 4-1. Alphabetical Land Assignments

Land Name	Land #	Signal Buffer Type	Direction
VTT	C26	Power/Other	
VTT	C27	Power/Other	
VTT	C28	Power/Other	
VTT	C29	Power/Other	
VTT	C30	Power/Other	
VTT	D25	Power/Other	
VTT	D26	Power/Other	
VTT	D27	Power/Other	
VTT	D28	Power/Other	
VTT	D29	Power/Other	
VTT	D30	Power/Other	
VTT_OUT_LEFT	J1	Power/Other	Output
VTT_OUT_RIGHT	AA1	Power/Other	Output
VTT_SEL	F27	Power/Other	Output
VTTPWRGD	AM6	Power/Other	Input



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
A2	VSS	Power/Other	
А3	RS2#	Common Clock	Input
A4	D2#	Source Synch	Input/Output
A5	D4#	Source Synch	Input/Output
A6	VSS	Power/Other	
A7	D7#	Source Synch	Input/Output
A8	DBI0#	Source Synch	Input/Output
A9	VSS	Power/Other	
A10	D8#	Source Synch	Input/Output
A11	D9#	Source Synch	Input/Output
A12	VSS	Power/Other	
A13	COMP0	Power/Other	Input
A14	D50#	Source Synch	Input/Output
A15	VSS	Power/Other	
A16	DSTBN3#	Source Synch	Input/Output
A17	D56#	Source Synch	Input/Output
A18	VSS	Power/Other	
A19	D61#	Source Synch	Input/Output
A20	RESERVED		
A21	VSS	Power/Other	
A22	D62#	Source Synch	Input/Output
A23	VCCA	Power/Other	
A24	VSS	Power/Other	
A25	VTT	Power/Other	
A26	VTT	Power/Other	
A27	VTT	Power/Other	
A28	VTT	Power/Other	
A29	VTT	Power/Other	
A30	VTT	Power/Other	
B1	VSS	Power/Other	
B2	DBSY#	Common Clock	Input/Output
В3	RS0#	Common Clock	Input
B4	D0#	Source Synch	Input/Output
B5	VSS	Power/Other	
B6	D5#	Source Synch	Input/Output
B7	D6#	Source Synch	Input/Output
B8	VSS	Power/Other	
В9	DSTBP0#	Source Synch	Input/Output
B10	D10#	Source Synch	Input/Output
B11	VSS	Power/Other	
B12	D13#	Source Synch	Input/Output

Table	4-2. Numeric	al Land Ass	ignment
Land #	Land Name	Signal Buffer Type	Direction
B13	RESERVED		
B14	VSS	Power/Other	
B15	D53#	Source Synch	Input/Output
B16	D55#	Source Synch	Input/Output
B17	VSS	Power/Other	
B18	D57#	Source Synch	Input/Output
B19	D60#	Source Synch	Input/Output
B20	VSS	Power/Other	
B21	D59#	Source Synch	Input/Output
B22	D63#	Source Synch	Input/Output
B23	VSSA	Power/Other	
B24	VSS	Power/Other	
B25	VTT	Power/Other	
B26	VTT	Power/Other	
B27	VTT	Power/Other	
B28	VTT	Power/Other	
B29	VTT	Power/Other	
B30	VTT	Power/Other	
C1	DRDY#	Common Clock	Input/Output
C2	BNR#	Common Clock	Input/Output
C3	LOCK#	Common Clock	Input/Output
C4	VSS	Power/Other	
C5	D1#	Source Synch	Input/Output
C6	D3#	Source Synch	Input/Output
C7	VSS	Power/Other	
C8	DSTBN0#	Source Synch	Input/Output
C9	RESERVED		
C10	VSS	Power/Other	
C11	D11#	Source Synch	Input/Output
C12	D14#	Source Synch	Input/Output
C13	VSS	Power/Other	
C14	D52#	Source Synch	Input/Output
C15	D51#	Source Synch	Input/Output
C16	VSS	Power/Other	
C17	DSTBP3#	Source Synch	Input/Output
C18	D54#	Source Synch	Input/Output
C19	VSS	Power/Other	
C20	DBI3#	Source Synch	Input/Output
C21	D58#	Source Synch	Input/Output
C22	VSS	Power/Other	
C23	VCCIOPLL	Power/Other	



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
C24	VSS	Power/Other	
C25	VTT	Power/Other	
C26	VTT	Power/Other	
C27	VTT	Power/Other	
C28	VTT	Power/Other	
C29	VTT	Power/Other	
C30	VTT	Power/Other	
D1	RESERVED		
D2	ADS#	Common Clock	Input/Output
D3	VSS	Power/Other	
D4	HIT#	Common Clock	Input/Output
D5	VSS	Power/Other	
D6	VSS	Power/Other	
D7	D20#	Source Synch	Input/Output
D8	D12#	Source Synch	Input/Output
D9	VSS	Power/Other	
D10	D22#	Source Synch	Input/Output
D11	D15#	Source Synch	Input/Output
D12	VSS	Power/Other	
D13	D25#	Source Synch	Input/Output
D14	RESERVED		
D15	VSS	Power/Other	
D16	RESERVED		
D17	D49#	Source Synch	Input/Output
D18	VSS	Power/Other	
D19	DBI2#	Source Synch	Input/Output
D20	D48#	Source Synch	Input/Output
D21	VSS	Power/Other	
D22	D46#	Source Synch	Input/Output
D23	RESERVED		
D24	VSS	Power/Other	
D25	VTT	Power/Other	
D26	VTT	Power/Other	
D27	VTT	Power/Other	
D28	VTT	Power/Other	
D29	VTT	Power/Other	
D30	VTT	Power/Other	
E2	VSS	Power/Other	
E3	TRDY#	Common Clock	Input
E4	HITM#	Common Clock	Input/Output
E5	RESERVED		

Land Wame Signal Buffer Type Direction E6 RESERVED	abie	4-2. Numeric	ai Laila A33	igilillelit
E7 RESERVED Power/Other E8 VSS Power/Other E9 D19# Source Synch Input/Output E10 D21# Source Synch Input/Output E11 VSS Power/Other E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Input/Other E25 VSS Power/Other E27 VSS Power/Other E28		Land Name		Direction
E8 VSS Power/Other E9 D19# Source Synch Input/Output E10 D21# Source Synch Input/Output E11 VSS Power/Other E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED E26 VSS Power/Other E24 RESERVED F2 FC5 Common Clock Input E29 VSS Power/Other </td <td>E6</td> <td>RESERVED</td> <td></td> <td></td>	E6	RESERVED		
E9 D19# Source Synch Input/Output E10 D21# Source Synch Input/Output E11 VSS Power/Other Fource Synch Input/Output E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other Input/Output E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Power/Other E25 E24 RESERVED Input/Output F2 FC5 Common Clock Input/Output F3	E7	RESERVED		
E10 D21# Source Synch Input/Output E11 VSS Power/Other E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED E25 VSS Power/Other E24 RESERVED E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input/Output F4 VSS <td>E8</td> <td>VSS</td> <td>Power/Other</td> <td></td>	E8	VSS	Power/Other	
E11 VSS Power/Other E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other Input/Output E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Power/Other E26 E24 RESERVED E27 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F5 RS1# Common Clock Input/O	E9	D19#	Source Synch	Input/Output
E12 DSTBP1# Source Synch Input/Output E13 D26# Source Synch Input/Output E14 VSS Power/Other Input/Output E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Input/Other E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other F2 FC5 Common Clock Input F3 RS1# Common Clock Input F4 VSS Power/Other <td>E10</td> <td>D21#</td> <td>Source Synch</td> <td>Input/Output</td>	E10	D21#	Source Synch	Input/Output
E13 D26# Source Synch Input/Output E14 VSS Power/Other E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input E24 RESERVED Input E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Sou	E11	VSS	Power/Other	
E14 VSS Power/Other E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Input/Output E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input/Output F9 D18#	E12	DSTBP1#	Source Synch	Input/Output
E15 D33# Source Synch Input/Output E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Power/Other E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS	E13	D26#	Source Synch	Input/Output
E16 D34# Source Synch Input/Output E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Power/Other E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch	E14	VSS	Power/Other	
E17 VSS Power/Other E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Power/Other E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output	E15	D33#	Source Synch	Input/Output
E18 D39# Source Synch Input/Output E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED E24 RESERVED E25 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other E29 VSS Power/Other F10 RESERVED F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 Source Synch Input/Output F14 Source Synch Input/Output F15 Source Synch Input/Output F17 D23# Source Synch Input/Output F18 Source Synch Input/Output F19 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E16	D34#	Source Synch	Input/Output
E19 D40# Source Synch Input/Output E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED E25 VSS Power/Other E26 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10	E17	VSS	Power/Other	
E20 VSS Power/Other E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Input/Output E24 RESERVED Input/Other E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output	E18	D39#	Source Synch	Input/Output
E21 D42# Source Synch Input/Output E22 D45# Source Synch Input/Output E23 RESERVED Fee Fee E24 RESERVED Fee Fee E25 VSS Power/Other Fee E26 VSS Power/Other Fee E27 VSS Power/Other Fee E28 VSS Power/Other Fee F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input Fee F7 VSS Power/Other Fee F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12	E19	D40#	Source Synch	Input/Output
E22 D45# Source Synch Input/Output E23 RESERVED E24 RESERVED E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch <td>E20</td> <td>VSS</td> <td>Power/Other</td> <td></td>	E20	VSS	Power/Other	
E23 RESERVED E24 RESERVED E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30#	E21	D42#	Source Synch	Input/Output
E24 RESERVED E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output	E22	D45#	Source Synch	Input/Output
E25 VSS Power/Other E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/O	E23	RESERVED		
E26 VSS Power/Other E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source	E24	RESERVED		
E27 VSS Power/Other E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E25	VSS	Power/Other	
E28 VSS Power/Other E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E26	VSS	Power/Other	
E29 VSS Power/Other F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E27	VSS	Power/Other	
F2 FC5 Common Clock Input F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Other F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E28	VSS	Power/Other	
F3 BR0# Common Clock Input/Output F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	E29	VSS	Power/Other	
F4 VSS Power/Other F5 RS1# Common Clock Input F6 RESERVED Input/Output F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F2	FC5	Common Clock	Input
F5 RS1# Common Clock Input F6 RESERVED Input F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F3	BR0#	Common Clock	Input/Output
F6 RESERVED F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F4	VSS	Power/Other	
F7 VSS Power/Other F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F5	RS1#	Common Clock	Input
F8 D17# Source Synch Input/Output F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F6	RESERVED		
F9 D18# Source Synch Input/Output F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F7	VSS	Power/Other	
F10 VSS Power/Other F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F8	D17#	Source Synch	Input/Output
F11 D23# Source Synch Input/Output F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F9	D18#	Source Synch	Input/Output
F12 D24# Source Synch Input/Output F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F10	VSS	Power/Other	
F13 VSS Power/Other F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F11	D23#	Source Synch	Input/Output
F14 D28# Source Synch Input/Output F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F12	D24#	Source Synch	Input/Output
F15 D30# Source Synch Input/Output F16 VSS Power/Other F17 D37# Source Synch Input/Output	F13	VSS	Power/Other	
F16 VSS Power/Other F17 D37# Source Synch Input/Output	F14	D28#	Source Synch	Input/Output
F17 D37# Source Synch Input/Output	F15	D30#	Source Synch	Input/Output
	F16	VSS	Power/Other	
F18 D38# Source Synch Input/Output	F17	D37#	Source Synch	Input/Output
, , , , , , , , , , , , , , , , , , , ,	F18	D38#	Source Synch	Input/Output



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
F19	VSS	Power/Other	
F20	D41#	Source Synch	Input/Output
F21	D43#	Source Synch	Input/Output
F22	VSS	Power/Other	
F23	RESERVED		
F24	TESTHI7	Power/Other	Input
F25	TESTHI2	Power/Other	Input
F26	TESTHI0	Power/Other	Input
F28	BCLK0	Clock	Input
F29	RESERVED		
G1	VSS	Power/Other	
G2	FC1	Power/Other	Input
G3	TESTHI8	Power/Other	Input
G4	TESTHI9	Power/Other	Input
G5	FC7	Source Synch	Output
G6	RESERVED		
G7	DEFER#	Common Clock	Input
G8	BPRI#	Common Clock	Input
G9	D16#	Source Synch	Input/Output
G10	RESERVED		
G11	DBI1#	Source Synch	Input/Output
G12	DSTBN1#	Source Synch	Input/Output
G13	D27#	Source Synch	Input/Output
G14	D29#	Source Synch	Input/Output
G15	D31#	Source Synch	Input/Output
G16	D32#	Source Synch	Input/Output
G17	D36#	Source Synch	Input/Output
G18	D35#	Source Synch	Input/Output
G19	DSTBP2#	Source Synch	Input/Output
G20	DSTBN2#	Source Synch	Input/Output
G21	D44#	Source Synch	Input/Output
G22	D47#	Source Synch	Input/Output
G23	RESET#	Common Clock	Input
G24	TESTHI6	Power/Other	Input
G25	TESTHI3	Power/Other	Input
G26	TESTHI5	Power/Other	Input
G27	TESTHI4	Power/Other	Input
G28	BCLK1	Clock	Input
G29	BSEL0	Power/Other	Output
G30	BSEL2	Power/Other	Output
H1	GTLREF	Power/Other	Input

Land # Land Name Signal Buffer Type Direction H2 FC6 Power/Other Input H3 VSS Power/Other Input H4 RSP# Common Clock Input H5 TESTHI10 Power/Other Input H6 VSS Power/Other Input H7 VSS Power/Other Input H8 VSS Power/Other Input H9 VSS Power/Other Input/Output H10 VSS Power/Other Input/Output H11 VSS Power/Other Input/Output H12 VSS Power/Other Input/Output H14 VSS Power/Other Input/Output H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H20 VSS Power/Other <tr< th=""><th>Table</th><th>4-2. Numerica</th><th>ii Lana Ass</th><th>igiiiioiit</th></tr<>	Table	4-2. Numerica	ii Lana Ass	igiiiioiit
H3		Land Name		Direction
H4 RSP# Common Clock Input H5 TESTHI10 Power/Other Input H6 VSS Power/Other Input H7 VSS Power/Other Input H8 VSS Power/Other Input/Output H9 VSS Power/Other Input/Output H10 VSS Power/Other Input/Output H11 VSS Power/Other Input/Output H12 VSS Power/Other Input/Output H13 VSS Power/Other Input/Output H14 VSS Power/Other Input/Output H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other Input/Output H18 VSS Power/Other Input/Output H20 VSS Power/Other Input/Output H21 VSS Power/Other Input/Output H22 <td>H2</td> <td>FC6</td> <td>Power/Other</td> <td>Input</td>	H2	FC6	Power/Other	Input
H5	НЗ	VSS	Power/Other	
H6	H4	RSP#	Common Clock	Input
H7 VSS Power/Other H8 VSS Power/Other H9 VSS Power/Other H10 VSS Power/Other H11 VSS Power/Other H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other	H5	TESTHI10	Power/Other	Input
H8 VSS Power/Other H9 VSS Power/Other H10 VSS Power/Other H11 VSS Power/Other H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other <	H6	VSS	Power/Other	
H9 VSS Power/Other H10 VSS Power/Other H11 VSS Power/Other H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other H29 GTLREF_SEL Power/Other <td>H7</td> <td>VSS</td> <td>Power/Other</td> <td></td>	H7	VSS	Power/Other	
H10 VSS Power/Other H11 VSS Power/Other H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other H30 BSEL1 Power/Other J3 RESERVED Input	H8	VSS	Power/Other	
H11 VSS Power/Other H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other H29 GTLREF_SEL Power/Other J3 RESERVED Output J4 VSS Power/Other <td>H9</td> <td>VSS</td> <td>Power/Other</td> <td></td>	H9	VSS	Power/Other	
H12 VSS Power/Other H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input/Output	H10	VSS	Power/Other	
H13 VSS Power/Other H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other H30 BSEL1 Power/Other J3 RESERVED Output J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4#	H11	VSS	Power/Other	
H14 VSS Power/Other H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other Power/Other H18 VSS Power/Other Power/Other H19 VSS Power/Other Power/Other H20 VSS Power/Other Power/Other H21 VSS Power/Other Power/Other H22 VSS Power/Other Power/Other H23 VSS Power/Other Power/Other H24 VSS Power/Other Power/Other H25 VSS Power/Other Power/Other H26 VSS Power/Other Output H27 VSS Power/Other Output H28 VSS Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Input J3 RESERVED	H12	VSS	Power/Other	
H15 DP1# Common Clock Input/Output H16 DP2# Common Clock Input/Output H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# <t< td=""><td>H13</td><td>VSS</td><td>Power/Other</td><td></td></t<>	H13	VSS	Power/Other	
H16	H14	VSS	Power/Other	
H17 VSS Power/Other H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J4 VSS Power/Other Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC <td< td=""><td>H15</td><td>DP1#</td><td>Common Clock</td><td>Input/Output</td></td<>	H15	DP1#	Common Clock	Input/Output
H18 VSS Power/Other H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Source Synch Input/Output J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/O	H16	DP2#	Common Clock	Input/Output
H19 VSS Power/Other H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J4 VSS Power/Other Input/Output J6 REQ1# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10	H17	VSS	Power/Other	
H20 VSS Power/Other H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J4 VSS Power/Other Input/Output J5 REQ1# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other	H18	VSS	Power/Other	
H21 VSS Power/Other H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Ottput J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other	H19	VSS	Power/Other	
H22 VSS Power/Other H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J4 VSS Power/Other Input/Output J5 REQ1# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H20	VSS	Power/Other	
H23 VSS Power/Other H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H21	VSS	Power/Other	
H24 VSS Power/Other H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Source Synch Input/Output J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H22	VSS	Power/Other	
H25 VSS Power/Other H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J4 VSS Power/Other Input/Output J6 REQ1# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H23	VSS	Power/Other	
H26 VSS Power/Other H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H24	VSS	Power/Other	
H27 VSS Power/Other H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J10 VCC Power/Other	H25	VSS	Power/Other	
H28 VSS Power/Other H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input July J4 VSS Power/Other Input/Output J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J10 VCC Power/Other	H26	VSS	Power/Other	
H29 GTLREF_SEL Power/Other Output H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J10 VCC Power/Other	H27	VSS	Power/Other	
H30 BSEL1 Power/Other Output J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input Input J4 VSS Power/Other Input/Output J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H28	VSS	Power/Other	
J1 VTT_OUT_LEFT Power/Other Output J2 FC3 Power/Other Input J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H29	GTLREF_SEL	Power/Other	Output
J2 FC3 Power/Other Input J3 RESERVED Input J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	H30	BSEL1	Power/Other	Output
J3 RESERVED J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J1	VTT_OUT_LEFT	Power/Other	Output
J4 VSS Power/Other J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J2	FC3	Power/Other	Input
J5 REQ1# Source Synch Input/Output J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J3	RESERVED		
J6 REQ4# Source Synch Input/Output J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J4	VSS	Power/Other	
J7 VSS Power/Other J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J5	REQ1#	Source Synch	Input/Output
J8 VCC Power/Other J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J6	REQ4#	Source Synch	Input/Output
J9 VCC Power/Other J10 VCC Power/Other J11 VCC Power/Other	J7	VSS	Power/Other	
J10 VCC Power/Other J11 VCC Power/Other	J8	VCC	Power/Other	
J11 VCC Power/Other	J9	VCC	Power/Other	
	J10	VCC	Power/Other	
110	J11	VCC	Power/Other	
J12 VCC Power/Other	J12	VCC	Power/Other	



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
J13	VCC	Power/Other	
J14	VCC	Power/Other	
J15	VCC	Power/Other	
J16	DP0#	Common Clock	Input/Output
J17	DP3#	Common Clock	Input/Output
J18	VCC	Power/Other	
J19	VCC	Power/Other	
J20	VCC	Power/Other	
J21	VCC	Power/Other	
J22	VCC	Power/Other	
J23	VCC	Power/Other	
J24	VCC	Power/Other	
J25	VCC	Power/Other	
J26	VCC	Power/Other	
J27	VCC	Power/Other	
J28	VCC	Power/Other	
J29	VCC	Power/Other	
J30	VCC	Power/Other	
K1	LINT0	Asynch GTL+	Input
K2	VSS	Power/Other	
K3	A20M#	Asynch GTL+	Input
K4	REQ0#	Source Synch	Input/Output
K5	VSS	Power/Other	
K6	REQ3#	Source Synch	Input/Output
K7	VSS	Power/Other	
K8	VCC	Power/Other	
K23	VCC	Power/Other	
K24	VCC	Power/Other	
K25	VCC	Power/Other	
K26	VCC	Power/Other	
K27	VCC	Power/Other	
K28	VCC	Power/Other	
K29	VCC	Power/Other	
K30	VCC	Power/Other	
L1	LINT1	Asynch GTL+	Input
L2	TESTHI13	Asynch GTL+	Input
L3	VSS	Power/Other	
L4	A6#	Source Synch	Input/Output
L5	A3#	Source Synch	Input/Output
L6	VSS	Power/Other	
L7	VSS	Power/Other	

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Land #	Land Name	Signal Buffer Type	Direction
L8	VCC	Power/Other	
L23	VSS	Power/Other	
L24	VSS	Power/Other	
L25	VSS	Power/Other	
L26	VSS	Power/Other	
L27	VSS	Power/Other	
L28	VSS	Power/Other	
L29	VSS	Power/Other	
L30	VSS	Power/Other	
M1	VSS	Power/Other	
M2	THERMTRIP#	Asynch GTL+	Output
МЗ	STPCLK#	Asynch GTL+	Input
M4	A7#	Source Synch	Input/Output
M5	A5#	Source Synch	Input/Output
M6	REQ2#	Source Synch	Input/Output
M7	VSS	Power/Other	
M8	VCC	Power/Other	
M23	VCC	Power/Other	
M24	VCC	Power/Other	
M25	VCC	Power/Other	
M26	VCC	Power/Other	
M27	VCC	Power/Other	
M28	VCC	Power/Other	
M29	VCC	Power/Other	
M30	VCC	Power/Other	
N1	PWRGOOD	Power/Other	Input
N2	IGNNE#	Asynch GTL+	Input
N3	VSS	Power/Other	
N4	RESERVED		
N5	RESERVED		
N6	VSS	Power/Other	
N7	VSS	Power/Other	
N8	VCC	Power/Other	
N23	VCC	Power/Other	
N24	VCC	Power/Other	
N25	VCC	Power/Other	
N26	VCC	Power/Other	
N27	VCC	Power/Other	
N28	VCC	Power/Other	
N29	VCC	Power/Other	
N30	VCC	Power/Other	



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

P1 TESTHI11 Power/Other Input P2 SMI# Asynch GTL+ Input P3 INIT# Asynch GTL+ Input P4 VSS Power/Other P5 RESERVED Power/Other P6 A4# Source Synch Input/Output P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch
P3 INIT# Asynch GTL+ Input P4 VSS Power/Other P5 RESERVED Input/Output P6 A4# Source Synch Input/Output P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other
P4 VSS Power/Other P5 RESERVED P6 A4# Source Synch Input/Output P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P4 VSS Power/Other P5 RESERVED Input/Output P6 A4# Source Synch Input/Output P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other
P6 A4# Source Synch Input/Output P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P7 VSS Power/Other P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P8 VCC Power/Other P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P23 VSS Power/Other P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P24 VSS Power/Other P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other R1 FC2 Power/Other Input R2 VSS Power/Other Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTBO# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P25 VSS Power/Other P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other P30 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P26 VSS Power/Other P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other P30 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P27 VSS Power/Other P28 VSS Power/Other P29 VSS Power/Other P30 VSS Power/Other R1 FC2 Power/Other Input R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P28 VSS Power/Other P29 VSS Power/Other P30 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P29 VSS Power/Other P30 VSS Power/Other R1 FC2 Power/Other R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
P30 VSS Power/Other R1 FC2 Power/Other Input R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R1 FC2 Power/Other Input R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R2 VSS Power/Other R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R3 FERR#/PBE# Asynch GTL+ Output R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R4 A8# Source Synch Input/Output R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R5 VSS Power/Other R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R6 ADSTB0# Source Synch Input/Output R7 VSS Power/Other R8 VCC Power/Other
R7 VSS Power/Other R8 VCC Power/Other
R8 VCC Power/Other
R23 VSS Power/Other
R24 VSS Power/Other
R25 VSS Power/Other
R26 VSS Power/Other
R27 VSS Power/Other
R28 VSS Power/Other
R29 VSS Power/Other
R30 VSS Power/Other
T1 COMP1 Power/Other Input
T2 FC4 Power/Other Input
T3 VSS Power/Other
T4 A11# Source Synch Input/Output
T5 A9# Source Synch Input/Output
T6 VSS Power/Other
T7 VSS Power/Other
T8 VCC Power/Other

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Land #	Land Name	Signal Buffer Type	Direction
T24	VCC	Power/Other	
T25	VCC	Power/Other	
T26	VCC	Power/Other	
T27	VCC	Power/Other	
T28	VCC	Power/Other	
T29	VCC	Power/Other	
T30	VCC	Power/Other	
U1	VSS	Power/Other	
U2	AP0#	Common Clock	Input/Output
U3	AP1#	Common Clock	Input/Output
U4	A13#	Source Synch	Input/Output
U5	A12#	Source Synch	Input/Output
U6	A10#	Source Synch	Input/Output
U7	VSS	Power/Other	
U8	VCC	Power/Other	
U23	VCC	Power/Other	
U24	VCC	Power/Other	
U25	VCC	Power/Other	
U26	VCC	Power/Other	
U27	VCC	Power/Other	
U28	VCC	Power/Other	
U29	VCC	Power/Other	
U30	VCC	Power/Other	
V1	MSID1	Power/Other	Output
V2	LL_ID0	Power/Other	Output
V3	VSS	Power/Other	
V4	A15#	Source Synch	Input/Output
V5	A14#	Source Synch	Input/Output
V6	VSS	Power/Other	
V7	VSS	Power/Other	
V8	VCC	Power/Other	
V23	VSS	Power/Other	
V24	VSS	Power/Other	
V25	VSS	Power/Other	
V26	VSS	Power/Other	
V27	VSS	Power/Other	
V28	VSS	Power/Other	
V29	VSS	Power/Other	
V30	VSS	Power/Other	
W1	MSID0	Power/Other	Output
W2	TESTHI12	Power/Other	Input
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Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
W3	TESTHI1	Power/Other	Input
W4	VSS	Power/Other	
W5	A16#	Source Synch	Input/Output
W6	A18#	Source Synch	Input/Output
W7	VSS	Power/Other	
W8	VCC	Power/Other	
W23	VCC	Power/Other	
W24	VCC	Power/Other	
W25	VCC	Power/Other	
W26	VCC	Power/Other	
W27	VCC	Power/Other	
W28	VCC	Power/Other	
W29	VCC	Power/Other	
W30	VCC	Power/Other	
Y1	BOOTSELECT	Power/Other	Input
Y2	/2 VSS Power/C		
Y3	Y3 RESERVED		
Y4	Y4 A20# Sour		Input/Output
Y5	Y5 VSS Power/Other		
Y6	A19#	Source Synch	Input/Output
Y7	VSS	Power/Other	
Y8	VCC	Power/Other	
Y23	VCC	Power/Other	
Y24	VCC	Power/Other	
Y25	VCC	Power/Other	
Y26	VCC	Power/Other	
Y27	VCC	Power/Other	
Y28	VCC	Power/Other	
Y29	VCC	Power/Other	
Y30	VCC	Power/Other	
AA2	LL_ID1	Power/Other	Output
AA3	VSS	Power/Other	
AA4	A21#	Source Synch	Input/Output
AA5	A23#	Source Synch	Input/Output
AA6	VSS	Power/Other	
AA7	VSS	Power/Other	
AA8	VCC	Power/Other	
AA23	VSS	Power/Other	
AA24	VSS	Power/Other	
AA25	VSS	Power/Other	
AA26	VSS	Power/Other	

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Land #	Land Name	Signal Buffer Type	Direction
AA27	VSS	Power/Other	
AA28	VSS	Power/Other	
AA29	VSS	Power/Other	
AA30	VSS	Power/Other	
AB1	VSS	Power/Other	
AB2	IERR#	Asynch GTL+	Output
AB3	MCERR#	Common Clock	Input/Output
AB4	A26#	Source Synch	Input/Output
AB5	A24#	Source Synch	Input/Output
AB6	A17#	Source Synch	Input/Output
AB7	VSS	Power/Other	
AB8	VCC	Power/Other	
AB23	VSS	Power/Other	
AB24	VSS	Power/Other	
AB25	VSS	Power/Other	
AB26	VSS	Power/Other	
AB27	VSS	Power/Other	
AB28	AB28 VSS Power		
AB29	VSS	Power/Other	
AB30	VSS	Power/Other	
AC1	TMS	TAP	Input
AC2	DBR#	Power/Other	Output
AC3	VSS	Power/Other	
AC4	RESERVED		
AC5	A25#	Source Synch	Input/Output
AC6	VSS	Power/Other	
AC7	VSS	Power/Other	
AC8	VCC	Power/Other	
AC23	VCC	Power/Other	
AC24	VCC	Power/Other	
AC25	VCC	Power/Other	
AC26	VCC	Power/Other	
AC27	VCC	Power/Other	
AC28	VCC	Power/Other	
AC29	VCC	Power/Other	
AC30	VCC	Power/Other	
AD1	TDI	TAP	Input
AD2	BPM2#	Common Clock	Input/Output
AD3	BINIT#	Common Clock	Input/Output
AD4	VSS	Power/Other	
AD5	ADSTB1#	Source Synch	Input/Output
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Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
AD6	A22#	Source Synch	Input/Output
AD7	VSS	Power/Other	
AD8	VCC	Power/Other	
AD23	VCC	Power/Other	
AD24	VCC	Power/Other	
AD25	VCC	Power/Other	
AD26	VCC	Power/Other	
AD27	VCC	Power/Other	
AD28	VCC	Power/Other	
AD29	VCC	Power/Other	
AD30	VCC	Power/Other	
AE1	TCK	TAP	Input
AE2	VSS	Power/Other	
AE3	RESERVED		
AE4	RESERVED		
AE5	VSS	Power/Other	
AE6	RESERVED		
AE7	VSS Power/Other		
AE8	SKTOCC#	Power/Other	Output
AE9	VCC	Power/Other	
AE10	VSS	Power/Other	
AE11	VCC	Power/Other	
AE12	VCC	Power/Other	
AE13	VSS	Power/Other	
AE14	VCC	Power/Other	
AE15	VCC	Power/Other	
AE16	VSS	Power/Other	
AE17	VSS	Power/Other	
AE18	VCC	Power/Other	
AE19	VCC	Power/Other	
AE20	VSS	Power/Other	
AE21	VCC	Power/Other	
AE22	VCC	Power/Other	
AE23	VCC Power/Othe		
AE24	VSS	Power/Other	
AE25	VSS	Power/Other	
AE26	VSS	Power/Other	
AE27	VSS	Power/Other	
AE28	VSS	Power/Other	
AE29	VSS	Power/Other	
AE30	VSS	Power/Other	

Table 4-2. Numerical Land Assignment			igiiiieiit
Land #	Land Name	Signal Buffer Type	Direction
AF1	TDO	TAP	Output
AF2	BPM4#	Common Clock	Input/Output
AF4	A28#	Source Synch	Input/Output
AF5	A27#	Source Synch	Input/Output
AF6	VSS	Power/Other	
AF7	VSS	Power/Other	
AF8	VCC	Power/Other	
AF9	VCC	Power/Other	
AF10	VSS	Power/Other	
AF11	VCC	Power/Other	
AF12	VCC	Power/Other	
AF13	VSS	Power/Other	
AF14	VCC	Power/Other	
AF15	VCC	Power/Other	
AF16	VSS	Power/Other	
AF17	VSS	Power/Other	
AF18	VCC	Power/Other	
AF19	VCC	Power/Other	
AF20	VSS	Power/Other	
AF21	VCC	Power/Other	
AF22	VCC	Power/Other	
AF23	VSS	Power/Other	
AF24	VSS	Power/Other	
AF25	VSS	Power/Other	
AF26	VSS	Power/Other	
AF27	VSS	Power/Other	
AF28	VSS	Power/Other	
AF29	VSS	Power/Other	
AF3	VSS	Power/Other	
AF30	VSS	Power/Other	
AG1	TRST#	TAP	Input
AG2	BPM3#	Common Clock	Input/Output
AG3	BPM5#	Common Clock	Input/Output
AG4	A30#	Source Synch	Input/Output
AG5	A31#	Source Synch	Input/Output
AG6	A29#	Source Synch	Input/Output
AG7	VSS	Power/Other	
AG8	VCC	Power/Other	
AG9	VCC	Power/Other	
AG10	VSS	Power/Other	
AG11	VCC	Power/Other	



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
AG12	VCC	Power/Other	
AG13	VSS	Power/Other	
AG14	VCC	Power/Other	
AG15	VCC	Power/Other	
AG16	VSS	Power/Other	
AG17	VSS	Power/Other	
AG18	VCC	Power/Other	
AG19	VCC	Power/Other	
AG20	VSS	Power/Other	
AG21	VCC	Power/Other	
AG22	VCC	Power/Other	
AG23	VSS	Power/Other	
AG24	VSS	Power/Other	
AG25	VCC	Power/Other	
AG26	VCC	Power/Other	
AG27	VCC	Power/Other	
AG28	VCC	Power/Other	
AG29	VCC	Power/Other	
AG30	VCC Power/Othe		
AH1	VSS Power/Other		
AH2	RESERVED		
AH3	VSS	Power/Other	
AH4	A32#	Source Synch	Input/Output
AH5	A33#	Source Synch	Input/Output
AH6	VSS	Power/Other	
AH7	VSS	Power/Other	
AH8	VCC	Power/Other	
AH9	VCC	Power/Other	
AH10	VSS	Power/Other	
AH11	VCC	Power/Other	
AH12	VCC	Power/Other	
AH13	VSS	Power/Other	
AH14	VCC	Power/Other	
AH15	VCC	Power/Other	
AH16	VSS	Power/Other	
AH17	VSS	Power/Other	
AH18	VCC	Power/Other	
AH19	VCC	Power/Other	
AH20	VSS	Power/Other	
AH21	VCC	Power/Other	
AH22	VCC	Power/Other	

Iable	4-2. Numeric	ai Lailu ASS	igilillelit
Land #	Land Name	Signal Buffer Type	Direction
AH23	VSS	Power/Other	
AH24	VSS	Power/Other	
AH25	VCC	Power/Other	
AH26	VCC	Power/Other	
AH27	VCC	Power/Other	
AH28	VCC	Power/Other	
AH29	VCC	Power/Other	
AH30	VCC	Power/Other	
AJ1	BPM1#	Common Clock	Input/Output
AJ2	BPM0#	Common Clock	Input/Output
AJ3	ITP_CLK1	TAP	Input
AJ4	VSS	Power/Other	
AJ5	A34#	Source Synch	Input/Output
AJ6	A35#	Source Synch	Input/Output
AJ7	VSS	Power/Other	
AJ8	VCC	Power/Other	
AJ9	VCC	Power/Other	
AJ10	VSS	Power/Other	
AJ11	VCC	Power/Other	
AJ12	VCC	Power/Other	
AJ13	VSS	Power/Other	
AJ14	VCC	Power/Other	
AJ15	VCC	Power/Other	
AJ16	VSS	Power/Other	
AJ17	VSS	Power/Other	
AJ18	VCC	Power/Other	
AJ19	VCC	Power/Other	
AJ20	VSS	Power/Other	
AJ21	VCC	Power/Other	
AJ22	VCC	Power/Other	
AJ23	VSS	Power/Other	
AJ24	VSS	Power/Other	
AJ25	VCC	Power/Other	
AJ26	VCC	Power/Other	
AJ27	VSS	Power/Other	
AJ28	VSS	Power/Other	
AJ29	VSS	Power/Other	
AJ30	VSS	Power/Other	
AK1	THERMDC	Power/Other	
AK2	VSS	Power/Other	
AK3	ITP_CLK0	TAP	Input



Table 4-2. Numerical Land Assignment

Table 4-2. Numerical Land Assignment

Land Hame		Signal Buffer Type	Direction
AK4	VID4 Power/C		Output
AK5	VSS	Power/Other	
AK6	RESERVED		
AK7	VSS	Power/Other	
AK8	VCC	Power/Other	
AK9	VCC	Power/Other	
AK10	VSS	Power/Other	
AK11	VCC	Power/Other	
AK12	VCC	Power/Other	
AK13	VSS	Power/Other	
AK14	VCC	Power/Other	
AK15	VCC	Power/Other	
AK16	VSS	Power/Other	
AK17	VSS	Power/Other	
AK18	VCC	Power/Other	
AK19	VCC	Power/Other	
AK20	VSS	Power/Other	
AK21	AK21 VCC Pov		
AK22	AK22 VCC Pow		
AK23	VSS	VSS Power/Other	
AK24	VSS	Power/Other	
AK25	VCC	Power/Other	
AK26	VCC	Power/Other	
AK27	VSS	Power/Other	
AK28	VSS	Power/Other	
AK29	VSS	Power/Other	
AK30	VSS	Power/Other	
AL1	THERMDA	Power/Other	
AL2	PROCHOT#	Asynch GTL+	Input/Output
AL3	VSS	Power/Other	
AL4	VID5	Power/Other	Output
AL5	VID1	Power/Other	Output
AL6	VID3	Power/Other	Output
AL7	VSS	Power/Other	
AL8	VCC	Power/Other	
AL9	VCC	Power/Other	
AL10	VSS	Power/Other	
AL11	VCC	Power/Other	
AL12	VCC	Power/Other	
AL13	VSS	Power/Other	
			1

Land # Land Name Signal Buffer Type Direction AL15 VCC Power/Other	Table	4-2. Numerica	ai Lailu ASS	igilillelit
AL16 VSS Power/Other AL17 VSS Power/Other AL18 VCC Power/Other AL19 VCC Power/Other AL20 VSS Power/Other AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 VCC Power/Other AM9 VCC Power/Other AM10 VSS		Land Name		Direction
AL17 VSS Power/Other AL18 VCC Power/Other AL19 VCC Power/Other AL20 VSS Power/Other AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 VCC Power/Other AM7 FC12 Power/Other AM8 VCC Power/Other AM10 VSS	AL15	VCC	Power/Other	
AL18 VCC Power/Other AL19 VCC Power/Other AL20 VSS Power/Other AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL29 VCC Power/Other AM10 VSS Power/Other AM11 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 FC11 Power/Other AM7 FC12 Power/Other AM8 VCC Power/Other AM10 V	AL16	VSS	Power/Other	
AL19 VCC Power/Other AL20 VSS Power/Other AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM20 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 FC11 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VS	AL17	VSS	Power/Other	
AL20 VSS Power/Other AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM29 VID0 Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC	AL18	VCC	Power/Other	
AL21 VCC Power/Other AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM5 FC11 Power/Other AM6 VCC Power/Other AM7 FC12 Power/Other AM8 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC	AL19	VCC	Power/Other	
AL22 VCC Power/Other AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 VCC Power/Other AM7 FC12 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC </td <td>AL20</td> <td>VSS</td> <td>Power/Other</td> <td></td>	AL20	VSS	Power/Other	
AL23 VSS Power/Other AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 FC12 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS	AL21	VCC	Power/Other	
AL24 VSS Power/Other AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL29 VCC Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 VSS Power/Other AM7 FC12 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC </td <td>AL22</td> <td>VCC</td> <td>Power/Other</td> <td></td>	AL22	VCC	Power/Other	
AL25 VCC Power/Other AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AM1 VSS Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other AM3 VID2 Power/Other AM4 VSS Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other AM6 FC12 Power/Other AM8 VCC Power/Other AM8 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS </td <td>AL23</td> <td>VSS</td> <td>Power/Other</td> <td></td>	AL23	VSS	Power/Other	
AL26 VCC Power/Other AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AM30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other Output AM4 VSS Power/Other Output AM4 VSS Power/Other Output AM5 FC11 Power/Other Output AM6 VCC Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other <	AL24	VSS	Power/Other	
AL27 VSS Power/Other AL28 VSS Power/Other AL29 VCC Power/Other AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other Output AM4 VSS Power/Other Output AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM18 VCC Power/Other	AL25	VCC	Power/Other	
AL28 VSS Power/Other AL29 VCC Power/Other AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AL26	VCC	Power/Other	
AL29 VCC Power/Other AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other AM4 VSS Power/Other AM5 FC11 Power/Other Output AM7 FC12 Power/Other AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM14 VCC Power/Other AM15 Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AL27	VSS	Power/Other	
AL30 VCC Power/Other AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other Output AM4 VSS Power/Other AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AL28	VSS	Power/Other	
AM1 VSS Power/Other AM2 VID0 Power/Other Output AM3 VID2 Power/Other Output AM4 VSS Power/Other AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM20 VSS Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AL29	VCC	Power/Other	
AM2 VID0 Power/Other Output AM3 VID2 Power/Other Output AM4 VSS Power/Other Output AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other	AL30	VCC	Power/Other	
AM3 VID2 Power/Other Output AM4 VSS Power/Other Output AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM1	VSS	Power/Other	
AM4 VSS Power/Other AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM2	VID0	Power/Other	Output
AM5 FC11 Power/Other Output AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	АМ3	VID2	Power/Other	Output
AM7 FC12 Power/Other Output AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM4	VSS	Power/Other	
AM8 VCC Power/Other AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM5	FC11	Power/Other	Output
AM9 VCC Power/Other AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM7	FC12	Power/Other	Output
AM10 VSS Power/Other AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM8	VCC	Power/Other	
AM11 VCC Power/Other AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM9	VCC	Power/Other	
AM12 VCC Power/Other AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM10	VSS	Power/Other	
AM13 VSS Power/Other AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM11	VCC	Power/Other	
AM14 VCC Power/Other AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM12	VCC	Power/Other	
AM15 VCC Power/Other AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM13	VSS	Power/Other	
AM16 VSS Power/Other AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM14	VCC	Power/Other	
AM17 VSS Power/Other AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM15	VCC	Power/Other	
AM18 VCC Power/Other AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM16	VSS	Power/Other	
AM19 VCC Power/Other AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM17	VSS	Power/Other	
AM20 VSS Power/Other AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM18	VCC	Power/Other	
AM21 VCC Power/Other AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM19	VCC	Power/Other	
AM22 VCC Power/Other AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM20	VSS	Power/Other	
AM23 VSS Power/Other AM24 VSS Power/Other AM25 VCC Power/Other	AM21	VCC	Power/Other	
AM24 VSS Power/Other AM25 VCC Power/Other	AM22	VCC	Power/Other	
AM25 VCC Power/Other	AM23	VSS	Power/Other	
	AM24	VSS	Power/Other	
AM26 VCC Power/Other	AM25	VCC	Power/Other	
	AM26	VCC	Power/Other	



Table 4-2. Numerical Land Assignment

Signal Buffer Type Land **Land Name Direction** AM27 VSS Power/Other AM28 VSS Power/Other AM29 VCC Power/Other AM30 VCC Power/Other AN1 VSS Power/Other AN2 VSS Power/Other AN3 VCC_SENSE Power/Other Output AN4 VSS_SENSE Power/Other Output VCC_MB_ REGULATION AN5 Power/Other Output VSS_MB_ REGULATION AN6 Power/Other Output AN7 FC16 Power/Other Output AN8 VCC Power/Other AN9 VCC Power/Other AN10 VSS Power/Other AN11 VCC Power/Other AN12 VCC Power/Other Power/Other AN13 VSS AN14 VCC Power/Other AN15 VCC Power/Other

Table 4-2. Numerical Land Assignment

Land #	Land Name	Signal Buffer Type	Direction
AN16	VSS	Power/Other	
AN17	VSS	Power/Other	
AN18	VCC	Power/Other	
AN19	VCC	Power/Other	
AN20	VSS	Power/Other	
AN21	VCC	Power/Other	
AN22	VCC	Power/Other	
AN23	VSS	Power/Other	
AN24	VSS	Power/Other	
AN25	VCC	Power/Other	
AN26	VCC	Power/Other	
AN27	VSS	Power/Other	
AN28	VSS	Power/Other	
AN29	VCC	Power/Other	
AN30	VCC	Power/Other	



4.2 Alphabetical Signals Reference

Table 4-3. Signal Description (Sheet 1 of 8)

Name	Туре	Description	
A[35:3]#	Input/ Output	A[35:3]# (Address) define a 2 ³⁶ -byte physical memory address space. In sub-phase 1 of the address phase, these signals transmit the address of a transaction. In sub-phase 2, these signals transmit transaction type information. These signals must connect the appropriate pins/lands of all agents on the processor FSB. A[35:3]# are protected by parity signals AP[1:0]#. A[35:3]# are source synchronous signals and are latched into the receiving buffers by ADSTB[1:0]#. On the active-to-inactive transition of RESET#, the processor samples a subset of the A[35:3]# signals to determine power-on configuration. See Section 6.1 for	
		more details.	
A20M#	Input	If A20M# (Address-20 Mask) is asserted, the processor masks physical address bit 20 (A20#) before looking up a line in any internal cache and before driving a read/write transaction on the bus. Asserting A20M# emulates the 8086 processor's address wrap-around at the 1-MB boundary. Assertion of A20M# is only supported in real mode.	
		A20M# is an asynchronous signal. However, to ensure recognition of this signal following an Input/Output write instruction, it must be valid along with the TRDY# assertion of the corresponding Input/Output Write bus transaction.	
ADS#	Input/ Output	ADS# (Address Strobe) is asserted to indicate the validity of the transaction address on the A[35:3]# and REQ[4:0]# signals. All bus agents observe the ADS# activation to begin parity checking, protocol checking, address decode, internal snoop, or deferred reply ID match operations associated with the new transaction.	
		Address strobes are used to latch A[35:3]# and REQ[4:0]# on their rising and falling edges. Strobes are associated with signals as shown below.	
ADCTD[4.0]#	Input/	Signals Associated Strobe	
ADSTB[1:0]#	Output	REQ[4:0]#, A[16:3]# ADSTB0#	
		A[35:17]# ADSTB1#	
ADVA QVIII Input/		AP[1:0]# (Address Parity) are driven by the request initiator along with ADS#, A[35:3]#, and the transaction type on the REQ[4:0]#. A correct parity signal is high if an even number of covered signals are low and low if an odd number of covered signals are low. This allows parity to be high when all the covered signals are high. AP[1:0]# should connect the appropriate pins/lands of all processor FSB agents. The following table defines the coverage model of these signals.	
AP[1:0]# Outp	Output	Request Signals Subphase 1 Subphase 2	
		A[35:24]# AP0# AP1#	
		A[23:3]# AP1# AP0#	
		REQ[4:0]# AP1# AP0#	
BCLK[1:0]	Input	The differential pair BCLK (Bus Clock) determines the FSB frequency. All processor FSB agents must receive these signals to drive their outputs and latch their inputs.	
		All external timing parameters are specified with respect to the rising edge of BCLK0 crossing V _{CROSS} .	



Table 4-3. Signal Description (Sheet 2 of 8)

Name	Type	Description
		BINIT# (Bus Initialization) may be observed and driven by all processor FSB agents and if used, must connect the appropriate pins/lands of all such agents. If the BINIT# driver is enabled during power-on configuration, BINIT# is asserted to signal any bus condition that prevents reliable future operation.
BINIT#	Input/ Output	If BINIT# observation is enabled during power-on configuration, and BINIT# is sampled asserted, symmetric agents reset their bus LOCK# activity and bus request arbitration state machines. The bus agents do not reset their IOQ and transaction tracking state machines upon observation of BINIT# activation. Once the BINIT# assertion has been observed, the bus agents will re-arbitrate for the FSB and attempt completion of their bus queue and IOQ entries.
		If BINIT# observation is disabled during power-on configuration, a central agent may handle an assertion of BINIT# as appropriate to the error handling architecture of the system.
BNR#	Input/ Output	BNR# (Block Next Request) is used to assert a bus stall by any bus agent unable to accept new bus transactions. During a bus stall, the current bus owner cannot issue any new transactions.
BOOTSELECT	Input	This input is required to determine whether the processor is installed in a platform that supports the Pentium 4 processor in the 775-land package. The processor will not operate if this signal is low. This input has a weak internal pull-up to $V_{\rm CC}$.
		BPM[5:0]# (Breakpoint Monitor) are breakpoint and performance monitor signals. They are outputs from the processor which indicate the status of breakpoints and programmable counters used for monitoring processor performance. BPM[5:0]# should connect the appropriate pins/lands of all processor FSB agents.
BPM[5:0]#	Input/ Output	BPM4# provides PRDY# (Probe Ready) functionality for the TAP port. PRDY# is a processor output used by debug tools to determine processor debug readiness.
		BPM5# provides PREQ# (Probe Request) functionality for the TAP port. PREQ# is used by debug tools to request debug operation of the processor.
		These signals do not have on-die termination. Refer to Section 2.5 for termination requirements.
BPRI#	Input	BPRI# (Bus Priority Request) is used to arbitrate for ownership of the processor FSB. It must connect the appropriate pins/lands of all processor FSB agents. Observing BPRI# active (as asserted by the priority agent) causes all other agents to stop issuing new requests, unless such requests are part of an ongoing locked operation. The priority agent keeps BPRI# asserted until all of its requests are completed, then releases the bus by de-asserting BPRI#.
BR0#	Input/ Output	BR0# drives the BREQ0# signal in the system and is used by the processor to request the bus. During power-on configuration this signal is sampled to determine the agent ID = 0.
		This signal does not have on-die termination and must be terminated.
BSEL[2:0]	Output	The BCLK[1:0] frequency select signals BSEL[2:0] are used to select the processor input clock frequency. Table 2-6 defines the possible combinations of the signals and the frequency associated with each combination. The required frequency is determined by the processor, chipset and clock synthesizer. All agents must operate at the same frequency. For more information about these signals, including termination recommendations refer to Section 2.9.
COMP[1:0]	Analog	COMP[1:0] must be terminated to V _{SS} on the system board using precision resistors.



Table 4-3. Signal Description (Sheet 3 of 8)

Name	Type		Desci	ription	
		D[63:0]# (Data) are the data signals. These signals provide a 64-bit data path between the processor FSB agents, and must connect the appropriate pins/lands on all such agents. The data driver asserts DRDY# to indicate a valid data transfer.			
		common clock period. DSTBP[3:0]# and DS	D[63:0]# are latc FBN[3:0]#. Each g nd one DSTBN#.	will, thus, be driven four times in a hed off the falling edge of both group of 16 data signals correspond to The following table shows the grouping.	
		Quad-Pumped Signa	I Groups		
D[63:0]#	Input/ Output	Data Group	DSTBN#/ DSTBP#	DBI#	
		D[15:0]#	0	0	
		D[31:16]#	1	1	
l		D[47:32]#	2	2	
		D[63:48]#	3	3	
		group of 16 data signa	als corresponds to	e the polarity of the data signals. Each one DBI# signal. When the DBI# sign s inverted and therefore sampled active.	nal
		DBI[3:0]# (Data Bus Inversion) are source synchronous and indicate the polarity of the D[63:0]# signals. The DBI[3:0]# signals are activated when the data on the data bus is inverted. If more than half the data bits, within a 16-bit group, would have been asserted electrically low, the bus agent may invert the data bus signals for that particular sub-phase for that 16-bit group.			
		DBI[3:0] Assignmen	t To Data Bus		
DBI[3:0]#	Input/ Output	Bus Signal	Data Bus Signa	als	
		DBI3#	D[63:48]#		
		DBI2#	D[47:32]#		
		DBI1#	D[31:16]#		
		DBI0#	D[15:0]#		
DBR#	Output	implemented on the sy that an in-target probe	ystem board. DBF can drive system	ocessor systems where no debug port t# is used by a debug port interposer s reset. If a debug port is implemented e system. DBR# is not a processor	so
DBSY#	Input/ Output	the processor FSB to	indicate that the c is de-asserted. T	the agent responsible for driving data of lata bus is in use. The data bus is his signal must connect the appropria	
DEFER#	Input	DEFER# is asserted by an agent to indicate that a transaction cannot be guaranteed in-order completion. Assertion of DEFER# is normally the responsibility of the addressed memory or input/output agent. This signal must connect the appropriate pins/lands of all processor FSB agents.			
DP[3:0]#	Input/ Output		nt responsible for	otection for the D[63:0]# signals. They driving D[63:0]#, and must connect the SB agents.	



Table 4-3. Signal Description (Sheet 4 of 8)

Name	Туре	Description		
DRDY#	Input/ Output	DRDY# (Data Ready) is asserted by the data driver on each data transfer, indicating valid data on the data bus. In a multi-common clock data transfer, DRDY# may be de-asserted to insert idle clocks. This signal must connect the appropriate pins/lands of all processor FSB agents.		
		DSTBN[3:0]# are the data strobes used to latch in D[63:0]#.		
		Signals Associated Strobe		
	Input/	D[15:0]#, DBI0# DSTBN0#		
DSTBN[3:0]#	Output	D[31:16]#, DBI1# DSTBN1#		
		D[47:32]#, DBI2# DSTBN2#		
		D[63:48]#, DBI3# DSTBN3#		
		DSTBP[3:0]# are the data strobes used to latch in D[63:0]#.		
		Signals Associated Strobe		
DOTDDIO 01#	Input/	D[15:0]#, DBI0# DSTBP0#		
DSTBP[3:0]#	Output	D[31:16]#, DBI1# DSTBP1#		
		D[47:32]#, DBI2# DSTBP2#		
		D[63:48]#, DBI3# DSTBP3#		
FCx	Other	FC signals are signals that are available for compatibility with other processors.		
FERR#/PBE#	Output	FERR#/PBE# (floating point error/pending break event) is a multiplexed signal and its meaning is qualified by STPCLK#. When STPCLK# is not asserted, FERR#/PBE# indicates a floating-point error and will be asserted when the processor detects an unmasked floating-point error. When STPCLK# is not asserted, FERR#/PBE# is similar to the ERROR# signal on the Intel 387 coprocessor, and is included for compatibility with systems using MS-DOS*-type floating-point error reporting. When STPCLK# is asserted, an assertion of FERR#/PBE# indicates that the processor has a pending break event waiting for service. The assertion of FERR#/PBE# indicates that the processor should be returned to the Normal state. For additional information on the pending break event functionality, including the identification of support of the feature and enable/disable information, refer to volume 3 of the Intel Architecture Software Developer's Manual and the Intel Processor Identification and the CPUID Instruction application note.		
GTLREF	Input	GTLREF determines the signal reference level for GTL+ input signals. GTLREF is used by the GTL+ receivers to determine if a signal is a logical 0 or logical 1.		
GTLREF_SEL	Output	GTLREF_SEL is used to select the appropriate chipset GTLREF voltage.		
HIT#	Input/ Output	HIT# (Snoop Hit) and HITM# (Hit Modified) convey transaction snoop operation results. Any FSB agent may assert both HIT# and HITM# together to indicate that it requires a snoop stall, which can be continued by reasserting HIT# and HITM# together.		
HITM#	Input/ Output			
IERR#	Output	IERR# (Internal Error) is asserted by a processor as the result of an internal error. Assertion of IERR# is usually accompanied by a SHUTDOWN transaction on the processor FSB. This transaction may optionally be converted to an external error signal (e.g., NMI) by system core logic. The processor will keep IERR# asserted until the assertion of RESET#. This signal does not have on-die termination. Refer to Section 2.5 for termination requirements.		



Table 4-3. Signal Description (Sheet 5 of 8)

Name	Туре	Description
IGNNE#	Input	IGNNE# (Ignore Numeric Error) is asserted to force the processor to ignore a numeric error and continue to execute noncontrol floating-point instructions. If IGNNE# is de-asserted, the processor generates an exception on a noncontrol floating-point instruction if a previous floating-point instruction caused an error. IGNNE# has no effect when the NE bit in control register 0 (CR0) is set. IGNNE# is an asynchronous signal. However, to ensure recognition of this signal following as length (Output write instruction, it must be valid along with the
		signal following an Input/Output write instruction, it must be valid along with the TRDY# assertion of the corresponding Input/Output Write bus transaction.
INIT#	Input	INIT# (Initialization), when asserted, resets integer registers inside the processor without affecting its internal caches or floating-point registers. The processor then begins execution at the power-on Reset vector configured during power-on configuration. The processor continues to handle snoop requests during INIT# assertion. INIT# is an asynchronous signal and must connect the appropriate pins/lands of all processor FSB agents.
		If INIT# is sampled active on the active to inactive transition of RESET#, then the processor executes its Built-in Self-Test (BIST).
ITP_CLK[1:0]	Input	ITP_CLK[1:0] are copies of BCLK that are used only in processor systems where no debug port is implemented on the system board. ITP_CLK[1:0] are used as BCLK[1:0] references for a debug port implemented on an interposer. If a debug port is implemented in the system, ITP_CLK[1:0] are no connects in the system. These are not processor signals.
LINT[1:0]	Input	LINT[1:0] (Local APIC Interrupt) must connect the appropriate pins/lands of all APIC Bus agents. When the APIC is disabled, the LINT0 signal becomes INTR, a maskable interrupt request signal, and LINT1 becomes NMI, a nonmaskable interrupt. INTR and NMI are backward compatible with the signals of those names on the Pentium processor. Both signals are asynchronous.
		Both of these signals must be software configured via BIOS programming of the APIC register space to be used either as NMI/INTR or LINT[1:0]. Because the APIC is enabled by default after Reset, operation of these signals as LINT[1:0] is the default configuration.
LL_ID[1:0]	Output	The LL_ID[1:0] signals are used to select the correct loadline slope for the processor. LL_ID[1:0] = 00 for the Pentium 4 processor in the 775-land package.
LOCK#	Input/ Output	LOCK# indicates to the system that a transaction must occur atomically. This signal must connect the appropriate pins/lands of all processor FSB agents. For a locked sequence of transactions, LOCK# is asserted from the beginning of the first transaction to the end of the last transaction.
LOCK#		When the priority agent asserts BPRI# to arbitrate for ownership of the processor FSB, it will wait until it observes LOCK# de-asserted. This enables symmetric agents to retain ownership of the processor FSB throughout the bus locked operation and ensure the atomicity of lock.
	Input/ Output	MCERR# (Machine Check Error) is asserted to indicate an unrecoverable error without a bus protocol violation. It may be driven by all processor FSB agents.
		MCERR# assertion conditions are configurable at a system level. Assertion options are defined by the following options:
MCERR#		Enabled or disabled. Accorted if configured for integral errors along with IEPP#
WICERR#		 Asserted, if configured, for internal errors along with IERR#. Asserted, if configured, by the request initiator of a bus transaction after it observes an error.
		 Asserted by any bus agent when it observes an error in a bus transaction.
		For more details regarding machine check architecture, refer to the IA-32 Software Developer's Manual, Volume 3: System Programming Guide.
MSID[1:0]	Output	MSID[1:0] are provided to indicate the market segment for the processor and may be used for future processor compatibility or for keying.



Table 4-3. Signal Description (Sheet 6 of 8)

Name	Туре	Description
PROCHOT#	Input/ Output	As an output, PROCHOT# (Processor Hot) will go active when the processor temperature monitoring sensor detects that the processor has reached its maximum safe operating temperature. This indicates that the processor Thermal Control Circuit (TCC) has been activated, if enabled. As an input, assertion of PROCHOT# by the system will activate the TCC, if enabled. The TCC will remain active until the system de-asserts PROCHOT#. See Section 5.2.4 for more details.
PWRGOOD	Input	PWRGOOD (Power Good) is a processor input. The processor requires this signal to be a clean indication that the clocks and power supplies are stable and within their specifications. 'Clean' implies that the signal will remain low (capable of sinking leakage current), without glitches, from the time that the power supplies are turned on until they come within specification. The signal must then transition monotonically to a high state. PWRGOOD can be driven inactive at any time, but clocks and power must again be stable before a subsequent rising edge of PWRGOOD. The PWRGOOD signal must be supplied to the processor; it is used to protect internal circuits against voltage sequencing issues. It should be driven high throughout boundary scan operation.
REQ[4:0]#	Input/ Output	REQ[4:0]# (Request Command) must connect the appropriate pins/lands of all processor FSB agents. They are asserted by the current bus owner to define the currently active transaction type. These signals are source synchronous to ADSTB0#. Refer to the AP[1:0]# signal description for a details on parity checking of these signals.
RESET#	Input	Asserting the RESET# signal resets the processor to a known state and invalidates its internal caches without writing back any of their contents. For a power-on Reset, RESET# must stay active for at least one millisecond after V _{CC} and BCLK have reached their proper specifications. On observing active RESET#, all FSB agents will de-assert their outputs within two clocks. RESET# must not be kept asserted for more than 10 ms while PWRGOOD is asserted.
		A number of bus signals are sampled at the active-to-inactive transition of RESET# for power-on configuration. These configuration options are described in the Section 6.1.
		This signal does not have on-die termination and must be terminated on the system board.
RS[2:0]#	Input	RS[2:0]# (Response Status) are driven by the response agent (the agent responsible for completion of the current transaction), and must connect the appropriate pins/lands of all processor FSB agents.
RSP#	Input	RSP# (Response Parity) is driven by the response agent (the agent responsible for completion of the current transaction) during assertion of RS[2:0]#, the signals for which RSP# provides parity protection. It must connect to the appropriate pins/lands of all processor FSB agents.
		A correct parity signal is high if an even number of covered signals are low and low if an odd number of covered signals are low. While RS[2:0]# = 000, RSP# is also high, since this indicates it is not being driven by any agent guaranteeing correct parity.
SKTOCC#	Output	SKTOCC# (Socket Occupied) will be pulled to ground by the processor. System board designers may use this signal to determine if the processor is present.
SMI#	Input	SMI# (System Management Interrupt) is asserted asynchronously by system logic. On accepting a System Management Interrupt, the processor saves the current state and enter System Management Mode (SMM). An SMI Acknowledge transaction is issued, and the processor begins program execution from the SMM handler.
		If SMI# is asserted during the de-assertion of RESET#, the processor will tristate its outputs.



Table 4-3. Signal Description (Sheet 7 of 8)

Name	Туре	Description
STPCLK#	Input	STPCLK# (Stop Clock), when asserted, causes the processor to enter a low power Stop-Grant state. The processor issues a Stop-Grant Acknowledge transaction, and stops providing internal clock signals to all processor core units except the FSB and APIC units. The processor continues to snoop bus transactions and service interrupts while in Stop-Grant state. When STPCLK# is de-asserted, the processor restarts its internal clock to all units and resumes execution. The assertion of STPCLK# has no effect on the bus clock; STPCLK# is an asynchronous input.
тск	Input	TCK (Test Clock) provides the clock input for the processor Test Bus (also known as the Test Access Port).
TDI	Input	TDI (Test Data In) transfers serial test data into the processor. TDI provides the serial input needed for JTAG specification support.
TDO	Output	TDO (Test Data Out) transfers serial test data out of the processor. TDO provides the serial output needed for JTAG specification support.
TESTHI[13:0]	Input	TESTHI[13:0] must be connected to the processor's appropriate power source (refer to VTT_OUT_LEFT and VTT_OUT_RIGHT signal description) through a resistor for proper processor operation. See Section 2.5 for more details.
THERMDA	Other	Thermal Diode Anode. See Section 5.2.7.
THERMDC	Other	Thermal Diode Cathode. See Section 5.2.7.
THERMTRIP#	Output	In the event of a catastrophic cooling failure, the processor will automatically shut down when the silicon has reached a temperature approximately 20 °C above the maximum $T_{\rm c}.$ Assertion of THERMTRIP# (Thermal Trip) indicates the processor junction temperature has reached a level beyond where permanent silicon damage may occur. Upon assertion of THERMTRIP#, the processor will shut off its internal clocks (thus, halting program execution) in an attempt to reduce the processor junction temperature. To protect the processor, its core voltage ($V_{\rm cc}$) must be removed following the assertion of THERMTRIP#. Driving of the THERMTRIP# signal is enabled within 10 μs of the assertion of PWRGOOD and is disabled on de-assertion of PWRGOOD. Once activated, THERMTRIP# remains latched until PWRGOOD is de-asserted. While the deassertion of the PWRGOOD signal will de-assert THERMTRIP#, if the processor's junction temperature remains at or above the trip level, THERMTRIP# will again be asserted within 10 μs of the assertion of PWRGOOD.
TMS	Input	TMS (Test Mode Select) is a JTAG specification support signal used by debug tools.
TRDY#	Input	TRDY# (Target Ready) is asserted by the target to indicate that it is ready to receive a write or implicit writeback data transfer. TRDY# must connect the appropriate pins/lands of all FSB agents.
TRST#	Input	TRST# (Test Reset) resets the Test Access Port (TAP) logic. TRST# must be driven low during power on Reset.
vcc	Input	VCC are the power pins for the processor. The voltage supplied to these pins is determined by the VID[5:0] pins.
VCCA	Input	VCCA provides isolated power for the internal processor core PLLs.
VCCIOPLL	Input	VCCIOPLL provides isolated power for internal processor FSB PLLs.
VCC_SENSE	Output	VCC_SENSE is an isolated low impedance connection to processor core power (V_{CC}) . It can be used to sense or measure voltage near the silicon with little noise.
VCC_MB_ REGULATION	Output	This land is provided as a voltage regulator feedback sense point for V _{CC} . It is connected internally in the processor package to the sense point land U27 as described in the <i>Voltage Regulator-Down (VRD) 10.1 Design Guide for Desktop Socket 775</i> .



Table 4-3. Signal Description (Sheet 8 of 8)

Name	Туре	Description		
VID[5:0]	Output	VID[5:0] (Voltage ID) signals are used to support automatic selection of power supply voltages ($V_{\rm CC}$). These are open drain signals that are driven by the processor and must be pulled up on the motherboard. Refer to the <i>Voltage Regulator-Down (VRD) 10.1 Design Guide for Desktop Socket 775</i> for more information. The voltage supply for these signals must be valid before the VR can supply $V_{\rm CC}$ to the processor. Conversely, the VR output must be disabled until the voltage supply for the VID signals becomes valid. The VID signals are needed to support the processor voltage specification variations. See Table 2-2 for definitions of these signals. The VR must supply the voltage that is requested by the signals, or disable itself.		
VSS	Input	VSS are the ground pins for the processor and should be connected to the system ground plane.		
VSSA	Input	VSSA is the isolated ground for internal PLLs.		
VSS_SENSE	Output	VSS_SENSE is an isolated low impedance connection to processor core V _{SS} . It can be used to sense or measure ground near the silicon with little noise.		
VSS_MB_ REGULATION	Output	This land is provided as a voltage regulator feedback sense point for V _{SS} . It is connected internally in the processor package to the sense point land V27 as described in the <i>Voltage Regulator-Down (VRD) 10.1 Design Guide for Desktop Socket 775.</i>		
VTT		Miscellaneous voltage supply.		
		The VTT_OUT_LEFT and VTT_OUT_RIGHT signals are included to provide a voltage supply for some signals that require termination to V _{TT} on the motherboard.		
VTT_OUT_LEFT		For future processor compatibility some signals are required to be pulled up to VTT_OUT_LEFT or VTT_OUT_RIGHT. Refer to the following table for the signals that should be pulled up to VTT_OUT_LEFT and VTT_OUT_RIGHT.		
VTT_OUT_RIGHT	Output	Pull-up Signal Signals to be Pulled Up		
VII_OUI_RIGHT		VTT_OUT_RIGHT VTT_PWRGOOD, VID[5:0], GTLREF, TMS, TDI, TDO, BPM[5:0], other VRD components		
		VTT_OUT_LEFT RESET#, BR0#, PWRGOOD, TESTHI1, TESTHI8, TESTHI9, TESTHI10, TESTHI11, TESTHI12		
VTT_SEL	Output	The VTT_SEL signal is used to select the correct V _{TT} voltage level for the processor.		
VTTPWRGD	Input	The processor requires this input to determine that the V _{TT} voltages are stable and within specification.		

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5 Thermal Specifications and Design Considerations

5.1 Processor Thermal Specifications

The Pentium 4 processor in the 775-land package requires a thermal solution to maintain temperatures within operating limits as set forth in Section 5.1.1. Any attempt to operate the processor outside these operating limits may result in permanent damage to the processor and potentially other components within the system. As processor technology changes, thermal management becomes increasingly crucial when building computer systems. Maintaining the proper thermal environment is key to reliable, long-term system operation.

A complete thermal solution includes both component and system level thermal management features. Component level thermal solutions can include active or passive heatsinks attached to the processor Integrated Heat Spreader (IHS). Typical system level thermal solutions may consist of system fans combined with ducting and venting.

For more information on designing a component level thermal solution, refer to the *Intel*[®] *Pentium*[®] 4 *Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines*.

Note: The boxed processor will ship with a component thermal solution. Refer to Chapter 7 for details on the boxed processor.

5.1.1 Thermal Specifications

To allow for the optimal operation and long-term reliability of Intel processor-based systems, the system/processor thermal solution should be designed such that the processor remains within the minimum and maximum case temperature (T_C) specifications when operating at or below the Thermal Design Power (TDP) value listed per frequency in Table 5-1. Thermal solutions not designed to provide this level of thermal capability may affect the long-term reliability of the processor and system. For more details on thermal solution design, refer to the appropriate processor thermal design guidelines.

The Pentium 4 processor in the 775-land package introduces a new methodology for managing processor temperatures which is intended to support acoustic noise reduction through fan speed control. Selection of the appropriate fan speed will be based on the temperature reported by the processor's thermal diode. If the diode temperature is greater than or equal to $T_{CONTROL}$, the processor case temperature must remain at or below the temperature as specified by the thermal profile. If the diode temperature is less than $T_{CONTROL}$ then the case temperature is permitted to exceed the thermal profile, but the diode temperature must remain at or below $T_{CONTROL}$. Systems that implement fan speed control must be designed to take these conditions into account. Systems that do not alter the fan speed only need to guarantee the case temperature meets the thermal profile specifications.

To determine a processor's case temperature specification based on the thermal profile, it is necessary to accurately measure processor power dissipation.

Thermal Specifications and Design Considerations



The case temperature is defined at the geometric top center of the processor IHS. Analysis indicates that real applications are unlikely to cause the processor to consume maximum power dissipation for sustained periods of time. Intel recommends that complete thermal solution designs target the Thermal Design Power (TDP) indicated in Table 5-1 instead of the maximum processor power consumption. The Thermal Monitor feature is intended to help protect the processor in the unlikely event that an application exceeds the TDP recommendation for a sustained period of time. For more details on the usage of this feature, refer to Section 5.2. In all cases, the Thermal Monitor feature must be enabled for the processor to remain within specification.

Table 5-1. Processor Thermal Specifications

Processor Number	Core Frequency (GHz)	Thermal Design Power (W)	Minimum T _C (°C)	Maximum T _C (°C)	Notes
520/521	2.80 (PRB = 0)	84	5	See Table 5-3 and Figure 5-2	1, 2
530/531	3 (PRB = 0)	84	5	See Table 5-3 and Figure 5-2	1, 2
540/541	3.20 (PRB = 0)	84	5	See Table 5-3 and Figure 5-2	1, 2
550/551	3.40 (PRB = 0)	84	5	See Table 5-3 and Figure 5-2	1, 2
550	3.40 (PRB = 1)	115	5	See Table 5-2 and Figure 5-1	1, 2
560/561	3.60 (PRB = 1)	115	5	See Table 5-2 and Figure 5-1	1, 2
570/571	3.80 (PRB = 1)	115	5	See Table 5-2 and Figure 5-1	1, 2

NOTES:

- Thermal Design Power (TDP) should be used for processor thermal solution design targets. The TDP is not the maximum power that the processor can dissipate.
- This table shows the maximum TDP for a given frequency range. Individual processors may have a lower TDP. Therefore, the
 maximum T_C will vary depending on the TDP of the individual processor. Refer to thermal profile figure and associated table
 for the allowed combinations of power and T_C.



Table 5-2. Thermal Profile for Processors with PRB = 1

Power (W)	Maximum T _C (°C)
0	44.0
2	44.5
4	45.0
6	45.5
8	46.0
10	46.5
12	47.0
14	47.5
16	48.0
18	48.5
20	49.0
22	49.5
24	50.0
26	50.5
28	51.0

Power (W)	Maximum T _C (°C)		
30	51.5		
32	52.0		
34	52.5		
36	53.0		
38	53.5		
40	54.0		
42	54.5		
44	55.0		
46	55.5		
48	56.0		
50	56.5		
52	57.0		
54	57.5		
56	58.0		
58	58.5		

Power (W)	Maximum T _C (°C)		
60	59.0		
62	59.5		
64	60.0		
66	60.5		
68	61.0		
70	61.5		
72	62.0		
74	62.5		
76	63.0		
78	63.5		
80	64.0		
82	64.5		
84	65.0		
86	65.5		
88	66.0		

Power (W)	Maximum T _C (°C)
90	66.5
92	67.0
94	67.5
96	68.0
98	68.5
100	69.0
102	69.5
104	70.0
106	70.5
108	71.0
110	71.5
112	72.0
114	72.5
115	72.8

Figure 5-1. Thermal Profile for Processors with PRB = 1

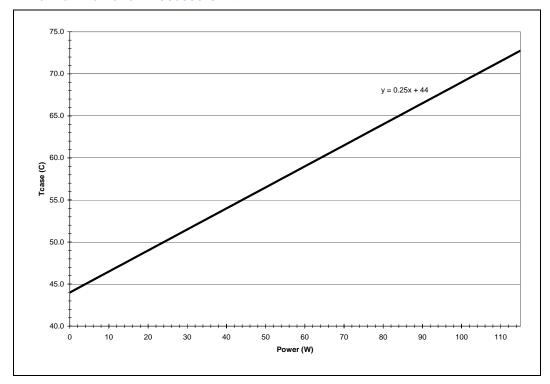




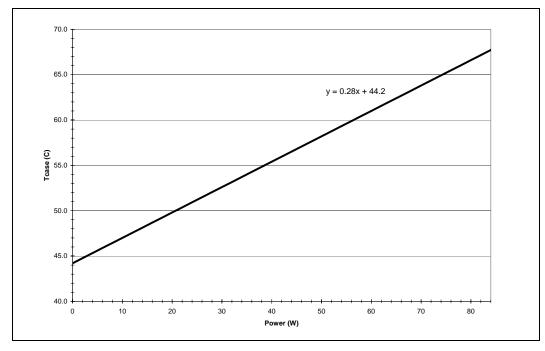
Table 5-3. Thermal Profile for Processors with PRB = 0

Power (W)	Maximum Tc (°C)		
0	44.2		
2	44.8		
4	45.3		
6	45.9		
8	46.4		
10	47.0		
12	47.6		
14	48.1		
16	48.7		
18	49.2		
20	49.8		
22	50.4		
24	50.9		
26	51.5		
28	52.0		

Power (W)	Maximum Tc (°C)
30	52.6
32	53.2
34	53.7
36	54.3
38	54.8
40	55.4
42	56.0
44	56.5
46	57.1
48	57.6
50	58.2
52	58.8
54	59.3
56	59.9
58	60.4

Power (W)	Maximum Tc (°C)	
60	61.0	
62	61.6	
64	62.1	
66	62.7	
68	63.2	
70	63.8	
72	64.4	
74	64.9	
76	65.5	
78	66.0	
80	66.6	
82	67.2	
84	67.7	

Figure 5-2. Thermal Profile for Processors with PRB = 0

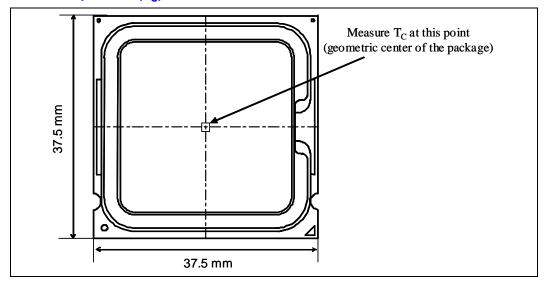




5.1.2 Thermal Metrology

The maximum and minimum case temperatures (T_C) are specified in Table 5-1. These temperature specifications are meant to help ensure proper operation of the processor. Figure 5-3 illustrates where Intel recommends T_C thermal measurements should be made. For detailed guidelines on temperature measurement methodology, refer to the $Intel^{\circledR}$ Pentium $^{\circledR}$ 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines.

Figure 5-3. Case Temperature (T_C) Measurement Location



5.2 Processor Thermal Features

5.2.1 Thermal Monitor

The Thermal Monitor feature helps control the processor temperature by activating the TCC when the processor silicon reaches its maximum operating temperature. The TCC reduces processor power consumption as needed by modulating (starting and stopping) the internal processor core clocks. The Thermal Monitor feature must be enabled for the processor to be operating within specifications. The temperature at which Thermal Monitor activates the thermal control circuit is not user configurable and is not software visible. Bus traffic is snooped in the normal manner, and interrupt requests are latched (and serviced during the time that the clocks are on) while the TCC is active.

When the Thermal Monitor feature is enabled, and a high temperature situation exists (i.e., TCC is active), the clocks will be modulated by alternately turning the clocks off and on at a duty cycle specific to the processor (typically 30–50%). Clocks often will not be off for more than 3.0 microseconds when the TCC is active. Cycle times are processor speed dependent and will decrease as processor core frequencies increase. A small amount of hysteresis has been included to prevent rapid active/inactive transitions of the TCC when the processor temperature is near its maximum operating temperature. Once the temperature has dropped below the maximum operating temperature, and the hysteresis timer has expired, the TCC goes inactive and clock modulation ceases.

Thermal Specifications and Design Considerations



With a properly designed and characterized thermal solution, it is anticipated that the TCC would only be activated for very short periods of time when running the most power intensive applications. The processor performance impact due to these brief periods of TCC activation is expected to be so minor that it would be immeasurable. An under-designed thermal solution that is not able to prevent excessive activation of the TCC in the anticipated ambient environment may cause a noticeable performance loss, and in some cases may result in a T_C that exceeds the specified maximum temperature and may affect the long-term reliability of the processor. In addition, a thermal solution that is significantly under-designed may not be capable of cooling the processor even when the TCC is active continuously. Refer to the Intel® Pentium® 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines for information on designing a thermal solution.

The duty cycle for the TCC, when activated by the Thermal Monitor, is factory configured and cannot be modified. The Thermal Monitor does not require any additional hardware, software drivers, or interrupt handling routines.

5.2.2 Thermal Monitor 2

The Pentium 4 processor in the 775-land package also supports a power management capability known as Thermal Monitor 2. This mechanism provides an efficient mechanism for limiting the processor temperature by reducing power consumption within the processor.

When Thermal Monitor 2 is enabled, and a high temperature situation is detected, the enhanced Thermal Control Circuit (TCC) will be activated. This enhanced TCC causes the processor to adjust its operating frequency (bus multiplier) and input voltage (VID). This combination of reduced frequency and VID results in a decrease in processor power consumption.

A processor enabled for Thermal Monitor 2 includes two operating points, each consisting of a specific operating frequency and voltage. The first point represents the normal operating conditions for the processor.

The second point consists of both a lower operating frequency and voltage. When the enhanced TCC is activated, the processor automatically transitions to the new frequency. This transition occurs very rapidly (on the order of $5~\mu s$). During the frequency transition, the processor is unable to service any bus requests, and consequently, all bus traffic is blocked. Edge-triggered interrupts will be latched and kept pending until the processor resumes operation at the new frequency.

Once the new operating frequency is engaged, the processor will transition to the new core operating voltage by issuing a new VID code to the voltage regulator. The voltage regulator must support VID transitions in order to support Thermal Monitor 2. During the voltage change, it will be necessary to transition through multiple VID codes to reach the target operating voltage. Each step will be one VID table entry (i.e., 12.5 mV steps). The processor continues to execute instructions during the voltage transition. Operation at this lower voltage reduces both the dynamic and leakage power consumption of the processor, providing a reduction in power consumption at a minimum performance impact.

Once the processor has sufficiently cooled, and a minimum activation time has expired, the operating frequency and voltage transition back to the normal system operating point. Transition of the VID code will occur first, to insure proper operation once the processor reaches its normal operating frequency. Refer to Figure 5-4 for an illustration of this ordering.



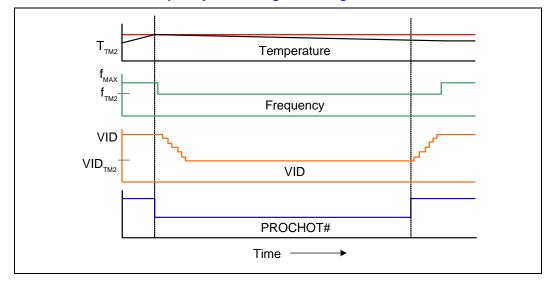


Figure 5-4. Thermal Monitor 2 Frequency and Voltage Ordering

The PROCHOT# signal is asserted when a high temperature situation is detected, regardless of whether or not Thermal Monitor or Thermal Monitor 2 is enabled.

It should be noted that the Thermal Monitor 2 TCC can not be activated via the on demand mode. The Thermal Monitor TCC, however, can be activated through the use of the on demand mode.

5.2.3 On-Demand Mode

The Pentium 4 processor in the 775-land package provides an auxiliary mechanism that allows system software to force the processor to reduce its power consumption. This mechanism is referred to as "On-Demand" mode and is distinct from the Thermal Monitor feature. On-Demand mode is intended as a means to reduce system level power consumption. Systems using the Pentium 4 processor in the 775-land package must not rely on software usage of this mechanism to limit the processor temperature.

If bit 4 of the ACPI P_CNT Control Register (located in the processor IA32_THERM_CONTROL MSR) is written to a '1', the processor will immediately reduce its power consumption via modulation (starting and stopping) of the internal core clock, independent of the processor temperature. When using On-Demand mode, the duty cycle of the clock modulation is programmable via bits 3:1 of the same ACPI P_CNT Control Register. In On-Demand mode, the duty cycle can be programmed from 12.5% on/ 87.5% off, to 87.5% on/12.5% off in 12.5% increments. On-Demand mode may be used in conjunction with the Thermal Monitor. If the system tries to enable On-Demand mode at the same time the TCC is engaged, the factory configured duty cycle of the TCC will override the duty cycle selected by the On-Demand mode.



5.2.4 PROCHOT# Signal

An external signal, PROCHOT# (processor hot), is asserted when the processor die temperature has reached its maximum operating temperature. If the Thermal Monitor is enabled (note that the Thermal Monitor must be enabled for the processor to be operating within specification), the TCC will be active when PROCHOT# is asserted. The processor can be configured to generate an interrupt upon the assertion or de-assertion of PROCHOT#. Refer to the *Intel Architecture Software Developer's Manuals* for specific register and programming details.

The Pentium 4 processor in the 775-land package implements a bi-directional PROCHOT# capability to allow system designs to protect various components from over-temperature situations. The PROCHOT# signal is bi-directional in that it can either signal when the processor has reached its maximum operating temperature or be driven from an external source to activate the TCC. The ability to activate the TCC via PROCHOT# can provide a means for thermal protection of system components.

One application is the thermal protection of voltage regulators (VR). System designers can create a circuit to monitor the VR temperature and activate the TCC when the temperature limit of the VR is reached. By asserting PROCHOT# (pulled-low) and activating the TCC, the VR can cool down as a result of reduced processor power consumption. Bi-directional PROCHOT# can allow VR thermal designs to target maximum sustained current instead of maximum current. Systems should still provide proper cooling for the VR, and rely on bi-directional PROCHOT# only as a backup in case of system cooling failure. The system thermal design should allow the power delivery circuitry to operate within its temperature specification even while the processor is operating at its Thermal Design Power. With a properly designed and characterized thermal solution, it is anticipated that bi-directional PROCHOT# would only be asserted for very short periods of time when running the most power intensive applications. An under-designed thermal solution that is not able to prevent excessive assertion of PROCHOT# in the anticipated ambient environment may cause a noticeable performance loss. Refer to the *Voltage Regulator-Down (VRD) 10.1 Design Guide for Desktop Socket 775* for details on implementing the bi-directional PROCHOT# feature.

5.2.5 THERMTRIP# Signal

Regardless of whether or not the Thermal Monitor feature is enabled, in the event of a catastrophic cooling failure, the processor will automatically shut down when the silicon has reached an elevated temperature (refer to the THERMTRIP# definition in Table 4-3). At this point, the FSB signal THERMTRIP# will go active and stay active as described in Table 4-3. THERMTRIP# activation is independent of processor activity and does not generate any bus cycles.

5.2.6 T_{CONTROL} and Fan Speed Reduction

 $T_{CONTROL}$ is a temperature specification based on a temperature reading from the thermal diode. The value for $T_{CONTROL}$ will be calibrated in manufacturing and configured for each processor. When T_{diode} is above $T_{CONTROL}$, then T_{C} must be at or below T_{C-MAX} as defined by the thermal profile in Table 5-2 and Figure 5-1; otherwise, the processor temperature can be maintained at $T_{CONTROL}$ (or lower) as measured by the thermal diode.

The purpose of this feature is to support acoustic optimization through fan speed control. Contact your Intel representative for further details and documentation.



5.2.7 Thermal Diode

The processor incorporates an on-die thermal diode. A thermal sensor located on the system board may monitor the die temperature of the processor for thermal management/long term die temperature change purposes. Table 5-4 and Table 5-5 provide the diode parameter and interface specifications. This thermal diode is separate from the Thermal Monitor's thermal sensor and cannot be used to predict the behavior of the Thermal Monitor.

Table 5-4. Thermal Diode Parameters

Symbol	Parameter	Min	Тур	Max	Unit	Notes
I _{FW}	Forward Bias Current	11		187	μΑ	1
n	Diode Ideality Factor	1.0083	1.011	1.023		2, 3, 4, 5
R _T	Series Resistance	3.242	3.33	3.594	Ω	2, 3, 6

NOTES:

- 1. Intel does not support or recommend operation of the thermal diode under reverse bias.
- Characterized at 75 °C.
- Not 100% tested. Specified by design characterization.
- 4. The ideality factor, n, represents the deviation from ideal diode behavior as exemplified by the diode equation:

$$I_{FW} = I_S * (e^{qV_D/nkT} - 1)$$

where I_S = saturation current, q = electronic charge, V_D = voltage across the diode, k = Boltzmann Constant, and T = absolute temperature (Kelvin).

- Devices found to have an ideality factor of 1.0183 to 1.023 will create a temperature error approximately 2 C° higher than
 the actual temperature. To minimize any potential acoustic impact of this temperature error, T_{CONTROL} will be increased by
 2 C° on these parts.
- 6. The series resistance, R_T, is provided to allow for a more accurate measurement of the thermal diode temperature. R_T, as defined, includes the pins of the processor but does not include any socket resistance or board trace resistance between the socket and the external remote diode thermal sensor. RT can be used by remote diode thermal sensors with automatic series resistance cancellation to calibrate out this error term. Another application is that a temperature offset can be manually calculated and programmed into an offset register in the remote diode thermal sensors as exemplified by the equation:

$$T_{error} = [R_T * (N-1) * I_{FWmin}] / [nk/q * ln N]$$

where T_{error} = sensor temperature error, N = sensor current ratio, k = Boltzmann Constant, q = electronic charge.

Table 5-5. Thermal Diode Interface

Signal Name	Land Number	Signal Description
THERMDA	AL1	diode anode
THERMDC	AK1	diode cathode

Thermal Specifications and Design Considerations





6 Features

6.1 Power-On Configuration Options

Several configuration options can be configured by hardware. The Pentium 4 processor in the 775-land package samples the hardware configuration at reset, on the active-to-inactive transition of RESET#. For specifications on these options, refer to Table 6-1.

The sampled information configures the processor for subsequent operation. These configuration options cannot be changed except by another reset. All resets reconfigure the processor; for reset purposes, the processor does not distinguish between a "warm" reset and a "power-on" reset.

Frequency determination functionality will exist on engineering sample processors which means that samples can run at varied frequencies. Production material will have the bus to core ratio locked and can only be operated at the rated frequency.

Table 6-1. Power-On Configuration Option Signals

Configuration Option	Signal ^{1, 2}
Output tristate	SMI#
Execute BIST	INIT#
In Order Queue pipelining (set IOQ depth to 1)	A7#
Disable MCERR# observation	A9#
Disable BINIT# observation	A10#
APIC Cluster ID (0-3)	A[12:11]#
Disable bus parking	A15#
Disable Hyper-Threading Technology	A31#
Symmetric agent arbitration ID	BR0#
RESERVED	A[6:3]#, A8#, A[14:13]#, A[16:30]#, A[32:35]#

NOTES:

- Asserting this signal during RESET# will select the corresponding option.
- 2. Address signals not identified in this table as configuration options should not be asserted during RESET#.

6.2 Clock Control and Low Power States

The processor allows the use of AutoHALT and Stop-Grant states to reduce power consumption by stopping the clock to internal sections of the processor, depending on each particular state. See Figure 6-1 for a visual representation of the processor low power states.

The processor adds support for the Enhanced HALT powerdown state. Refer to Figure 6-1 and the following sections.

Not all processors are capable of supporting the Enhanced HALT state. Refer to the Specification Update to determine which processor stepping and frequencies will support the Enhanced HALT state.



6.2.1 Normal State

This is the normal operating state for the processor.

6.2.2 HALT and Enhanced HALT Powerdown States

The Prescott processor supports the HALT or Enhanced HALT powerdown state. The Enhanced HALT powerdown state is configured and enabled via the BIOS.

The Enhanced HALT state is a lower power state as compared to the Stop Grant State.

If Enhanced HALT is not enabled, the default powerdown state entered will be HALT. Refer to the sections below for details about the HALT and Enhanced HALT states.

6.2.2.1 HALT Powerdown State

HALT is a low power state entered when all the logical processors have executed the HALT or MWAIT instructions. When one of the logical processors executes the HALT instruction, that logical processor is halted, however, the other processor continues normal operation. The processor will transition to the Normal state upon the occurrence of SMI#, BINIT#, INIT#, or LINT[1:0] (NMI, INTR). RESET# will cause the processor to immediately initialize itself.

The return from a System Management Interrupt (SMI) handler can be to either Normal Mode or the HALT Power Down state. See the *Intel Architecture Software Developer's Manual, Volume III:* System Programmer's Guide for more information.

The system can generate a STPCLK# while the processor is in the HALT Power Down state. When the system deasserts the STPCLK# interrupt, the processor will return execution to the HALT state.

While in HALT Power Down state, the processor will process bus snoops.

6.2.2.2 Enhanced HALT Powerdown State

Enhanced HALT is a low power state entered when all logical processors have executed the HALT or MWAIT instructions and Enhanced HALT has been enabled via the BIOS. When one of the logical processors executes the HALT instruction, that logical processor is halted; however, the other processor continues normal operation.

The processor will automatically transition to a lower frequency and voltage operating point before entering the Enhanced HALT state. Note that the processor FSB frequency is not altered; only the internal core frequency is changed. When entering the low power state, the processor will first switch to the lower bus ratio and then transition to the lower VID.

While in Enhanced HALT state, the processor will process bus snoops.

The processor exits the Enhanced HALT state when a break event occurs. When the processor exits the Enhanced HALT state, it will first transition the VID to the original value and then change the bus ratio back to the original value.



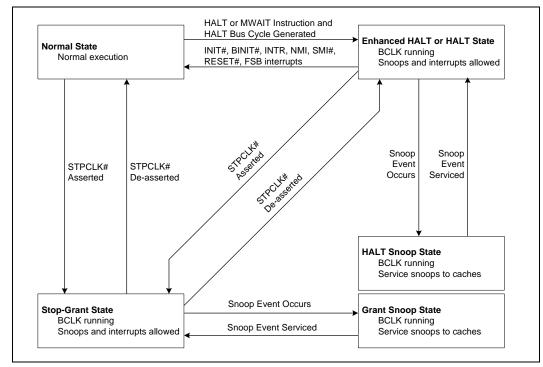


Figure 6-1. Processor Low Power State Machine

6.2.3 Stop-Grant State

When the STPCLK# signal is asserted, the Stop-Grant state of the processor is entered 20 bus clocks after the response phase of the processor-issued Stop Grant Acknowledge special bus cycle.

Since the GTL+ signals receive power from the FSB, these signals should not be driven (allowing the level to return to V_{TT}) for minimum power drawn by the termination resistors in this state. In addition, all other input signals on the FSB should be driven to the inactive state.

BINIT# will not be serviced while the processor is in Stop-Grant state. The event will be latched and can be serviced by software upon exit from the Stop Grant state.

RESET# will cause the processor to immediately initialize itself, but the processor will stay in Stop-Grant state. A transition back to the Normal state will occur with the de-assertion of the STPCLK# signal.

A transition to the HALT/Grant Snoop state will occur when the processor detects a snoop on the FSB (see Section 6.2.3).

While in the Stop-Grant State, SMI#, INIT#, BINIT# and LINT[1:0] will be latched by the processor, and only serviced when the processor returns to the Normal State. Only one occurrence of each event will be recognized upon return to the Normal state.

While in Stop-Grant state, the processor will process a FSB snoop.



6.2.4 Enhanced HALT Snoop or HALT Snoop State, Grant Snoop State

The Enhanced HALT Snoop State is used in conjunction with the new Enhanced HALT state. If Enhanced HALT state is not enabled in the BIOS, the default Snoop State entered will be the HALT Snoop State. Refer to the sections below for details on HALT Snoop State, Grant Snoop State and Enhanced HALT Snoop State.

6.2.4.1 HALT Snoop State, Grant Snoop State

The processor will respond to snoop transactions on the FSB while in Stop-Grant state or in HALT Power Down state. During a snoop transaction, the processor enters the HALT:Grant Snoop state. The processor will stay in this state until the snoop on the FSB has been serviced (whether by the processor or another agent on the FSB). After the snoop is serviced, the processor will return to the Stop-Grant state or HALT Power Down state, as appropriate.

6.2.4.2 Enhanced HALT Snoop State

The Enhanced HALT Snoop State is the default Snoop State when the Enhanced HALT state is enabled via the BIOS. The processor will remain in the lower bus ratio and VID operating point of the Enhanced HALT state.

While in the Enhanced HALT Snoop State, snoops are handled the same way as in the HALT Snoop State. After the snoop is serviced the processor will return to the Enhanced HALT Power Down state.

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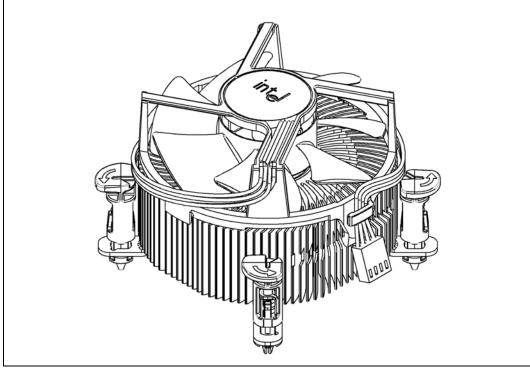


7 Boxed Processor Specifications

The Pentium 4 processor on 90 nm process in the 775-land package will also be offered as a boxed Intel processor. Boxed Intel processors are intended for system integrators who build systems from baseboards and standard components. The boxed Pentium 4 processor in the 775-land package will be supplied with a cooling solution. This chapter documents baseboard and system requirements for the cooling solution that will be supplied with the boxed Pentium 4 processor in the 775-land package. This chapter is particularly important for OEMs that manufacture baseboards for system integrators. Unless otherwise noted, all figures in this chapter are dimensioned in millimeters and inches [in brackets]. Figure 7-1 shows a mechanical representation of a boxed Pentium 4 processor in the 775-land package.

Note: Drawings in this section reflect only the specifications on the boxed Intel processor product. These dimensions should not be used as a generic keep-out zone for all cooling solutions. It is the system designers' responsibility to consider their proprietary cooling solution when designing to the required keep-out zone on their system platforms and chassis. Refer to the Intel[®] Pentium[®] 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines for further guidance. Contact your local Intel Sales Representative for this document.

Figure 7-1. Mechanical Representation of the Boxed Processor



NOTE: The airflow of the fan heatsink is into the center and out of the sides of the fan heatsink.



7.1 Mechanical Specifications

7.1.1 Boxed Processor Cooling Solution Dimensions

This section documents the mechanical specifications of the boxed Pentium 4 processor on 90 nm process in the 775-land package. The boxed processor will be shipped with an unattached fan heatsink. Figure 7-1 shows a mechanical representation of the boxed Pentium 4 processor in the 775-land package.

Clearance is required around the fan heatsink to ensure unimpeded airflow for proper cooling. The physical space requirements and dimensions for the boxed processor with assembled fan heatsink are shown in Figure 7-2 (side view), and Figure 7-3 (top view). The airspace requirements for the boxed processor fan heatsink must also be incorporated into new baseboard and system designs. Airspace requirements are shown in Figure 7-7 and Figure 7-8. Note that some figures have centerlines shown (marked with alphabetic designations) to clarify relative dimensioning.

Figure 7-2. Space Requirements for the Boxed Processor (Side View)

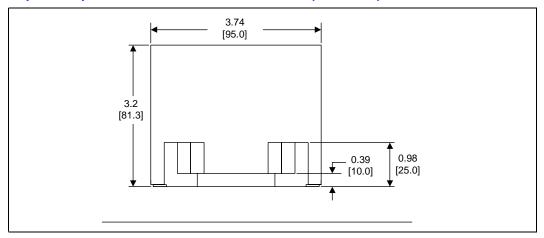
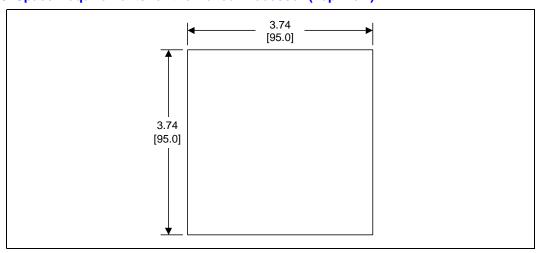


Figure 7-3. Space Requirements for the Boxed Processor (Top View)



NOTES

 Diagram does not show the attached hardware for the clip design and is provided only as a mechanical representation.



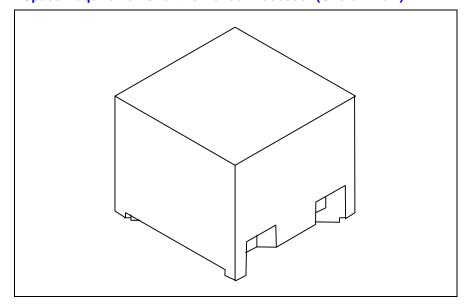


Figure 7-4. Space Requirements for the Boxed Processor (Overall View)

7.1.2 Boxed Processor Fan Heatsink Weight

The boxed processor fan heatsink will not weigh more than 450 grams. See Chapter 5 and the Intel[®] Pentium[®] 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guidelines for details on the processor weight and heatsink requirements.

7.1.3 Boxed Processor Retention Mechanism and Heatsink Attach Clip Assembly

The boxed processor thermal solution requires a heatsink attach clip assembly, to secure the processor and fan heatsink in the baseboard socket. The boxed processor will ship with the heatsink attach clip assembly.

7.2 Electrical Requirements

7.2.1 Fan Heatsink Power Supply

The boxed processor's fan heatsink requires a +12 V power supply. A fan power cable will be shipped with the boxed processor to draw power from a power header on the baseboard. The power cable connector and pinout are shown in Figure 7-5. Baseboards must provide a matched power header to support the boxed processor. Table 7-1 contains specifications for the input and output signals at the fan heatsink connector.



The fan heatsink outputs a SENSE signal that is an open-collector output that pulses at a rate of 2 pulses per fan revolution. A baseboard pull-up resistor provides V_{OH} to match the system board-mounted fan speed monitor requirements, if applicable. Use of the SENSE signal is optional. If the SENSE signal is not used, pin 3 of the connector should be tied to GND.

The fan heatsink receives a PWM signal from the motherboard from the 4th pin of the connector labeled as CONTROL.

The boxed processor's fan heatsink requires a constant +12 V supplied to pin 2 and does not support variable voltage control or 3-pin PWM control.

The power header on the baseboard must be positioned to allow the fan heatsink power cable to reach it. The power header identification and location should be documented in the platform documentation, or on the system board itself. Figure 7-6 shows the location of the fan power connector relative to the processor socket. The baseboard power header should be positioned within 110 mm [4.33 inches] from the center of the processor socket.

Figure 7-5. Boxed Processor Fan Heatsink Power Cable Connector Description

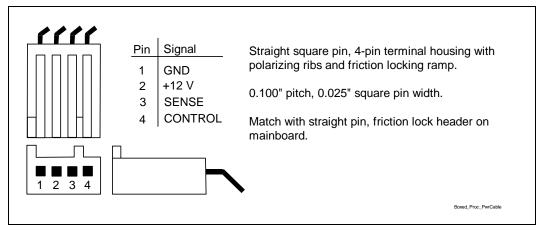


Table 7-1. Fan Heatsink Power and Signal Specifications

Description	Min	Тур	Max	Unit	Notes
+12 V: 12 volt fan power supply	10.2	12	13.8	V	-
IC: Peak Fan current draw Fan start-up current draw Fan start-up current draw maximum duration	_	1.1 	1.5 2.2 1.0	A A Second	-
SENSE: SENSE frequency	_	2	_	pulses per fan revolution	1
CONTROL	21	25	28	kHz	2, 3

NOTES:

- 1. Baseboard should pull this pin up to 5V with a resistor.
- Open drain type, pulse width modulated.
- 3. Fan will have pull-up resistor to 4.75 V maximum of 5.25 V.



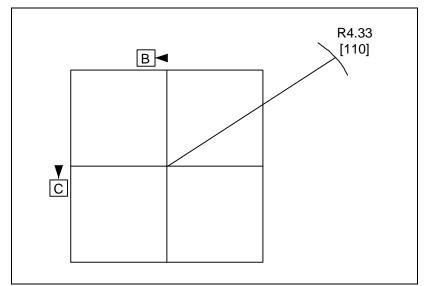


Figure 7-6. Baseboard Power Header Placement Relative to Processor Socket

7.3 Thermal Specifications

This section describes the cooling requirements of the fan heatsink solution used by the boxed processor.

7.3.1 Boxed Processor Cooling Requirements

The boxed processor may be directly cooled with a fan heatsink. However, meeting the processor's temperature specification is also a function of the thermal design of the entire system, and ultimately the responsibility of the system integrator. The processor temperature specification is in Chapter 5. The boxed processor fan heatsink is able to keep the processor temperature within the specifications (see Table 5-1) in chassis that provide good thermal management. For the boxed processor fan heatsink to operate properly, it is critical that the airflow provided to the fan heatsink is unimpeded. Airflow of the fan heatsink is into the center and out of the sides of the fan heatsink. Airspace is required around the fan to ensure that the airflow through the fan heatsink is not blocked. Blocking the airflow to the fan heatsink reduces the cooling efficiency and decreases fan life. Figure 7-7 and Figure 7-8 illustrate an acceptable airspace clearance for the fan heatsink. The air temperature entering the fan should be kept below 38 °C. Again, meeting the processor's temperature specification is the responsibility of the system integrator.



Figure 7-7. Boxed Processor Fan Heatsink Airspace Keepout Requirements (Top View)

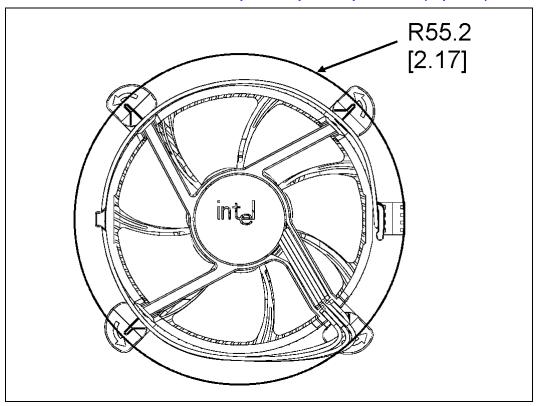
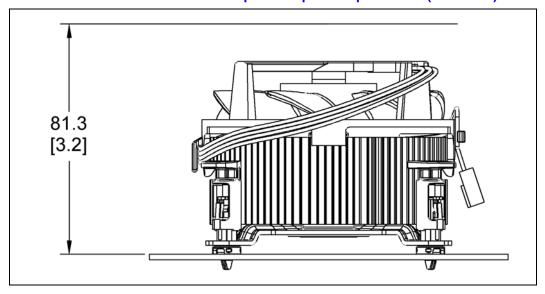


Figure 7-8. Boxed Processor Fan Heatsink Airspace Keepout Requirements (Side View)





7.3.2 Variable Speed Fan

If the boxed processor fan heatsink 4-pin connector is connected to a 3-pin motherboard header it will operate as follows:

The boxed processor fan will operate at different speeds over a short range of internal chassis temperatures. This allows the processor fan to operate at a lower speed and noise level, while internal chassis temperatures are low. If internal chassis temperature increases beyond a lower set point, the fan speed will rise linearly with the internal temperature until the higher set point is reached. At that point, the fan speed is at its maximum. As fan speed increases, so does fan noise levels. Systems should be designed to provide adequate air around the boxed processor fan heatsink that remains cooler then lower set point. These set points, represented in Figure 7-9 and Table 7-2, can vary by a few degrees from fan heatsink to fan heatsink. The internal chassis temperature should be kept below 38 °C. Meeting the processor's temperature specification (see Chapter 5) is the responsibility of the system integrator.

The motherboard must supply a constant +12~V to the processor's power header to ensure proper operation of the variable speed fan for the boxed processor. Refer to Table 7-1 for the specific requirements.

Figure 7-9. Boxed Processor Fan Heatsink Set Points

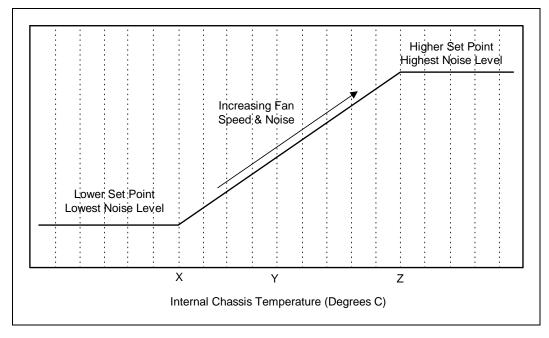




Table 7-2. Fan Heatsink Power and Signal Specifications

Boxed Processor Fan Heatsink Set Point (°C)	Boxed Processor Fan Speed	
X ≤ 30	When the internal chassis temperature is below or equal to this set point, the fan operates at its lowest speed. Recommended maximum internal chassis temperature for nominal operating environment.	1
Y = 34	When the internal chassis temperature is at this point, the fan operates between its lowest and highest speeds. Recommended maximum internal chassis temperature for worst-case operating environment.	-
Z ≥ 38	When the internal chassis temperature is above or equal to this set point, the fan operates at its highest speed.	-

NOTES:

If the boxed processor fan heatsink 4-pin connector is connected to a 4-pin motherboard header and the motherboard is designed with a fan speed controller with PWM output (CONTROL see Table 7-1) and remote thermal diode measurement capability the boxed processor will operate as follows:

As processor power has increased the required thermal solutions have generated increasingly more noise. Intel has added an option to the boxed processor that allows system integrators to have a quieter system in the most common usage.

The 4th wire PWM solution provides better control over chassis acoustics. This is achieved by more accurate measurement of processor die temperature through the processor's temperature diode ($T_{\rm diode}$). Fan RPM is modulated through the use of an ASIC located on the motherboard that sends out a PWM control signal to the 4th pin of the connector labeled as CONTROL. The fan speed is based on actual processor temperature instead of internal ambient chassis temperatures.

If the new 4-pin active fan heat sink solution is connected to an older 3-pin baseboard processor fan header, it will default back to a thermistor controlled mode, allowing compatibility with existing 3-pin baseboard designs. Under thermistor controlled mode, the fan RPM is automatically varied based on the Tinlet temperature measured by a thermistor located at the fan inlet.

For more details on specific motherboard requirements for 4-wire based fan speed control see the Intel[®] Pentium[®] 4 Processor on 90 nm Process in the 775-Land Package Thermal Design Guide.

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^{1.} Set point variance is approximately ± 1 °C from fan heatsink to fan heatsink.